HC05L5GRS/D REV. 2.0

68HC05L5 68HC705L5

General Release Specification

July 9, 1998



For More Information On This Product, Go to: www.freescale.com Motorola reserves the right to make changes without further notice to any products herein to improve reliability, function or design. Motorola does not assume any liability arising out of the application or use of any product or circuit described herein; neither does it convey any license under its patent rights nor the rights of others. Motorola products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Motorola was negligent regarding the design or manufacture of the part.

© Motorola, Inc., 1998

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

MOTOROLA

List of Sections

| Section 1. General Description |
|---|
| Section 2. Memory Map 33 |
| Section 3. Central Processor Unit (CPU) 51 |
| Section 4. Resets and Interrupts 57 |
| Section 5. Low-Power Modes |
| Section 6. Parallel Input/Output (I/O) |
| Section 7. Oscillators/Clock Distributions |
| Section 8. Simple Serial Peripheral Interface (SSPI) |
| Section 9. Timer System 115 |
| Section 10. LCD Driver |
| Section 11. Instruction Set |
| Section 12. Electrical Specifications |
| Section 13. Mechanical Specifications |
| Section 14. Ordering Information |
| Appendix A. MC68HC705L5 181 |

MC68HC(7)05L5 - Rev. 2.0

List of Sections

General Release Specification

Table of Contents

Section 1. General Description

| 1.1 | Contents |
|---------|--|
| 1.2 | Introduction |
| 1.3 | Features |
| 1.4 | MCU Structure |
| 1.5 | Mask Options |
| 1.6 | Functional Pin Description23 |
| 1.6.1 | V_{DD} and V_{SS} |
| 1.6.2 | OSC1 and OSC2 |
| 1.6.2.1 | Crystal or Ceramic Resonator |
| 1.6.2.2 | External Clock |
| 1.6.3 | XOSC1 and XOSC2 |
| 1.6.3.1 | Crystal Resonator27 |
| 1.6.3.2 | External Clock |
| 1.6.4 | RESET |
| 1.6.5 | Port A (PA0–PA7) |
| 1.6.6 | Port B (PB0–PB7/KWI0–KWI7)28 |
| 1.6.7 | Port C (PC0/SDI, PC1/SDO, PC2/SCK, PC3/TCAP, |
| | PC4/EVI, PC5/EVO, PC6/IRQ2, and PC7/IRQ1)28 |
| 1.6.8 | Port D (PD1–PD3/BP1–BP3, |
| | and PD4–PD7/FP34–FP27) |
| 1.6.9 | Port E (PE0–PE7/FP38–FP35) |
| 1.6.10 | VLCD1, VLCD2, and VLCD3 |
| 1.6.11 | NDLY |
| 1.7 | Modes of Operation |
| 1.7.1 | Mode Entry |
| 1.7.2 | Single-Chip Mode (SCM)31 |
| 1.7.3 | Self-Check Mode |

MOTOROLA

Table of Contents

Section 2. Memory Map

| 2.1 | Contents |
|-------|---|
| 2.2 | Introduction |
| 2.3 | Input/Output and Control Registers |
| 2.3.1 | Read/Write Bits |
| 2.3.2 | Read-Only Bits |
| 2.3.3 | Write-Only Bits |
| 2.3.4 | Reserved Bits |
| 2.3.5 | Reset Value |
| 2.3.6 | Option Map |
| 2.4 | Summary of Internal Registers and I/O Map37 |
| 2.5 | Option Map for I/O Configurations |
| 2.5.1 | Resistor Control Register 1 |
| 2.5.2 | Resistor Control Register 246 |
| 2.5.3 | Open-Drain Output Control Register 146 |
| 2.5.4 | Open-Drain Output Control Register 2 |
| 2.5.5 | Key Wakeup Input Enable Register |
| 2.5.6 | Mask Option Status Register49 |
| 2.6 | RAM |
| 2.7 | Self-Check ROM |
| 2.8 | Mask ROM |

Section 3. Central Processor Unit (CPU)

| 3.1 | Contents |
|-----|-------------------------|
| 3.2 | Introduction |
| 3.3 | CPU Registers |
| 3.4 | Accumulator |
| 3.5 | Index Register |
| 3.6 | Condition Code Register |
| 3.7 | Stack Pointer |
| 3.8 | Program Counter |
| 3.9 | Arithmetic/Logic Unit |
| | |

General Release Specification

Section 4. Resets and Interrupts

| 4.1 | Contents |
|-------|----------------------------------|
| 4.2 | Introduction |
| 4.3 | Interrupts |
| 4.3.1 | IRQ1 and IRQ2 |
| 4.3.2 | Key Wakeup Interrupt (KWI) |
| 4.3.3 | IRQ (KWI) Software Consideration |
| 4.3.4 | Timer 1 Interrupt64 |
| 4.3.5 | Timer 2 Interrupt64 |
| 4.3.6 | SSPI Interrupt64 |
| 4.3.7 | Timebase Interrupt64 |
| 4.4 | Interrupt Control Register64 |
| 4.5 | Interrupt Status Register |

Section 5. Low-Power Modes

| 5.1 | Contents | 39 |
|-----|-----------|------------|
| 5.2 | | 39 |
| 5.3 | Stop Mode | 39 |
| 5.4 | Wait Mode | <i>'</i> 0 |

Section 6. Parallel Input/Output (I/O)

| 6.1 | Contents |
|-------|--------------------------------|
| 6.2 | Introduction |
| 6.3 | Port A |
| 6.3.1 | Port A Data Register76 |
| 6.3.2 | Port A Data Direction Register |
| 6.4 | Port B |
| 6.5 | Port C |
| 6.5.1 | Port C Data Register |
| 6.5.2 | Port C Data Direction Register |
| 6.6 | Port D |
| 6.7 | Port E |

MOTOROLA

Table of Contents

Section 7. Oscillators/Clock Distributions

| 7.1 Contents |
|--|
| 7.2 Introduction |
| 7.3 OSC Clock Divider and POR Counter |
| 7.4 System Clock Control |
| 7.5 OSC and XOSC90 |
| 7.5.1 OSC on Line |
| 7.5.2 XOSC on Line |
| 7.5.2.1 XOSC with FOSCE = 1 |
| 7.5.2.2 XOSC with FOSCE = 0 |
| 7.5.2.3 XOSC with FOSCE = 0 and STOP92 |
| 7.5.2.4 Stop Mode and Wait Mode. 92 |
| 7.6 Timebase |
| 7.6.1 LCDCLK |
| 7.6.2 STUP |
| 7.6.3 TBI |
| 7.6.4 COP |
| 7.6.5 Timebase Control Register 1 |
| 7.6.6 Timebase Control Register 2 |
| 7.6.7 Miscellaneous Register |

Section 8. Simple Serial Peripheral Interface (SSPI)

| 0.4 | Contonto |
|-------|-----------------------------|
| 8.1 | Contents |
| 8.2 | Introduction |
| 8.3 | Features |
| 8.4 | Functional Descriptions105 |
| 8.5 | Internal Block Descriptions |
| 8.5.1 | Control |
| 8.5.2 | SPDR |
| 8.5.3 | SPCR |
| 8.5.4 | SPSR |
| 8.5.5 | CLKGEN |
| 8.6 | Signal Descriptions |
| 8.6.1 | SSPI Data I/O (SDI and SDO) |
| 8.6.2 | Serial Clock (SCK)108 |
| | |

| 8.7 | Registers | |
|-------|------------------------------------|--|
| 8.7.1 | Serial Peripheral Control Register | |
| 8.7.2 | Serial Peripheral Status Register | |
| 8.7.3 | Serial Peripheral Data Register | |
| 8.8 | Port Function | |

Section 9. Timer System

| 9.1 | Contents |
|-------|------------------------------|
| 9.2 | Introduction |
| 9.3 | Timer 1 |
| 9.3.1 | Counter |
| 9.3.2 | Output Compare Register |
| 9.3.3 | Input Capture Register120 |
| 9.3.4 | Timer Control Register121 |
| 9.3.5 | Timer Status Register122 |
| 9.3.6 | Timer During Wait Mode |
| 9.3.7 | Timer During Stop Mode |
| 9.4 | Timer 2 |
| 9.4.1 | Timer Control Register 2 |
| 9.4.2 | Timer Status Register 2130 |
| 9.4.3 | Output Compare Register 2 |
| 9.4.4 | Timer Counter Register 2 |
| 9.4.5 | Time Base Control Register 1 |
| 9.4.6 | Timer Input 2 (EVI) |
| 9.4.7 | Event Output (EVO)135 |
| 9.5 | Prescaler |

Section 10. LCD Driver

| 10.1 | Contents |
|------|--|
| 10.2 | Introduction |
| 10.3 | LCD Waveform Examples140 |
| 10.4 | Backplane Driver and Port Selection144 |
| 10.5 | Frontplane Driver and Port Selection |
| 10.6 | LCD Control Register |
| 10.7 | LCD Data Register |

MC68HC(7)05L5-Rev. 2.0

MOTOROLA

Table of Contents

Section 11. Instruction Set

| 11.1 Contents |
|--|
| 11.2 Introduction150 |
| 11.3 Addressing Modes |
| 11.3.1 Inherent |
| 11.3.2 Immediate |
| 11.3.3 Direct |
| 11.3.4 Extended |
| 11.3.5 Indexed, No Offset152 |
| 11.3.6 Indexed, 8-Bit Offset |
| 11.3.7 Indexed,16-Bit Offset |
| 11.3.8 Relative |
| 11.4 Instruction Types153 |
| 11.4.1 Register/Memory Instructions |
| 11.4.2 Read-Modify-Write Instructions155 |
| 11.4.3 Jump/Branch Instructions |
| 11.4.4 Bit Manipulation Instructions |
| 11.4.5 Control Instructions |
| 11.5 Instruction Set Summary160 |
| 11.6 Opcode Map |

Section 12. Electrical Specifications

| 12.1 | Contents |
|-------|---|
| 12.2 | Introduction |
| 12.3 | Maximum Ratings168 |
| 12.4 | Operating Temperature Range169 |
| 12.5 | Thermal Characteristics |
| 12.6 | Recommended Operating Conditions |
| 12.7 | 5.0-Volt DC Electrical Characteristics170 |
| 12.8 | 3.3-Volt DC Electrical Characteristics |
| 12.9 | 2.7-Volt DC Electrical Characteristics172 |
| 12.10 | Control Timing |

Section 13. Mechanical Specifications

| 13.1 | Contents | 75 |
|------|-------------------------------------|----|
| 13.2 | Introduction | 75 |
| 13.3 | Quad Flat Pack (QFP) — Case 841B-01 | 76 |

General Release Specification

Section 14. Ordering Information

| 14.1 | Contents |
|------|-------------------------------|
| 14.2 | Introduction |
| 14.3 | MCU Ordering Forms |
| 14.4 | Application Program Media |
| 14.5 | ROM Program Verification |
| 14.6 | ROM Verification Units (RVUs) |
| 14.7 | MC Order Numbers |

Appendix A. MC68HC705L5

| A.1 | Contents |
|------------------------------------|--|
| A.2 | Introduction |
| A.3 | Differences between MC68HC05L5 and MC68HC705L5182 |
| A.4 | MCU Structure |
| A.5 | Mask Options |
| A.6 | Functional Pin Description |
| A.7 | Programming Voltage (V _{PP}) |
| A.8 A.8.1 A.8.2 A.8.3 | Modes of Operation.186Mode Entry.186Single-Chip Mode (SCM).187Bootstrap Mode.187 |
| A.9 | Memory Map |
| A.10 | Boot ROM |
| A.11 A.11.1 A.11.2 | |
| A.12 | COP Watchdog Timer |
| A.13 | LCD 1/2 Duty and 1/2 Bias Timing Diagram192 |
| A.14 A.14.1 A.14.2 A.14.3 | 2 Operating Temperature Range |
| | |

Table of Contents

| A.15 R | ecommended Operating Conditions | 194 |
|--------|--|-----|
| A.15.1 | EPROM Programming Voltage | 194 |
| A.15.2 | 5.0-Volt DC Electrical Characteristics | 195 |
| A.15.3 | 3.3-Volt DC Electrical Characteristics | 196 |
| A.15.4 | 3.3-Volt and 5.0-Volt Control Timing | 197 |
| A.16 M | C Order Numbers | 198 |

General Release Specification

List of Figures

| Figure | Title | Page |
|--------|---|------|
| 1-1 | Block Diagram | 21 |
| 1-2 | Pin Assignment for Single-Chip Mode | 23 |
| 1-3 | Oscillator Connections | 26 |
| 1-4 | Oscillator Connections | 27 |
| 1-5 | Mode Entry Diagram | 31 |
| 2-1 | Memory Map | 34 |
| 2-2 | Register Description Key | 35 |
| 2-3 | Main I/O Map | 37 |
| 2-4 | Option Map | |
| 2-5 | Resistor Control Register 1 (RCR1) | |
| 2-6 | Resistor Control Register 2 (RCR2) | |
| 2-7 | Open-Drain Output Control Register 1 (WOM1) | |
| 2-8 | Open-Drain Output Control Register 2 (WOM2) | |
| 2-9 | Key Wakeup Input Enable Register (KWIEN) | |
| 2-10 | Mask Option Status Register (MOSR) | 49 |
| 3-1 | Programming Model | 52 |
| 3-2 | Stacking Order | 52 |
| 4-1 | Timer 1 Interrupt | 60 |
| 4-2 | IRQ Timing Delay | 60 |
| 4-3 | Software Patch for IRQ1 | 60 |
| 4-4 | Interrupt Flowchart | 61 |
| 4-5 | IRQ1 and IRQ2 Block Diagram | 62 |
| 4-6 | Key Wakeup Interrupt (KWI) | |
| 4-7 | Interrupt Control Register (INTCR) | |
| 4-8 | Interrupt Status Register (INTSR) | 66 |

MOTOROLA

List of Figures

| Figure | Title | Page |
|--------|--|------|
| 5-1 | Clock State and STOP Recovery/Power-On Reset Delay Diagrams | 71 |
| 5-2 | Stop/Wait Flowcharts | |
| 6-1 | Port I/O Circuitry for One Bit. | 74 |
| 6-2 | Port A Data Register (PORTA) | |
| 6-3 | Port A Data Direction Register (DDRA) | |
| 6-4 | Port B Data Register (PORTB) | |
| 6-5 | Port C Data Register (PORTC) | |
| 6-6 | Port C Data Direction Register (DDRC) | |
| 6-7 | Port D Data Register (PORTD) | |
| 6-8 | Port E Data Register (PORTE) | 85 |
| 7-1 | Clock Signal Distribution | 88 |
| 7-2 | OSC1, OSC2, XOSC1, and XOSC2 Mask Options . | 90 |
| 7-3 | Unused XOSC1 Pin | 91 |
| 7-4 | Timebase Clock Divider | 94 |
| 7-5 | Timebase Control Register 1 (TBCR1) | 97 |
| 7-6 | Timebase Control Register 2 (TBCR2) | 98 |
| 7-7 | Miscellaneous Register (MISC) | 100 |
| 8-1 | SSPI Master-Slave Interconnection | |
| 8-2 | SSPI Block Diagram | |
| 8-3 | SSPI Clock-Data Timing Diagram | |
| 8-4 | Serial Peripheral Control Register (SPCR) | |
| 8-5 | Serial Peripheral Status Register (SPSR) | |
| 8-6 | Serial Peripheral Data Register (SPDR) | 113 |
| 9-1 | Timer System Block Diagram | 116 |
| 9-2 | Timer 1 Block Diagram | |
| 9-3 | Timer Control Register (TCR) | 121 |
| 9-4 | Timer Status Register (TSR) | 122 |
| 9-5 | Timer 2 Block Diagram | |
| 9-6 | Timer 2 Timing Diagram for f(PH2) > f(TIMCLK) | |
| 9-7 | Timer 2 Timing Diagram for f(PH2) = f(TIMCLK) | |
| 9-8 | Timer Control Register 2 (TCR2) | 128 |

General Release Specification

List of Figures

| Figure | Title | Page |
|--------|--|------|
| 9-9 | Timer Status Register 2 (TSR2) | 130 |
| 9-10 | Output Compare Register 2 (OC2) | 131 |
| 9-11 | Timer Counter Register 2 (TCNT2) | 131 |
| 9-12 | Time Base Control Register 1 (TBCR1) | 132 |
| 9-13 | EVI Block Diagram | 132 |
| 9-14 | EVI Timing Diagram | 134 |
| 9-15 | EVO Block Diagram | 135 |
| 9-16 | EVO Timing Diagram | 136 |
| 9-17 | Prescaler Block Diagram | 137 |
| 10-1 | LCD 1/1 Duty and 1/1 Bias Timing Diagram | 140 |
| 10-2 | LCD 1/2 Duty and 1/2 Bias Timing Diagram | 141 |
| 10-3 | LCD 1/3 Duty and 1/3 Bias Timing Diagram | 142 |
| 10-4 | LCD 1/4 Duty and 1/3 Bias Timing Diagram | 143 |
| 10-5 | LCD Control Register (LCDCR) | 146 |
| 10-6 | LDC Data Registers | 148 |
| 12-1 | Stop Recovery Timing Diagram | 174 |
| A-2 | Pin Assignments for Single-Chip Mode | |
| A-3 | Mode Entry Diagram | |
| A-4 | Memory Map | |
| A-5 | Program Control Register (PCR) | 190 |

MC68HC(7)05L5 - Rev. 2.0

List of Figures

General Release Specification

MC68HC(7)05L5-Rev. 2.0

MOTOROLA

List of Tables

| Table | Title | Page |
|-------|--------------------------------------|------|
| 1-1 | Pin Configuration | 24 |
| 1-2 | Mode Select Summary | 30 |
| 4-1 | Interrupt Vector Assignments | 58 |
| 7-1 | System Bus Clock Frequency Selection | 89 |
| 7-2 | Recovery Time Requirements | 93 |
| 7-3 | Timebase Interrupt Frequency | |
| 7-4 | COP Timeout Period | 96 |
| 7-5 | Timebase Interrupt Frequency | 99 |
| 7-6 | System Bus Clock Frequency Selection | 101 |
| 9-1 | EVI Modes Selection | 129 |
| 9-2 | Timebase Prescale Rate Selection | 132 |
| 9-3 | EVI Modes Selection | 133 |
| 9-4 | Timebase Prescale Rate Selection | 137 |
| 10-1 | Backplane and Port Selection | 144 |
| 10-2 | Frontplane and Port Selection | 145 |
| 10-3 | Frontplane Data Register Bit Usage | 148 |
| 11-1 | Register/Memory Instructions | 154 |
| 11-2 | Read-Modify-Write Instructions | |
| 11-3 | Jump and Branch Instructions | 157 |
| 11-4 | Bit Manipulation Instructions. | |
| 11-5 | Control Instructions. | 159 |
| 11-6 | Instruction Set Summary | 160 |
| 11-7 | Opcode Map | 166 |
| | | |

List of Tables

| Table | Title | Page |
|-------|---|------|
| 14-1 | MC Order Numbers | 180 |
| A-1 | Differences Between MC68HC05L5 and MC68HC705L5 | 182 |
| A-2 | Pin Configuration | 185 |
| A-3 | Mode Select Summary | 186 |
| A-4 | MC Order Numbers | 198 |

General Release Specification

Section 1. General Description

1.1 Contents

| 1.2 | Introduction |
|------------------|--|
| 1.3 | Features |
| 1.4 | MCU Structure |
| 1.5 | Mask Options |
| 1.6 | Functional Pin Description |
| 1.6.1 | V _{DD} and V _{SS} |
| 1.6.2 | OSC1 and OSC2 |
| 1.6.2. | 1 Crystal or Ceramic Resonator |
| 1.6.2.2 | |
| 1.6.3 | XOSC1 and XOSC226 |
| 1.6.3. | |
| 1.6.3.2 1.6.4 | |
| - | RESET |
| 1.6.5 | Port A (PA0–PA7) |
| 1.6.6 | Port B (PB0–PB7/KWI0–KWI7) |
| 1.6.7 | Port C (PC0/SDI, PC1/SDO, PC2/SCK, PC3/TCAP, |
| | PC4/EVI, PC5/EVO, PC6/IRQ2, and PC7/IRQ1)28 |
| 1.6.8 | Port D (PD1–PD3/BP1–BP3, and PD4–PD7/FP34–FP27).29 |
| 1.6.9 | Port E (PE0–PE7/FP38–FP35) |
| 1.6.10 | VLCD1, VLCD2, and VLCD3 |
| 1.6.11 | NDLY |
| 1.7 | Modes of Operation |
| 1.7.1 | Mode Entry |
| 1.7.2 | Single-Chip Mode (SCM)31 |
| 1.7.3 | Self-Check Mode |
| | |

| | Π. |
|----------|----|
| - C | |
| | |
| - 5 | |
| - | |
| | _ |
| | |
| | |
| | |
| - C | |
| - | |
| | |
| - C. | |
| | |
| | 5 |
| - | |
| Т | 5 |
| | |
| 5 | |
| | |
| - 6 | |
| Ĩ | |
| ٩. | |
| | |
| | |
| | |
| 5 | |
| | |
| | |
| • | |
| - | |
| | 1. |
| 0 | |
| _ | |
| | |
| - 61 | |
| | Κ. |
| - 6 | |
| | ĥ. |
| . 0 | 7 |
| | b |
| | |
| 9 | |
| <u> </u> | |
| | |
| L i | |
| | |
| | |

MC68HC(7)05L5 - Rev. 2.0

General Description

1.2 Introduction

The MC68HC05L5 is an 80-pin microcontroller unit (MCU) with highly sophisticated on-chip peripheral functions. The memory map includes 8 Kbytes of user ROM and 256 bytes of static RAM. The MCU has five parallel ports: A, B, C, D, and E. The MC68HC05L5 includes a timebase circuit, 8- and 16-bit timers, a computer operating properly (COP) watchdog timer, liquid crystal display (LCD) drivers, and a simple serial peripheral interface (SSPI).

1.3 Features

Features of the MC68HC05L5 MCU include:

- Low-cost HC05 core
- 8,208 bytes of user ROM and 256 bytes of user static RAM
- General-purpose data pins:
 - 14 bidirectional pins
 - 10 input/ouptut-only pins
 - 15 output-only pins, including 8-bit key wakeup interrupts
- Pullup resistors options
- Open-drain outputs options
- Two interrupt request (IRQ) inputs
- 16-bit timer with input capture and output compare (timer 1)
- 8-bit event counter/modulus clock divider (timer 2)
- Simple serial peripheral interface (SSPI)
- LCD drivers 1-to-4 backplane drivers x 27-to-39 frontplane drivers
- On-chip timebase circuits with COP watchdog timer and timebase interrupts
- Dual oscillators and selectable system clock frequency
- Power-saving stop mode and wait mode
- 80-pin quad flat pack (QFP) package

General Release Specification

1.4 MCU Structure



Figure 1-1 shows the structure of the MC68HC05L5 MCU.



Figure 1-1. Block Diagram

General Description

NOTE: A line over a signal name indicates an active low signal. For example, RESET is active low.

1.5 Mask Options

The three mask options on the MC68HC05L5 are:

- 1. RSTR: RESET pin pullup resistor
- 2. OSCR: OSC feedback resistor
- 3. XOSCR: XOSC feedback/damping resistor

See 2.5.6 Mask Option Status Register.

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

MOTOROLA

General Description Functional Pin Description

1.6 Functional Pin Description

The MC68HC05L5 is available in an 80-pin QFP. The pin assignment is shown in **Figure 1-2**.





Figure 1-2. Pin Assignment for Single-Chip Mode

MOTOROLA

General Description

| Pin Number | SCM, Self-Check | I/O | Pin Number | SCM, Self-Check | I/O |
|---|---|--|---|--|---|
| 23 24 25 26 27 28 29 30 | PA0 PA1 PA2 PA3 PA4 PA5 PA6 PA7 | I/O I/O I/O I/O I/O I/O I/O | 52 53 54 55 56 57 58 59 | FP0 FP1 FP2 FP3 FP4 FP5 FP6 FP7 | 0 0 0 0 0 0 0 |
| 31 32 33 34 35 36 37 38 | PB0/KWI0 PB1/KWI1 PB2/KWI2 PB3/KWI3 PB4/KWI4 PB5/KWI5 PB6/KWI6 PB7/KWI7 | | 61 62 63 64 65 66 67 68 69 | FP8 FP9 FP10 FP11 FP12 FP13 FP14 FP15 FP16 | |
| 39 40 41 42 43 44 45 46 | PC0/SDI PC1/SDO PC2/SCK PC3/TCAP PC4/EVI PC5/EVO PC6/IRQ2 PC7/IRQ1 | I/O I/O I/O I/O I/O I I I | 70 71 72 73 74 75 76 77 78 | FP17 FP18 FP19 FP20 FP21 FP22 FP23 FP24 FP25 | |
| 17 47 1 60 16 21 22 18 19 | $\begin{array}{c} \text{NDLY}^{(1)} \\ V_{\text{DD}} \\ V_{\text{SS}} \\ V_{\text{SS}} \\ \text{OSC1} \\ \text{OSC2} \\ \text{XOSC1} \\ \text{XOSC2} \end{array}$ | | 79 80 2 3 4 5 6 7 8 | FP26 FP27/PE7 FP28/PE6 FP29/PE5 FP30/PE4 FP31/PE3 FP32/PE2 FP33/PE1 FP34/PE0 | 0 0 0 0 0 0 0 0 0 |
| 15 14 13 48 49 50 51 | VLCD1 VLCD2 VLCD3 BP3/PD3 BP2/PD2 BP1/PD1 BP0 | | 9 10 11 12 Note 1.The NDI to V _{DD} . | FP35/PD7 FP36/PD6 FP37/PD5 FP38/PD4 _Y pin should be c | O O O O |

Table 1-1. Pin Configuration

General Release Specification

1.6.1 $\,V_{DD}$ and V_{SS}

Power is supplied to the MCU through V_{DD} and V_{SS} . V_{DD} is the positive supply, and V_{SS} is ground. The MCU operates from a single power supply. Very fast signal transitions occur on the MCU pins. The short rise and fall times place very high short-duration current demands on the power supply. To prevent noise problems, special care should be taken to provide good power supply bypassing at the MCU by using bypass capacitors with good high-frequency characteristics that are positioned as close to the MCU as possible. Bypassing requirements vary, depending on how heavily the MCU pins are loaded.

1.6.2 OSC1 and OSC2

The OSC1 and OSC2 pins are the connections for the 2-pin on-chip oscillator. The OSC1 and OSC2 pins can accept:

- A crystal as shown in Figure 1-3 (a)
- An external clock signal as shown in Figure 1-3 (b)

The frequency, f_{OSC} , of the oscillator or external clock source is divided by 64 to produce the internal operating frequency, f_{OP} , by default.

1.6.2.1 Crystal or Ceramic Resonator

The circuit in **Figure 1-3 (a)** shows a typical 2-pin oscillator circuit for an AT-cut, parallel resonant crystal. The crystal manufacturer's recommendations should be followed, as the crystal parameters determine the external component values required to provide maximum stability and reliable startup. The load capacitance values used in the oscillator circuit design should include all stray capacitances. The crystal and components should be mounted as close as possible to the pins for startup stabilization and to minimize output distortion. An internal startup feedback resistor of R_{OF} between OSC1 and OSC2 may be selected as a mask option for MC68HC05L5. Typical R_{OF} resistor value is 2 M Ω .

MOTOROLA

General Description



Figure 1-3. Oscillator Connections

1.6.2.2 External Clock

An external clock from another CMOS-compatible device can be connected to the OSC1 input, with the OSC2 input not connected, as shown in **Figure 1-3**. This configuration is possible regardless of how the oscillator is set up.

1.6.3 XOSC1 and XOSC2

The XOSC1 and XOSC2 pins are the connections for the 2-pin on-chip oscillator. The XOSC1 and XOSC2 pins can accept:

- A crystal as shown in Figure 1-4 (a)
- An external clock signal as shown in Figure 1-4 (b)

The frequency, f_{OSC} , of the oscillator or external clock source is divided by two to produce the internal operating frequency, f_{OP} , if selected by SYS1–SYS0 bits.

When XOSC is not used, the XOSC1 pin must be connected to the RESET pin to assure proper initialization of the clock circuitry. XOSC2 pin should remain unconnected.

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

MOTOROLA

General Description Functional Pin Description

1.6.3.1 Crystal Resonator

The circuit in **Figure 1-4 (a)** shows a typical 2-pin oscillator circuit for an AT-cut, parallel resonant crystal. The crystal manufacturer's recommendations should be followed, as the crystal parameters determine the external component values required to provide maximum stability and reliable startup. The load capacitance values used in the oscillator circuit design should include all stray capacitances. The crystal and components should be mounted as close as possible to the pins for startup stabilization and to minimize output distortion. An internal startup feedback resistor of R_{XOF} between XOSC1 and XOSC2 and a damping resistor of R_{XOF} in series to XOSC2 may be selected as a mask option. Typical R_{XOF} resistor value is 5.5 MΩ, and R_{XOD} resistor value is 320 kΩ.



Figure 1-4. Oscillator Connections

1.6.3.2 External Clock

An external clock from another CMOS-compatible device can be connected to the XOSC1 input, with the XOSC2 input not connected, as shown in **Figure 1-4 (b)**. This configuration is possible regardless of how the oscillator is set up.

| MC68HC(7 | ')05L5 — | Rev. | 2.0 |
|----------|----------|------|-----|
|----------|----------|------|-----|

General Description

1.6.4 **RESET**

This pin can be used as an input to reset the MCU to a known startup state by pulling it to the low state. When power is removed, the $\overline{\text{RESET}}$ pin contains a steering diode to discharge any voltage on the pin to V_{DD}. The $\overline{\text{RESET}}$ pin contains an internal Schmitt trigger to improve its noise immunity as an input. An internal $\overline{\text{RESET}}$ pin pullup resistor may be selected as a mask option. A typical pullup resistor value is 33 k Ω .

1.6.5 Port A (PA0-PA7)

Port A is an 8-bit I/O port. The state of any pin is software programmable and all port A lines are configured as inputs during power-on or reset. Port A outputs may be configured as open-drain outputs and connected to a pullup resistor by software option.

1.6.6 Port B (PB0–PB7/KWI0–KWI7)

Port B is an 8-bit input-only port that shares its lines with the key wakeup interrupt (KWI) system. Port B has a pullup option by software option.

1.6.7 Port C (PC0/SDI, PC1/SDO, PC2/SCK, PC3/TCAP, PC4/EVI, PC5/EVO, PC6/IRQ2, and PC7/IRQ1)

Port C is a 6-bit I/O port and 2-bit input-only port. The state of the PC0–PC5 pins are software programmable and all port C lines are configured as inputs during power-on or reset. All port C lines may connect to a pullup resistor by software option.

- Bits PC0–PC2 are shared with the SSPI subsystem and may be configured as open-drain outputs.
- Bit 3 is shared with the TCAP pin of timer 1 and may be configured as an open-drain output.
- Bit 4 is shared with the EVI bit of timer 2 and may be configured as an open-drain output.

MC68HC(7)05L5 - Rev. 2.0

28

Semiconductor, Inc

reescale

- Bit 5 is shared with the EVO bit of timer 2 and may be configured as an open-drain output.
- Bit 6 is shared with the IRQ2 input. This bit is an input-only pin.
- Bit 7 is shared with the $\overline{IRQ1}$ input. This bit is an input-only pin.

1.6.8 Port D (PD1-PD3/BP1-BP3 and PD4-PD7/FP34-FP27)

Port D is a 7-bit output-only port that shares its bits with the LCD backplane/frontplane drivers. Port D lines are configured as LCD outputs during power-on or reset. PD1–PD3 and PD4–PD7 outputs may be configured as open-drain outputs by a software option.

1.6.9 Port E (PE0-PE7/FP38-FP35)

Port E is an 8-bit output-only port that shares its bits with LCD frontplane drivers. Port E lines are configured as LCD outputs during power-on or reset. PE0–PE3 and PE4–PE7 outputs may be configured as open-drain outputs by a software option.

1.6.10 VLCD1, VLCD2, and VLCD3

These pins provide offset to the LCD driver bias for adjusting the contrast of the LCD.

1.6.11 NDLY

This pin is reserved for factory test and should be connected to V_{DD} in single-chip mode (user mode).

MC68HC(7)05L5-Rev. 2.0

General Description

1.7 Modes of Operation

The MC68HC05L5 has two operating modes:

- Single-chip mode (SCM)
- Self-check mode

Single-chip mode, also called user mode, allows maximum use of pins for on-chip peripheral functions.

The self-check capability of MC68HC05L5 provides an internal check to determine if the device is functional.

1.7.1 Mode Entry

Mode entry is done at the rising edge of the RESET pin. Once the device enters one of the modes, the mode cannot be changed by software. Only an external reset can change the mode.

At the rising edge of the RESET pin, the device latches the states of IRQ1 and IRQ2 and places itself in the specified mode. While the RESET pin is low, all pins are configured as single-chip mode. **Table 1-2** shows the states of IRQ1 and IRQ2 for each mode entry.

High voltage $V_{TST} = 2 \times V_{DD}$ is required to select modes other than single-chip mode.

| | | - | |
|-------------------------|-------|----------------------|----------------------|
| Modes | RESET | PC6/IRQ1 | PC7/IRQ2 |
| Single-chip (user) mode | - | V_{SS} or V_{DD} | V_{SS} or V_{DD} |
| Self-check mode | | V _{TST} | V _{DD} |

General Description Modes of Operation



Figure 1-5. Mode Entry Diagram

1.7.2 Single-Chip Mode (SCM)

In this mode, all address and data bus activity occurs within the MCU. Thus, no external pins are required for these functions. The single-chip mode allows the maximum number of I/O pins for on-chip peripheral functions, for example, ports A through E, and LCD drivers.

1.7.3 Self-Check Mode

In this mode, the reset vector is fetched from a 496-byte internal selfcheck ROM at \$3E00–\$3FEF. The self-check ROM contains a selfcheck program to test the functions of internal modules.

Since this mode is not a normal user mode, all of the privileged control bits are accessible. This allows the self-check mode to be used for self-test of the device.

MC68HC(7)05L5 - Rev. 2.0

General Description

General Release Specification

Section 2. Memory Map

2.1 Contents

| 2.2 | Introduction | 34 |
|-------|---|----|
| 2.3 | Input/Output and Control Registers | 35 |
| 2.3.1 | Read/Write Bits | 35 |
| 2.3.2 | Read-Only Bits | 35 |
| 2.3.3 | Write-Only Bits | 35 |
| 2.3.4 | Reserved Bits | 36 |
| 2.3.5 | Reset Value | 36 |
| 2.3.6 | Option Map | 36 |
| 2.4 | Summary of Internal Registers and I/O Map | 37 |
| 2.5 | Option Map for I/O Configurations | 43 |
| 2.5.1 | Resistor Control Register 1 | 45 |
| 2.5.2 | Resistor Control Register 2 | 46 |
| 2.5.3 | Open-Drain Output Control Register 1 | 46 |
| 2.5.4 | Open-Drain Output Control Register 2 | 48 |
| 2.5.5 | Key Wakeup Input Enable Register | 48 |
| 2.5.6 | Mask Option Status Register | 49 |
| 2.6 | RAM | 50 |
| 2.7 | Self-Check ROM | 50 |
| 2.8 | Mask ROM | 50 |
| | | |

Memory Map

2.2 Introduction

The MC68HC05L5 contains an 8,192-byte mask ROM, 480 bytes of selfcheck ROM, and 256 bytes of RAM. An additional 16 bytes of mask ROM are provided for user vectors at \$3FF0-\$3FFF.

The MCU's memory map is shown in Figure 2-1.



Figure 2-1. Memory Map

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

MOTOROLA

34

2.3 Input/Output and Control Registers

The input/output (I/O) and control registers reside in locations \$0000–\$003F. A summary of these registers is shown in **Figure 2-3**. The bit assignments for each register are shown in **Figure 2-4**. Reading from unimplemented bits (denoted by shading) will return unknown states (unless explicitly defined to read 0), and writing to unimplemented bits will have no effect. See also **Figure 2-2**.



Figure 2-2. Register Description Key

2.3.1 Read/Write Bits

Read/write bits are typically control bits. They are, in general, not modified by a module. Reset indicates the initial value of the latch.

2.3.2 Read-Only Bits

Read-only bits are status flag bits. They are indicators of module status. Reset indicates the value that will be read immediately after system reset or before the module is enabled.

MOTOROLA

Memory Map

2.3.3 Write-Only Bits

Write-only bits are control bits. They typically return a state of 0 to prevent an inadvertent write to this bit by a READ-MODIFY-WRITE instruction. Reset indicates the value that will be read immediately after system reset, which is the forced read value (typically 0).

2.3.4 Reserved Bits

Reserved bits are read-only bits that typically read 0. Writes to these bits are ignored, and the user should not write 1 for future compatibility. Reset indicates the value that will be read immediately after system reset which is the forced read value (typically 0).

2.3.5 Reset Value

Values specified on the row marked *Reset:* are initial values of register bits after system reset. Those bits unaffected by reset are marked with the letter U. Those bits that are unaffected by reset but initialized by power-on reset are marked with an asterisk (*).

2.3.6 Option Map

Address locations \$0000–\$000F are dual mapped. When the OPTM bit in the MISC register is cleared, the main address map is accessed. When the OPTM bit in the MISC register is set, the option address map is accessed.

NOTE: Although not necessary for this device, for future compatibility the OPTM bit should be cleared when accessing memory locations \$0010 and above.
2.4 Summary of Internal Registers and I/O Map

Figure 2-3 contains a detailed memory map of the I/O registers.

| Addr. | Register Name | | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|--------|--|-----------------|-------|-------------|--------|-----------|------------|------------|-----|------------|
| \$0000 | Port A Data Register (PORTA) | Read: Write: | PA7 | PA6 | PA5 | PA4 | PA3 | PA2 | PA1 | PA0 |
| | | Reset: | | | | Unaffecte | d by reset | | | |
| \$0001 | Port B Data Register (PORTB) | Read: Write: | PB7 | PB6 | PB5 | PB4 | PB3 | PB2 | PB1 | PB0 |
| | (, , , , , , , , , , , , , , , , , , , | Reset: | | | | Unaffecte | d by reset | | | |
| \$0002 | Port C Data Register (PORTC) | Read: Write: | PC7 | PC6 | PC5 | PC4 | PC3 | PC2 | PC1 | PC0 |
| | | Reset: | | • | | Unaffecte | d by reset | | | |
| \$0003 | Port D Data Register (PORTD) | Read: Write: | PD7 | PD6 | PD5 | PD4 | PD3 | PD2 | PD1 | 1 |
| | | Reset: | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| \$0004 | Port E Data Register (PORTE) | Read: Write: | PE7 | PE6 | PE5 | PE4 | PE3 | PE2 | PE1 | PE0 |
| | (FORTE) | Reset: | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| \$0005 | Reserved | [| R | R | R | R | R | R | R | R |
| \$0006 | Reserved | [| R | R | R | R | R | R | R | R |
| \$0007 | Reserved | [| R | R | R | R | R | R | R | R |
| \$0008 | Interrupt Control Register (INTCR) | Read: Write: | IRQ1E | IRQ2E | 0 | KWIE | IRQ1S | IRQ2S | 0 | 0 |
| | | Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| \$0009 | Interrupt Status Register | | IRQ1F | IRQ2F | 0 | KWIF | 0 RIRQ1 | 0 RIRQ2 | 0 | 0 RKWIF |
| | (INTSR) | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | | [| |] = Unimple | mented | R | = Reserve | èd | | |
| | _ | | | | | | | | | |

Figure 2-3. Main I/O Map (Sheet 1 of 6)

Memory Map

| Addr. | Register Name | | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|--------|---|------------------|---------|-----------|---------|-----------|------------|--------|------------|-------|
| \$000A | Serial Peripheral Control | Read: Write: | SPIE | SPE | DORD | MSTR | 0 | 0 | 0 | SPR |
| | Register (SPCR) | Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Serial Peripheral Status Register | Read: | SPIF | DCOL | 0 | 0 | 0 | 0 | 0 | 0 |
| \$000B | (SPSR) | Write: Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| \$000C | Serial Peripheral Data Register (SPDR) | Read: Write: | MSB | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 2 | LSB |
| | | Reset: | | | | Unaffecte | d by reset | | | |
| \$000D | Reserved | [| R | R | R | R | R | R | R | R |
| \$000E | Reserved | [| R | R | R | R | R | R | R | R |
| \$000F | Reserved | [| R | R | R | R | R | R | R | R |
| \$0010 | Timer Base Control Register 1 (TBCR1) | Read: Write: | TBCLK | 0 | LCLK | 0 | 0 | 0 | T2R1 | T2R0 |
| | | Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | Timer Base Control Register 2 | Read: | TBIF | TBIE | TBR1 | TBR0 | 0 | 0 | 0 | 0 |
| \$0011 | (TBCR2) | Write: | 0 | | | | RTBIF | | COPE | COPC |
| | | Reset: | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 |
| \$0012 | Timer Control Register (TCR) | Read: Write: | ICIE | OC1IE | TOIE | 0 | 0 | 0 | IEDG | OLVL |
| | (, | Reset: | 0 | 0 | 0 | 0 | 0 | 0 | U | 0 |
| | Timer Status Register | Read: | ICF | OC1F | TOF | 0 | 0 | 0 | 0 | 0 |
| \$0013 | (TSR) | Write: | | | | | | | | |
| | | Reset: | U | U | U | 0 | 0 | 0 | 0 | 0 |
| | Input Capture Register High | Read: | BIT 15 | BIT 14 | BIT 13 | BIT 12 | BIT 11 | BIT 10 | BIT 9 | BIT 8 |
| \$0014 | (ICH) | Write: | | | | | | | | |
| | | Reset: | | | | Unaffecte | d by reset | | | |
| | | [| | = Unimple | emented | R | = Reserve | ed | U = Unaffe | cted |
| | F | igure | 2-3. Ma | ain I/O I | Map (Sł | neet 2 o | f 6) | | | |

General Release Specification

MC68HC(7)05L5-Rev. 2.0

Memory Map Summary of Internal Registers and I/O Map

| Addr. | Register Name | | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 | | |
|--------|--|-----------------|---------------------|---------------------|---------|-----------|------------|------------|----------|------------|--|--|
| | Input Capture Register Low | Read: | BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 | | |
| \$0015 | (ICL) | Write: | | | | | | | | | | |
| | () | Reset: | | | | Unaffecte | d by reset | | | | | |
| \$0016 | Output Compare Register 1 High (OC1H) | Read: Write: | BIT 15 | BIT 14 | BIT 13 | BIT 12 | BIT 11 | BIT 10 | BIT 9 | BIT 8 | | |
| | (000.0) | Reset: | | | | Unaffecte | d by reset | | | | | |
| \$0017 | Output Compare Register 1 Low (OC1L) | Read: Write: | BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 | | |
| | (0012) | Reset: | | | | Unaffecte | d by reset | | | | | |
| \$0018 | Timer Counter Register High (TCNTH) | Read: Write: | BIT 15 | BIT 14 | BIT 13 | BIT 12 | BIT 11 | BIT 10 | BIT 9 | BIT 8 | | |
| | | Reset: | Unaffected by reset | | | | | | | | | |
| \$0019 | Timer Counter Register Low (TCNTL) | Read: Write: | BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 | | |
| | (IGNIE) | Reset: | | Unaffected by reset | | | | | | | | |
| \$001A | Alternate Timer Counter Register High (ACNTH) | Read: Write: | BIT 15 | BIT 14 | BIT 13 | BIT 12 | BIT 11 | BIT 10 | BIT 9 | BIT 8 | | |
| | Register high (ACNTH) | Reset: | | | | Unaffecte | d by reset | | | | | |
| \$001B | Alternate Timer Counter Register Low (ACMTL) | Read: Write: | BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 | | |
| | | Reset: | | 1 | 1 | Unaffecte | d by reset | | | | | |
| \$001C | Timer Control Register 2 (TCR2) | Read: Write: | TI2IE | OC2IE | 0 | T2CLK | IM2 | IL2 | OE2 | OL2 | | |
| | (1012) | Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |
| \$001D | Timer Status Register 2 (TSR2) | Read: Write: | TI2F | OC2F | 0 | 0 | 0 RTI2F | 0 ROC2F | 0 | 0 | | |
| | (1312) | Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |
| \$001E | Output Compare Register 2 (OC2) | Read: Write: | BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 | | |
| | (002) | Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | | |
| | | [| | = Unimple | emented | | | | | | | |
| | F | igure | 2-3. Ma | ain I/O I | Map (Sh | neet 3 o | f 6) | | | | | |
| MC68 | HC(7)05L5 — Rev. 2.0 | | | | | | Ge | neral Rel | ease Spe | cification | | |

Memory Map

| Addr. | Register Name | | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|--------|-------------------------------------|-----------------|---------------------|-------|-------|-----------|------------|-------|-------|-------|
| \$001F | Timer Counter Register 2 (TCNT2) | Read: Write: | BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
| | (10112) | Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| \$0020 | LCD Control Register (LCDCR) | Read: Write: | LCDE | DUTY1 | DUTY0 | 0 | PEH | PEL | PDH | 0 |
| | (2020) | Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| \$0021 | LCD Data Register 1 (LCDR1) | Read: Write: | F1B3 | F1B2 | F1B1 | F1B0 | F0B3 | F0B2 | F0B1 | F0B0 |
| | | Reset: | Unaffected by reset | | | | | | | |
| \$0022 | LCD Data Register 2 (LCDR2) | Read: Write: | F3B3 | F3B2 | F3B1 | F3B0 | F2B3 | F2B2 | F2B1 | F2B0 |
| | (LODINZ) | Reset: | | | | Unaffecte | d by reset | | | |
| \$0023 | LCD Data Register 3 (LCDR3) | Read: Write: | F5B3 | F5B2 | F5B1 | F5B0 | F4B3 | F4B2 | F4B1 | F4B0 |
| | (20210) | Reset: | | | | Unaffecte | d by reset | | | |
| \$0024 | LCD Data Register 4 (LCDR4) | Read: Write: | F7B3 | F7B2 | F7B1 | F7B0 | F6B3 | F6B2 | F6B1 | F6B0 |
| | | Reset: | | | | Unaffecte | d by reset | | | |
| \$0025 | LCD Data Register 5 (LCDR5) | Read: Write: | F9B3 | F9B2 | F9B1 | F9B0 | F8B3 | F8B2 | F8B1 | F8B0 |
| | (LODIO) | Reset: | | | | Unaffecte | d by reset | | | |
| \$0026 | LCD Data Register 6 (LCDR6) | Read: Write: | F11B3 | F11B2 | F11B1 | F11B0 | F10B3 | F10B2 | F10B1 | F10B0 |
| | (20010) | Reset: | | | | Unaffecte | d by reset | | | |
| \$0027 | LCD Data Register 7 (LCDR7) | Read: Write: | F13B3 | F13B2 | F13B1 | F13B0 | F12B3 | F12B2 | F12B1 | F12B0 |
| | (200) | Reset: | | | | Unaffecte | d by reset | | | |

Figure 2-3. Main I/O Map (Sheet 4 of 6)

Freescale Semiconductor, Inc.

Memory Map Summary of Internal Registers and I/O Map

| Addr. | Register Name | | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|--------|----------------------------------|-----------------|-------|-------|-------|-----------|------------|-------|-------|-------|
| \$0028 | LCD Data Register 8 (LCDR8) | Read: Write: | F15B3 | F15B2 | F15B1 | F15B0 | F14B3 | F14B2 | F14B1 | F14B0 |
| | (LODINO) | Reset: | | | | Unaffecte | d by reset | | | |
| \$0029 | LCD Data Register 9 (LCDR9) | Read: Write: | F17B3 | F17B2 | F17B1 | F17B0 | F16B3 | F16B2 | F16B1 | F16B0 |
| | | Reset: | | | | Unaffecte | d by reset | | | |
| \$002A | LCD Data Register 10 (LCDR10) | Read: Write: | F19B3 | F19B2 | F19B1 | F19B0 | F18B3 | F18B2 | F18B1 | F18B0 |
| | | Reset: | | | | Unaffecte | d by reset | | | |
| \$002B | LCD Data Register 11 (LCDR11) | Read: Write: | F21B3 | F21B2 | F21B1 | F21B0 | F20B3 | F20B2 | F20B1 | F20B0 |
| | | Reset: | | I | | Unaffecte | d by reset | | | |
| \$002C | LCD Data Register 12 (LCDR12) | Read: Write: | F23B3 | F23B2 | F23B1 | F23B0 | F22B3 | F22B2 | F22B1 | F22B0 |
| | () | Reset: | | | | Unaffecte | d by reset | | | |
| \$002D | LCD Data Register 13 (LCDR13) | Read: Write: | F25B3 | F25B2 | F25B1 | F25B0 | F24B3 | F24B2 | F24B1 | F24B0 |
| | | Reset: | | | | Unaffecte | d by reset | | | |
| \$002E | LCD Data Register 14 (LCDR14) | Read: Write: | F27B3 | F27B2 | F27B1 | F27B0 | F26B3 | F26B2 | F26B1 | F26B0 |
| | | Reset: | | | | Unaffecte | d by reset | | | |
| \$002F | LCD Data Register 15 (LCDR15) | Read: Write: | F29B3 | F29B2 | F29B1 | F29B0 | F28B3 | F28B2 | F28B1 | F28B0 |
| | (2021(10) | Reset: | | | | Unaffecte | d by reset | | | |
| \$0030 | LCD Data Register 16 (LCDR16) | Read: Write: | F31B3 | F31B2 | F31B1 | F31B0 | F30B3 | F30B2 | F30B1 | F30B0 |
| | (2001(10) | Reset: | | | | Unaffecte | d by reset | | | |

Figure 2-3. Main I/O Map (Sheet 5 of 6)

Memory Map

| Addr. | Register Name | | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|-------------------------|--|-----------------|----------|-------------|---------|-----------|------------|-------|-------|-------|
| \$0031 | LCD Data Register 17 (LCDR17) | Read: Write: | F33B3 | F33B2 | F33B1 | F33B0 | F32B3 | F32B2 | F32B1 | F32B0 |
| | | Reset: | | | | Unaffecte | d by reset | | | |
| \$0032 | LCD Data Register 18 (LCDR18) | Read: Write: | F35B3 | F35B2 | F35B1 | F35B0 | F34B3 | F34B2 | F34B1 | F34B0 |
| | | Reset: | | | | Unaffecte | d by reset | | | |
| \$0033 | LCD Data Register 19 (LCDR19) | Read: Write: | F37B3 | F37B2 | F37B1 | F37B0 | F36B3 | F36B2 | F36B1 | F36B0 |
| | (2001(17) | Reset: | | • | | Unaffecte | d by reset | | | |
| \$0034 | LCD Data Register 20 (LCDR20) | Read: Write: | 0 | 0 | 0 | 0 | F38B3 | F38B2 | F38B1 | F38B0 |
| | | Reset: | | 1 | | Unaffecte | d by reset | | | |
| \$0035 | Reserved | [| R | R | R | R | R | R | R | R |
| \$0036 | Reserved | [| R | R | R | R | R | R | R | R |
| \$0037 | Reserved | [| R | R | R | R | R | R | R | R |
| \$0038 | Reserved | [| R | R | R | R | R | R | R | R |
| \$0039 | Reserved | [| R | R | R | R | R | R | R | R |
| \$003A | Reserved | [| R | R | R | R | R | R | R | R |
| \$003B | Reserved | [| R | R | R | R | R | R | R | R |
| \$003C | Reserved | [| R | R | R | R | R | R | R | R |
| \$003D | Reserved | [| R | R | R | R | R | R | R | R |
| \$003E | Miscellaneous Register | Read: Write: | FTUP | STUP | 0 | 0 | SYS1 | SYS0 | FOSCE | OPTM |
| | (MISC) | Reset: | * | * | 0 | 0 | 1 | 0 | 1 | 0 |
| \$003F | Reserved | [| R | R | R | R | R | R | R | R |
| * Unaffectec power-o | d by reset but initialized by n reset | | |] = Unimple | mented | R | = Reserve | | | |
| Poner 0 | | iauro | 2_2 M | ain I/O I | | | J | u | | |
| | F | gure | 2-3. IVI | | map (31 | 1661 0 0 | 0 | | | |

General Release Specification

MC68HC(7)05L5-Rev. 2.0

2.5 Option Map for I/O Configurations

Most of the I/O configurations are done in the option map (**Figure 2-4**). Some options still remain as mask options for the MC68HC05L5 such as a pullup resistor for the RESET pin and resistors for the OSC1/OSC2 and XOSC1/XOSC2 pins. These mask options may be read by the MOSR (\$000F) in the option map.

The option map is located at 0000-000F of the main memory map and it is available when the OPTM bit in the MISC register (003E) is set. Main registers at 0000-000F are not available when OPTM = 1.

I/O port data direction registers are contained in the option map in **Figure 2-4**.

| Addr. | Register Name | | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|--------|---|-----------------|-------|-----------|-------|-------|-------|-------|-------|-------|
| \$0000 | Port A Data Direction Register (DDRA) | Read: Write: | DDRA7 | DDRA6 | DDRA5 | DDRA4 | DDRA3 | DDRA2 | DDRA1 | DDRA0 |
| | (DDIA) | Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| \$0001 | Reserved | | R | R | R | R | R | R | R | R |
| \$0002 | Port C Data Direction Register (DDRC) | Read: Write: | 0 | 0 | DDRC5 | DDRC4 | DDRC3 | DDRC2 | DDRC1 | DDRC0 |
| | (22) | Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| \$0003 | Reserved | | R | R | R | R | R | R | R | R |
| \$0004 | Reserved | [| R | R | R | R | R | R | R | R |
| \$0005 | Reserved | [| R | R | R | R | R | R | R | R |
| \$0006 | Reserved | [| R | R | R | R | R | R | R | R |
| \$0007 | Reserved | [| R | R | R | R | R | R | R | R |
| \$0008 | Read Resistor Control Register 1 (RCR1) | | 0 | 0 | 0 | 0 | RBH | RBL | RAH | RAL |
| | (RCRT) Reset: | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | | [| R | = Reserve | ed | | | | | |

Figure 2-4. Option Map (Sheet 1 of 2)

MC68HC(7)05L5-Rev. 2.0

Memory Map

| Addr. | Register Name | | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|--------|--|-----------------|--------------------|-----------|---------|--------|-----------|-------|------------|-------|
| \$0009 | Resistor Control Register 2 (RCR2) | Read: Write: | RC7 | RC6 | RC5 | RC4 | RC3 | RC2 | RC1 | RC0 |
| | (((()(2)) | Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| \$000A | Open-Drain Output Control Register 1 (WOM1) | Read: Write: | DWOMH | DWOML | EWOMH | EWOML | 0 | 0 | AWOMH | AWOML |
| | | Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| \$000B | Open-Drain Output Control Register 2 (WOM2) | Read: Write: | 0 | 0 | CWOM5 | CWOM4 | CWOM3 | CWOM2 | CWOM1 | CWOM0 |
| | | Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| \$000C | Reserved | [| R | R | R | R | R | R | R | R |
| \$000D | Reserved | [| R | R | R | R | R | R | R | R |
| \$000E | Key Wakeup Input Enable Register (KWIEN) | Read: Write: | KWIE7 | KWIE6 | KWIE5 | KWIE4 | KWIE3 | KWIE2 | KWIE1 | KWIE0 |
| | | Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| \$000F | Mack Option Status Dogistor | Read: Write: | RSTR | OSCR | XOSCR | 0 | 0 | 0 | 0 | 0 |
| φυυυ | Mask Option Status Register Write: Reset: | | U | U | U | 0 | 0 | 0 | 0 | 0 |
| | F | iaure | 2-4 0 | = Unimple | emented | R R | = Reserve | ed | U = Unaffe | cted |
| | | guid | - - - U | | | | <i>-,</i> | | | |

General Release Specification

MC68HC(7)05L5-Rev. 2.0

Memory Map Option Map for I/O Configurations

2.5.1 Resistor Control Register 1

Address: Option Map — \$0008

| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|-----------------|-------|---|---|---|-----|-----|-----|-------|
| Read: Write: | 0 | 0 | 0 | 0 | RBH | RBL | RAH | RAL |
| Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Figure 2-5. Resistor Control Register 1 (RCR1)

Bits 7-4 - Reserved

These bits are not used and always read as logic 0.

RBH — Port B Pullup Resistor (H)

When this bit is set, pullup resistors are connected to the upper four bits of port B. This bit is cleared on reset.

RBL — Port B Pullup Resistor (L)

When this bit is set, pullup resistors are connected to the lower four bits of port B. This bit is cleared on reset.

RAH — Port A Pullup Resistor (H)

When this bit is set, pullup resistors are connected to the upper four bits of port A. This bit is cleared on reset.

RAL — Port A Pullup Resistor (L)

When this bit is set, pullup resistors are connected to the lower four bits of port A. This bit is cleared on reset.

Memory Map

2.5.2 Resistor Control Register 2



Figure 2-6. Resistor Control Register 2 (RCR2)

RCx — Port C Pullup Resistor (Bitx)

When RC*x* bit is set, the pullup resistor is connected to the corresponding bit of port C. This bit is cleared on reset.

2.5.3 Open-Drain Output Control Register 1

Address: Option Map — \$000A

| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|-----------------|-------|-------|-------|-------|---|---|-------|-------|
| Read: Write: | DWOMH | DWOML | EWOMH | EWOML | 0 | 0 | AWOMH | AWOML |
| Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Figure 2-7. Open-Drain Output Control Register 1 (WOM1)

DWOMH — Port D Open-Drain Mode (H)

When this bit is set, the upper four bits of port D are configured as open-drain outputs if these bits are selected as port D output by the PDH bit in the LCDCR. This bit is cleared on reset.

DWOML — Port D Open-Drain Mode (L)

When this bit is set, the lower three bits of port D are configured as open-drain outputs if the corresponding BPx pin is not used by the LCD driver. This bit is cleared on reset.

MC68HC(7)05L5 - Rev. 2.0

EWOMH — Port E Open-Drain Mode (H)

When this bit is set, the upper four bits of port E (that are configured as I/O output by the PEH bit in the LCDCR) are configured as opendrain outputs. This bit is cleared on reset.

EWOML — Port E Open-Drain Mode (L)

When this bit is set, the lower four bits of port E (that are configured as I/O output by the PEL bit in the LCDCR) are configured as opendrain outputs. This bit is cleared on reset.

Bits 3 and 2 — Reserved

These bits are not used and always return to logic 0.

AWOMH — Port A Open-Drain Mode (H)

When this bit is set, the upper four bits of port A that are configured as output (corresponding to the DDRA bit set) become open-drain outputs. This bit is cleared on reset.

AWOML — Port E Open-Drain Mode (L)

When this bit is set, the lower four bits of port A that are configured as output (corresponding DDRA bit set) become open-drain outputs. This bit is cleared on reset.

Memory Map

2.5.4 Open-Drain Output Control Register 2

Address: Option Map — \$000B

| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|-----------------|-------|---|-------|-------|-------|-------|-------|-------|
| Read: Write: | 0 | 0 | CWOM5 | CWOM4 | CWOM3 | CWOM2 | CWOM1 | CWOM0 |
| Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Figure 2-8. Open-Drain Output Control Register 2 (WOM2)

Bits 7 and 6 — Reserved

These bits are not used and always read as logic 0.

CWOM*x* — Port C Open-Drain Mode (Bit*x*)

When CWOMx bit is set, port C bits x are configured as open-drain outputs if DDRCx is set. This bit is cleared on reset.

2.5.5 Key Wakeup Input Enable Register

Address: Option Map — \$000E

| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|--------|-------|-------|-------|-------|-------|-------|-------|-------|
| Read: | KWIE7 | KWIE6 | KWIE5 | KWIE4 | KWIE3 | KWIE2 | KWIE1 | KWIE0 |
| Write: | | RWIEO | KWIE5 | | KWIE5 | | | KWILO |
| Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Figure 2-9. Key Wakeup Input Enable Register (KWIEN)

KWIEx — Key Wakeup Input Enable (Bitx)

When KWIE*x* bit is set, the KWI*x* (PB*x*) input is enabled for key wakeup interrupt. This bit is cleared on reset.

MC68HC(7)05L5-Rev. 2.0

2.5.6 Mask Option Status Register

The mask option status register (MOSR) indicates the state of mask options specified prior to production of the MC68HC05L5.

Address: Option Map — \$000F



Figure 2-10. Mask Option Status Register (MOSR)

RSTR — RESET Pin Pullup Resistor

When this bit is set, it indicates an internal pullup resistor is attached to the $\overline{\text{RESET}}$ pin by mask option.

OSCR — OSC Feedback Resistor

When this bit is set, it indicates that an internal feedback resistor is attached between OSC1 and OSC2 by mask option.

XOSCR — OSC Feedback Resistor

When this bit is set, it indicates that an internal feedback resistor is attached between XOSC1 and XOSC2. The damping resistor at the XOSC2 pin is attached by mask option.

Bits 4-0 — Reserved

These bits are not used and always read as logic 0.

MC68HC(7)05L5-Rev. 2.0

Memory Map

2.6 RAM

The 256-byte internal RAM is positioned at \$0040–\$013F in the memory map. The lower 192 bytes are positioned in the page zero which are accessible by the direct addressing mode. The upper 64 bytes of this area (page zero) are used for the CPU stack area. Care should be taken if the stack area is used for data storage.

The remaining 64 byte of RAM at \$0100–\$013F are accessed by extended addressing mode.

The RAM is implemented with static cells and retains its contents during the stop and wait modes.

2.7 Self-Check ROM

Self-check ROM is 480 bytes of mask ROM positioned at \$3E00-\$3FDF. This ROM contains self-check programs and reset/interrupt vectors in the self-check mode.

2.8 Mask ROM

The 8,192-byte user ROM is positioned at \$1000–\$2FFF, and an additional 16 bytes of ROM are located at \$3FF0–\$3FFF for user vectors.

General Release Specification

MC68HC(7)05L5-Rev. 2.0

Section 3. Central Processor Unit (CPU)

3.1 Contents

| 3.2 | Introduction |
|-----|---------------------------|
| 3.3 | CPU Registers |
| 3.4 | Accumulator |
| 3.5 | Index Register |
| 3.6 | Condition Code Register53 |
| 3.7 | Stack Pointer |
| 3.8 | Program Counter |
| 3.9 | Arithmetic/Logic Unit |

3.2 Introduction

This section describes the central processor unit (CPU).

MC68HC(7)05L5 - Rev. 2.0

Central Processor Unit (CPU)

3.3 CPU Registers

The MCU contains five registers as shown in **Figure 3-1**. The interrupt stacking order is shown in **Figure 3-2**.







NOTE: Since the stack pointer decrements during pushes, the PCL is stacked first, followed by PCH, etc. Pulling from the stack is in the reverse order.

Figure 3-2. Stacking Order

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

MOTOROLA

3.4 Accumulator

The accumulator (A) is a general-purpose, 8-bit register used to hold operands and results of arithmetic calculations or data manipulations.

| 7 | | 0 |
|---|---|---|
| | А | |

3.5 Index Register

The index register (X) is an 8-bit register used for the indexed addressing value to create an effective address. The index register may also be used as a temporary storage area.

| 7 | | 0 |
|---|---|---|
| | Х | |

3.6 Condition Code Register

The condition code register (CCR) is a 5-bit register in which the H, N, Z, and C bits are used to indicate the results of the instruction just executed, and the I bit is used to enable or disable interrupts. These bits can be tested individually by a program, and specific actions can be taken as a result of their state. Each bit is explained in the following paragraphs.



Half Carry (H)

This bit is set during ADD and ADC operations to indicate that a carry occurred between bits 3 and 4.

Interrupt (I)

When this bit is set, the timer and external interrupt are masked (disabled). If an interrupt occurs while this bit is set, the interrupt is latched and processed as soon as the I bit is cleared.

MOTOROLA

Negative (N)

When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was negative.

Zero (Z)

When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was 0.

Carry/Borrow (C)

When set, this bit indicates that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the last arithmetic operation. This bit is affected also during bit test and branch instructions and during shifts and rotates.

3.7 Stack Pointer

The stack pointer (SP) contains the address of the next free location on the stack. During an MCU reset or the reset stack pointer (RSP) instruction, the stack pointer is set to location \$00FF. The stack pointer is then decremented as data is pushed onto the stack and incremented as data is pulled from the stack.

When accessing memory, the eight most significant bits are permanently set to 00000011. These eight 0 bits are appended to the six least significant register bits to produce an address within the range of \$00FF to \$00C0. Subroutines and interrupts may use up to 64 (decimal) locations. If 64 locations are exceeded, the stack pointer wraps around and loses the previously stored information. A subroutine call occupies two locations on the stack; an interrupt uses five locations.



MC68HC(7)05L5-Rev. 2.0

54

3.8 Program Counter

The program counter (PC) is a 14-bit register that contains the address of the next byte to be fetched.

| 13 | | 0 |
|----|----|---|
| | PC | |

3.9 Arithmetic Logic Unit

The arithmetic logic unit (ALU) performs the arithmetic and logical operations defined by the instruction set.

The binary arithmetic circuits decode instructions and set up the ALU for the selected operation. Most binary arithmetic is based on the addition algorithm, carrying out subtraction as negative addition. Multiplication is not performed as a discrete operation but as a chain of addition and shift operations within the ALU. The multiply instruction (MUL) requires 11 internal processor cycles to complete this chain of operations.

Central Processor Unit (CPU)

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

Section 4. Resets and Interrupts

4.1 Contents

| 4.2 | Introduction |
|-------|---|
| 4.3 | Interrupts |
| 4.3.1 | IRQ1 and IRQ2 |
| 4.3.2 | Key Wakeup Interrupt (KWI) |
| 4.3.3 | IRQ (KWI) Software Consideration |
| 4.3.4 | Timer 1 Interrupt64 |
| 4.3.5 | Timer 2 Interrupt64 |
| 4.3.6 | SSPI Interrupt64 |
| 4.3.7 | Timebase Interrupt64 |
| 4.4 | Interrupt Control Register64 |
| 4.5 | Interrupt Status Register |

4.2 Introduction

In user operating modes, the reset/interrupt vectors are located at the top of the address space (\$3FF0-\$3FFF). In self-check mode, the reset/interrupt vectors are located at \$3FE0-\$3FEF in the internal self-check ROM. Descriptions in this section assume a user operating mode is in use. **Table 4-1** shows the address assignments for the vectors.

MC68HC(7)05L5-Rev. 2.0

Resets and Interrupts

| Vector Address | Interrupt | Masked by | Local Mask | Priority (1 = Highest) | |
|-------------------|-----------|------------------------------|-------------------------|---------------------------|------------------------------|
| 3FF0-3FF1 | Timebase | | l bit | TBIE | 7 |
| 3FF2–3FF3 | SSPI | | l bit | SPIE | 6 |
| 3FF4–3FF5 | Timer 2 | TI2I OC2I | l bit I bit | TI2IE OC2IE | 5 5 |
| 3FF6–3FF7 | Timer 1 | ICI OC1I TOI | l bit I bit I bit | ICIE OC1IE TOIE | 4 4 4 |
| 3FF8–3FF9 | KWI | | l bit | KWIE | 3 |
| 3FFA-3FFB | IRQ | IRQ1 IRQ2 | l bit I bit | IRQ1E IRQ2E | 2 2 |
| 3FFC-3FFD | SWI | | None | None | Same level as an instruction |
| 3FFE-3FFF | Reset | COP RESET pin Power-on | None None None | COPE None None | 1 1 1 |

Table 4-1. Interrupt Vector Assignments

Upon reset, the I bit in the condition code register is set and interrupts are disabled (masked). When an interrupt occurs, the I bit is set automatically by hardware after stacking the condition code register (CCR). All interrupts in the MC68HC05L5 follow a fixed hardware priority circuit to resolve simultaneous requests.

Each interrupt has a software programmable interrupt mask bit which may be used to selectively inhibit automatic hardware response. In addition, the I bit in the CCR acts as a class inhibit mask to inhibit all sources in the I-bit class. RESET and software interrupt (SWI) are not masked by the I bit in the CCR.

SWI is an instruction rather than a prioritized asynchronous interrupt source. In a sense, it is lower in priority than any source because once any interrupt sequence has begun, SWI cannot override it. In another sense, it is higher in priority than any hardware sources, except reset, because once the SWI opcode is fetched, no other sources can be honored until after the first instruction in the SWI service routine has been executed. SWI causes the I mask bit in the CCR to be set.

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

4.3 Interrupts

There are six hardware interrupt sources in the MC68HC05L5:

- IRQ1 and IRQ2
- Key wakeup interrupt (KWI)
- Timer 1 (TOI, ICI, and OC1I)
- Timer 2 (TI2I and OC2I)
- Serial transfer complete interrupt (SSPI)
- Timebase interrupt (TBI)

4.3.1 IRQ1 and IRQ2

Two external interrupt request inputs, IRQ1 and IRQ2, share the same vector address at \$3FFA and \$3FFB.

Bits IRQ1S and IRQ2S in interrupt control register (INTCR) control whether $\overline{IRQ1}$ and $\overline{IRQ2}$, respectively, respond only to the falling edge or falling edge and low level to trigger an interrupt. The $\overline{IRQ1}$ and $\overline{IRQ2}$ are enabled by IRQ1E and IRQ2E bits and IRQ1F and IRQ2F bits are provided as an indicator in the interrupt status register (INTSR). Since the IRQ1(2)F can be set by either the pins or the data latches of PC7(6), be sure to clear the flags by software before setting the IRQ1(2)E bit.

The $\overline{\text{IRQ1}}$ and the $\overline{\text{IRQ2}}$ pins are shared with port C bit 7 and bit 6, respectively, and $\overline{\text{IRQ2}}$ pin states can be determined by reading port C pins. The BIL and BIH instructions apply only to the $\overline{\text{IRQ1}}$ input.

4.3.2 Key Wakeup Interrupt (KWI)

Eight key wakeup inputs ($\overline{KWI0}-\overline{KWI7}$) share pins with port B. Each key wakeup input is enabled by the corresponding bit in the KWIEN register which resides in the option map, and \overline{KWI} is enabled by the KWIE bit in the INTCR. When a falling edge is detected at one of the enabled key wakeup inputs, the KWIF bit in the INTSR is set and \overline{KWI} is generated if KWIE = 1. Each input has a latch which responds only to the falling edge at the pin, and all input latches are cleared at the same time by clearing the KWIF bit. See **Figure 4-6**.

MOTOROLA

Resets and Interrupts

4.3.3 IRQ (KWI) Software Consideration

IRQ and KWI interrupts have a timing delay in a case described in **Figure 4-2**. This section shows programming for proper interrupts with IRQ or KWI.

Figure 4-1 shows an example of timer 1 interrupt. In this case, the interrupt by TOF occurs as soon as the TOIE (timer 1 overflow interrupt enable) bit is set.



Figure 4-1. Timer 1 Interrupt

Figure 4-2 shows an example of $\overline{IRQ1}$ interrupt. In this case, the interrupt occurs **after** execution the instruction following the instruction which sets IRQ1E bit. The similar action occurs against $\overline{IRQ2}$ and \overline{KWI} interrupts.



Figure 4-2. IRQ Timing Delay

This problem can be solved by using a software patch like **Figure 4-3**. A similar procedure could be used for $\overline{IRQ2}$ or \overline{KWI} .



Figure 4-3. Software Patch for IRQ1

General Release Specification

MC68HC(7)05L5 - Rev. 2.0



Note 1. KWI, timer 1, timer 2, SSPI, and TBI

Figure 4-4. Interrupt Flowchart

MOTOROLA

Resets and Interrupts





General Release Specification

MC68HC(7)05L5-Rev. 2.0

62



Figure 4-6. Key Wakeup Interrupt (KWI)

MC68HC(7)05L5-Rev. 2.0

MOTOROLA

Resets and Interrupts

4.3.4 Timer 1 Interrupt

Three timer 1 interrupts (TOI, ICI, and OC1I) share the same interrupt vector at \$3FF6 and \$3FF7. See **9.3 Timer 1.**

4.3.5 Timer 2 Interrupt

Two timer 2 interrupts (TI2I and OC2I) share the same interrupt vector at \$3FF4 and \$3FF5. See **9.4.1 Timer Control Register 2.**

4.3.6 SSPI Interrupt

The SSPI transfer complete interrupt uses the vector at \$3FF2 and \$3FF3. See Section 8. Simple Serial Peripheral Interface (SSPI).

4.3.7 Timebase Interrupt

The timebase interrupt uses the vector at \$3FF0 and \$3FF1. See **7.6 Timebase**.

4.4 Interrupt Control Register

| Address: | \$0008 | | | | | | | |
|-----------------|--------|-------|---|------|-------|-------|---|-------|
| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
| Read: Write: | IRQ1E | IRQ2E | 0 | KWIE | IRQ1S | IRQ2S | 0 | 0 |
| Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Figure 4-7. Interrupt Control Register (INTCR)

IRQ1E — IRQ1 Interrupt Enable

The IRQ1E bit enables IRQ1 interrupt when IRQ1F is set. This bit is cleared on reset.

- 0 = IRQ1 interrupt disabled
- 1 = IRQ1 interrupt enabled
- IRQ2E IRQ2 Interrupt Enable

The IRQ2E bit enables IRQ2 interrupt when IRQ2F is set. This bit is cleared on reset.

- 0 = IRQ2 interrupt disabled
- 1 = IRQ2 interrupt enabled
- Bit 5 Reserved

This bit is not used and is always read as logic 0.

KWIE — Key Wakeup Interrupt (KWI) Enable

The KWIE bit enables key wakeup interrupt when KWIF is set. This bit is cleared on reset.

- 0 = KWI disabled
- 1 = KWI enabled

IRQ1S — IRQ1 Select Edge Sensitive Only

- 0 = IRQ1 configured for low level and negative edge sensitive
- 1 = IRQ1 configured to respond only to negative edges
- IRQ2S IRQ2 Select Edge Sensitive Only
 - 0 = IRQ2 configured for low level and negative edge sensitive
 - 1 = IRQ2 configured to respond only to negative edges
- Bits 1 and 0 Reserved

These bits are not used and always read as logic 0.

MC68HC(7)05L5-Rev. 2.0

Resets and Interrupts

4.5 Interrupt Status Register





IRQ1F — IRQ1 Interrupt Flag

When IRQ1S = 0, the falling edge or low level at the $\overline{IRQ1}$ pin sets IRQ1F. When IRQ1S = 1, only the falling edge sets the IRQ1F bit. If the IRQ1E bit and this bit are set, an interrupt is generated. This read-only bit is cleared by writing a logic 1 to the RIRQ1 bit. Reset clears this bit.

IRQ2F — IRQ2 Interrupt Flag

When IRQ2S = 0, the falling edge or low level at the $\overline{IRQ2}$ pin sets IRQ2F. When IRQ2S = 1, only the falling edge sets the IRQ2F bit. If the IRQ2E bit and this bit are set, an interrupt is generated. This read-only bit is cleared by writing a logic 1 to the RIRQ2 bit. Reset clears this bit.

Bit 5 — Reserved

This bit is not used and is always read as logic 0.

KWIF — Key Wakeup Interrupt Flag

When the KWIE*x* bit in the KWIEN register is set, the falling edge at the KWI*x* pin sets the KWIF bit. If the KWIE bit and this bit are set, an interrupt is generated. This read-only bit is cleared by writing a logic 1 to the RKWIF bit. Reset clears this bit.

MC68HC(7)05L5 - Rev. 2.0

RIRQ1 — Reset IRQ1 Flag

The RIRQ1 bit is a write-only bit and is always read as logic 0. Writing a logic 1 to this bit clears the IRQ1F bit and writing logic 0 to this bit has no effect.

RIRQ2 — Reset IRQ2 Flag

The RIRQ2 bit is a write-only bit and is always read as logic 0. Writing a logic 1 to this bit clears the IRQ2F bit and writing a logic 0 to this bit has no effect.

Bit 1 — Reserved

This bit is not used and is always read as logic 0.

RKWIF — Reset KWI Flag

The RKWIF bit is a write-only bit and is always read as logic 0. Writing a logic 1 to this bit clears the KWIF bit and writing a logic 0 to this bit has no effect.

Resets and Interrupts

General Release Specification

MC68HC(7)05L5-Rev. 2.0

General Release Specification — MC68HC05L5

Section 5. Low-Power Modes

5.1 Contents

| 5.2 | | .69 |
|-----|-----------|-----|
| 5.3 | Stop Mode | .69 |
| 5.4 | Wait Mode | .70 |

5.2 Introduction

The MCU has two power-saving modes, stop and wait. Flowcharts of these modes are shown in **Figure 5-2**.

5.3 Stop Mode

The STOP instruction places the MCU in its lowest-power mode. In stop mode, the internal main oscillator OSC is turned off, halting all internal processing, including timer operations (timer 1, timer 2, and computer operating properly (COP) watchdog timer. Suboscillator XOSC does not stop oscillating. Therefore, if XOSC is used as the clock source for the COP watchdog timer, COP is still functional in stop mode. See **Section 7. Oscillators/Clock Distributions.**

During stop mode, the timer prescaler is cleared. The I bit in the condition code register (CCR) is cleared to enable external interrupts. All other registers and memory remain unaltered. All input/output lines remain unchanged. The processor can be brought out of stop mode only by RESET or an interrupt from IRQ1, IRQ2, KWI, SSPI (slave mode only), or TBI. See Section 7. Oscillators/Clock Distributions.

MOTOROLA

Low-Power Modes

5.4 Wait Mode

The WAIT instruction places the MCU in a low-power mode, but wait mode consumes more power than stop mode. All CPU action is suspended, but on-chip peripherals and oscillators remain active. Any interrupt or reset (including a COP reset) will cause the MCU to exit wait mode.

During wait mode, the I bit in the CCR is cleared to enable interrupts. All other registers, memory, and input/output lines remain in their previous state. The timers may be enabled to allow a periodic exit from wait mode. Wait mode must be exited and the COP must be reset to prevent a COP timeout.

The reduction of power in wait mode depends on how many of the onchip peripheral's clocks can be shut down. Therefore, the amount of power that will be consumed is dependent on the application, and it would be prohibitive to test all parts for all variations. For these reasons, the values given in **Section 12. Electrical Specifications** reflect typical application conditions after initial characterization of silicon.

MC68HC(7)05L5 - Rev. 2.0



Figure 5-1. Clock State and STOP Recovery/Power-On Reset Delay Diagrams

MOTOROLA

Low-Power Modes



Figure 5-2. Stop/Wait Flowcharts

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

72
General Release Specification — MC68HC05L5

Section 6. Parallel Input/Output (I/O)

6.1 Contents

| 6.2 | Introduction | 4 |
|-------|---------------------------------|---|
| 6.3 | Port A | 5 |
| 6.3.1 | Port A Data Register | 6 |
| 6.3.2 | Port A Data Direction Register7 | 7 |
| 6.4 | Port B | 8 |
| 6.5 | Port C | 9 |
| 6.5.1 | Port C Data Register | 1 |
| 6.5.2 | Port C Data Direction Register | 2 |
| 6.6 | Port D | 3 |
| 6.7 | Port E | 5 |
| | | |

Parallel Input/Output (I/O)

6.2 Introduction

The MCU has five parallel ports:

- Port A has eight input/output (I/O) pins.
- Port B has eight input-only pins.
- Port C has six I/O pins and tow input-only pins.
- Port D has seven output-only pins.
- Port E has eight output-only pins.

Most of these 39 I/O pins serve multiple purposes, depending on the configuration of the MCU system. The configuration is in turn controlled by hardware mode selection as well as internal control registers.



Figure 6-1. Port I/O Circuitry for One Bit

MOTOROLA

6.3 Port A

Port A is an 8-bit, bidirectional, general-purpose port. The data direction of a port A pin is determined by its corresponding DDRA bit.

When a port A pin is programmed as an output by the corresponding DDRA bit, data in the PORTA data register becomes output data to the pin. This data is returned when the PORTA register is read.

Open drain or CMOS outputs are selected by AWOMH and AWOML bits in the WOM1 register. If the AWOMH bit is set, the P-channel drivers of bits 7–4 output buffers are disabled (open drain). If the AWOML bit is set, the P-channel drivers of bits 3–0 output buffers are disabled (open drain).

When a bit is programmed as input by the corresponding DDRA bit, the pin level is read by the CPU.

Port A has optional pullup resistors. When the RAH bit or RAL bit in the RCR1 is set, pullup resistors are attached to the upper four bits or lower four bits of port A pins, respectively. When a pin outputs a low level, the pullup resistor is disconnected regardless of the RAH or RAL bit state.

Parallel Input/Output (I/O)

6.3.1 Port A Data Register



Figure 6-2. Port A Data Register (PORTA)

Read

Anytime; returns pin level if DDR set to input; returns output data latch if DDR set to output

Write

Anytime; data stored in an internal latch; drives pin only if DDR set for output

Reset

Becomes high-impedance inputs

General Release Specification

6.3.2 Port A Data Direction Register

Address: Option Map — \$0000

| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|-----------------|-------|-------|-------|-------|-------|-------|-------|-------|
| Read: Write: | DDRA7 | DDRA6 | DDRA5 | DDRA4 | DDRA3 | DDRA2 | DDRA1 | DDRA0 |
| Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Figure 6-3. Port A Data Direction Register (DDRA)

Read

Anytime when OPTM = 1

Write

Anytime when OPTM = 1

Reset

Cleared to \$00; all general-purpose I/O configured for input

DDRA*x* — Port A Data Direction Register Bit *x*

0 = Configure I/O pin PAx to input

1 = Configure I/O pin PAx to output

MC68HC(7)05L5-Rev. 2.0

Parallel Input/Output (I/O)

6.4 Port B

Port B pins serve two basic functions: KWI input pins and generalpurpose input pins.

Each $\overline{\text{KWI}}$ input is enabled or disabled by the corresponding KWIEx bit in the KWIEN register, and the usage of the $\overline{\text{KWI}}$ input does not affect the general-purpose input function.

Port B pin states may be read any time regardless of the configurations. Since there is no output drive logic associated with port B, there is no DDRB register and the write to the PORTB register has no meaning.

Port B has optional pullup resistors. When the RBH or RBL bit in the RCR1 is set, pullup resistors are attached to the upper four bits or lower four bits of port A pins, respectively.

| Address: | \$0001 | | | | | | | |
|-----------------|--------|-----|-----|-----------|------------|-----|-----|-------|
| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
| Read: Write: | PB7 | PB6 | PB5 | PB4 | PB3 | PB2 | PB1 | PB0 |
| Reset: | | • | | Unaffecte | d by reset | | • | |

Figure 6-4. Port B Data Register (PORTB)

Read

Anytime; returns pin level

Write

Has no meaning or effect

Reset

Unaffected; always an input port

General Release Specification

6.5 Port C

Port C pins share functions with several on-chip peripherals. A pin function is controlled by the enable bit of each associated peripheral.

Bit 7 and bit 6 of port C are input-only pins and IRQ input pins. Since IRQ1F or IRQ2F can be set by either the pins or the data latches, when using IRQs, be sure to clear the flags by software before enabling the IRQ1E or IRQ2E bits.

The PC5 pin is a general-purpose I/O pin and the direction of the pin is determined by the DDRC5 bit in the data direction register C (DDRC). When the event output (EVO) is enabled, the PC5 is configured as an event output pin and the DDRC5 bit has meaning only for the read of PC5 bit in the PORTC register; if the DDRC5 is set, the PC5 data latch is read by the CPU. Otherwise, PC5 pin level (EVO state) is read. When EVO is disabled, the DDRC5 bit decides the idling state of EVO (if DDRC5 = 1).

The PC4 and PC3 pins share functions with the timer input pins (EVI and TCAP). These bits are not affected by the usage of timer input functions and the directions of pins are always controlled by the DDRC4 and DDRC3 bits. Also, the DDRC4 and DDRC3 bits determine whether the pin states or data latch states should be read by the CPU.

NOTE: Since the TCAP pin is shared with the PC3 I/O pin, changing the state of the PC3 DDR or data register can cause an unwanted TCAP interrupt. This can be handled by clearing the ICIE bit before changing the configuration of PC3 and clearing any pending interrupts before enabling ICIE.

> Since the EVI pin is shared with the PC4 I/O pin. DDRC4 should always be cleared whenever EVI is used. EVI should not be used when DDRC4 is high.

MC68HC(7)05L5 - Rev. 2.0

Parallel Input/Output (I/O)

The PC2–PC0 pins are shared with the simple serial peripheral interface (SSPI). When the SSPI is not used (SPE = 0), DDRC2–DDRC0 bits control the direction of the pins, and when the SSPI is enabled, the pins are configured as serial clock output or input (SCK), serial data output (SDO), and serial data input (SDI). The direction of the SCK depends on the MSTR bit in the SPCR. When PORTC is read, the value read will be determined by the data direction register. When the port is configured for input (DDRC2, DDRC1, or DDRC0 equal to logic 0), the pin state is read. When the port is configured for output (DDRC2, DDRC1, or DDRC0 equal to logic 0), the output data latch is read.

Port C has optional pullup resistors. When the RCx bit in the RCR2 is set, pullup resistors are attached to the PCx pin. When a pin outputs a low level, the pullup resistor is disconnected regardless of an RCR2 register bit being set

Bits 5–0 have open drain or CMOS output options, which are controlled by the corresponding WOM2 register bits. These open drain or CMOS output options may be selected for either the general-purpose output ports or the peripheral outputs (EVO, SCK, and SDO).

General Release Specification

6.5.1 Port C Data Register



Figure 6-5. Port C Data Register (PORTC)

Read

Anytime; returns pin level if DDR set to input; returns output data latch if DDR set to output, PC7 and PC6 are input-only pins

Write

Anytime; data stored in an internal latch; drives pin only if DDR set for output; writes do not change pin state; when pin configured for SDO, SCK, and EVO peripheral output, bits 7 and 6 are read-only bits and write has no effect

Reset

Becomes high-impedance input

Parallel Input/Output (I/O)

6.5.2 Port C Data Direction Register

Address: Option Map — \$0002

| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|-----------------|-------|---|-------|-------|-------|-------|-------|-------|
| Read: Write: | 0 | 0 | DDRC5 | DDRC4 | DDRC3 | DDRC2 | DDRC1 | DDRC0 |
| Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Figure 6-6. Port C Data Direction Register (DDRC)

Read

Anytime when OPTM = 1

Write

Anytime when OPTM = 1; bits7 and 6 are read-only and write has no effect

Reset

Cleared to \$00; all general-purpose I/O configured for input

Bits 7 and 6 — Not used

Always read logic 0

DDRC5–DDRC0 — Port C Data Direction Register Bit *x*

The timer and SSPI force the I/O state to be an output for each port C line associated with an enabled output function such as SDO and EVO. For these cases, the data direction bits will not change.

0 = Configure I/O pin PC x to input

1 = Configure I/O pin PCx to output

General Release Specification

6.6 Port D

Port D pins serve one of two basic functions, depending on the MCU mode selected:

- LCD frontplane and backplane driver outputs
- General-purpose output pins

Since port D is an output-only port, there is no DDRD register.

On reset, all port D outputs are disconnected from the pins and the port D data latches are set to a logic 1.

By writing a 1 the PDH bit in the LCD control register (LCDCR), LCD frontplanes drivers (FP35–FP38) are disabled and the upper four bits of port D output are connected to the pins.

The pin connections of the lower three bits of port D depend on the LCD duty selection by the DUTY1 and DUTY0 bits in the LCDCR. When the LCD duty is not 1/4, the unused backplane driver(s) is (are) replaced by the port D output pin(s) automatically.

If DWOMH bit or DWOML bit in the WOM1 register is set, the P-channel drivers of output buffers at the upper four bits or lower three bits, respectively, are disabled (open-drain mode). These open-drain controls do not apply to the pins which are configured as frontplane or backplane driver outputs.

MC68HC(7)05L5-Rev. 2.0

Parallel Input/Output (I/O)

| Address: | \$0003 | | | | | | | |
|-----------------|--------|-----|-----|-----|-----|-----|-----|-------|
| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
| Read: Write: | PD7 | PD6 | PD5 | PD4 | PD3 | PD2 | PD1 | 1 |
| Reset: | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |

Figure 6-7. Port D Data Register (PORTD)

Read

Anytime; returns output data latch; bit 0 is always read logic 1

Write

Anytime; writes do not change pin state when configured for LCD driver output

Reset

All bits set to logic 1 and output ports disconnected from the pins; LCD is enabled on reset

General Release Specification

MC68HC(7)05L5-Rev. 2.0

MOTOROLA

6.7 Port E

Port E pins serve one of two basic functions, depending on the MCU mode selected:

- LCD frontplane driver outputs
- General-purpose output pins

Since port E is an output-only port, there is no DDRE register.

On reset, all port E outputs are disconnected from the pins and the port E data latches are set to a logic 1.

The upper or lower four bits of port E output are connected to the pins instead of the LCD frontplane drivers by writing 1 to the PEH or PEL bit, respectively, in the LCD control register(LCDCR).

If EWOMH bit or EWOML bit in the WOM1 register is set, the P-channel driver of output buffers at the upper or lower four bits, respectively, are disabled (open-drain mode). These open-drain controls do not apply to the pins which are configured as frontplane driver outputs.



Figure 6-8. Port E Data Register (PORTE)

Read

Anytime; returns output data latch

Write

Anytime; writes do not change pin state when configured for LCD driver output

Reset

All bits set to logic 1 and output ports disconnected from the pins; LCD is enabled on reset

| MC68HC(7)05L5-Rev. 2 | 2.0 |
|----------------------|-----|
|----------------------|-----|

MOTOROLA

Parallel Input/Output (I/O)

General Release Specification

Section 7. Oscillators/Clock Distributions

7.1 Contents

| 7.2 Introduction |
|---------------------------------------|
| 7.3 OSC Clock Divider and POR Counter |
| 7.4 System Clock Control |
| 7.5 OSC and XOSC90 |
| 7.5.1 OSC on Line |
| 7.5.2 XOSC on Line |
| 7.5.2.1 XOSC with FOSCE = 1 |
| 7.5.2.2 XOSC with FOSCE = 0 |
| 7.5.2.3 XOSC with FOSCE = 0 and STOP |
| 7.5.2.4 Stop Mode and Wait Mode |
| 7.6 Timebase |
| 7.6.1 LCDCLK |
| 7.6.2 STUP |
| 7.6.3 TBI |
| 7.6.4 COP |
| 7.6.5 Timebase Control Register 1 |
| 7.6.6 Timebase Control Register 2 |
| 7.6.7 Miscellaneous Register |

Oscillators/Clock Distributions

7.2 Introduction

The two oscillator blocks are OSC and XOSC. Several combinations of the clock distributions are allowed for the modules in the MC68HC05L5. Refer to **Figure 7-1**.





7.3 OSC Clock Divider and POR Counter

The OSC clock is divided by a 7-bit counter which is used for the system clock, timebase, and power-on reset (POR) counter. Clocks divided by 2, 4, and 64 are available for the system clock selections and a clock divided by 128 is provided for the timebase and POR counter.

The POR counter is a 6-bit clock counter that is driven by the OSC divided by 128. The overflow of this counter is used for setting FTUP bit, releasing the POR, and resuming operation from stop mode.

The 7-bit divider and POR counter are initialized to \$0078 by two conditions:

- Power-on detection
- When FOSCE bit is cleared

7.4 System Clock Control

The system clock is provided for all internal modules except timebase. Both OSC and XOSC are available as the system clock source. The divide ratio is selected by the SYS1 and SYS0 bits in the MISC register. (See **Table 7-1**.)

By default, OSC divided by 64 is selected on reset.

NOTE: Do not switch the system clock to XOSC (SYS1 and SYS0 = 11) when XOSC clock is not available. The XOSC clock is available when STUP flag is set.

Do not switch the system clock to OSC (SYS1 and SYS0 = 00, 01, or 10) when OSC clock is not available. The OSC clock is available when FTUP flag is set.

| SYS1 | SYS0 | Divide Ratio | CPU Bus Frequency (Hz) | | | | |
|------|------|--------------|------------------------|----------------|-----------------|--|--|
| 5151 | 5150 | | OSC = 4.0 M | OSC = 4.1943 M | XOSC = 32.768 k | | |
| 0 | 0 | OSC ÷ 2 | 2.0 M | 2.0972 M | — | | |
| 0 | 1 | OSC ÷ 4 | 1.0 M | 1.0486 M | — | | |
| 1 | 0 | OSC ÷ 64 | 62.5 k | 65.536 k | — | | |
| 1 | 1 | XOSC ÷ 2 | _ | | 16.384 k | | |

 Table 7-1. System Bus Clock Frequency Selection

Oscillators/Clock Distributions

7.5 OSC and XOSC

The secondary oscillator (XOSC) runs continuously after power up. The main oscillator (OSC) can be stopped to conserve power via the STOP instruction or the FOSCE bit in the MISC register. The effects of restarting the OSC will vary depending on the current state of the MCU, including SYS0, SYS1, and FOSCE.

7.5.1 OSC on Line

If the system clock is OSC, FOSCE should remain logic 1. Executing the STOP instruction in this condition will halt OSC, put the MCU into a low-power mode and clear the 6-bit POR counter. The 7-bit divider is not initialized. Exiting STOP with external IRQ or reset re-starts the oscillator. When the POR counter overflows, internal reset is released and execution can begin. The stabilization time will vary between 8064 and 8192 counts.

NOTE: Exiting STOP with external reset will always return the MCU to the state as defined by the default register definitions, for example, SYS0:SYS1 = 1:0, FOSCE = 1.



Figure 7-2. OSC1, OSC2, XOSC1, and XOSC2 Mask Options

General Release Specification

7.5.2 XOSC on Line

If XOSC is the system clock (SYS:SYS1 = 1:1), OSC can be stopped either by the STOP instruction or by clearing the FOSCE bit.

The suboscillator (XOSC) never stops except during power down. This clock also may be used as the clock source of the system clock and timebase. STUP bit indicates that the XOSC clock is available.

OSC and XOSC pins have options for feedback and damping resistor implementations. These options are set through mask option and may be read through the MOSR register.

NOTE: When XOSC is not used, the XOSC1 input pin should be connected to the RESET pin.



Figure 7-3. Unused XOSC1 Pin

7.5.2.1 XOSC with FOSCE = 1

If the system clock is XOSC and FOSCE = 1, executing the STOP instruction will halt OSC, put the MCU into a low-power mode and clear the 6-bit POR counter. The 7-bit divider is not initialized. Exiting STOP with external IRQ re-starts the oscillator; however, execution begins immediately using XOSC. When the POR counter overflows, FTUP is set, signaling that OSC is stable and OSC can be used as the system clock. The stabilization time will vary between 8064 and 8192 counts.

MOTOROLA

Oscillators/Clock Distributions

7.5.2.2 XOSC with FOSCE = 0

If XOSC is the system clock, clearing FOSCE will stop OSC and preset the 7-bit divider and 6-bit POR counter to \$0078. Execution will continue with XOSC and when FOSCE is set again, OSC will re-start. When the POR counter overflows, FTUP is set, signaling that OSC is stable and OSC can be used as the system clock. The stabilization time will be 8072 counts.

7.5.2.3 XOSC with FOSCE = 0 and STOP

If XOSC is the system clock and FOSCE is cleared, further power reduction can be achieved by executing the STOP instruction. In this case, OSC is stopped, the 7-bit divider and 6-bit POR counter are preset to \$0078 (since FOSCE = 0) and execution is halted. Exiting STOP with external IRQ does not re-start the OSC; however, execution begins immediately using XOSC. OSC may be re-started by setting FOSCE. When the POR counter overflows, FTUP will be set, signaling that OSC is stable and can be used as the system clock. The stabilization time will be 8072 counts.

7.5.2.4 Stop Mode and Wait Mode

During stop mode, the main oscillator (OSC) is shut down and the clock path from the second oscillator (XOSC) is disconnected. All modules except timebase are halted. Entering stop mode clears the FTUP flag in the MISC register and initializes the POR counter. Stop mode is exited by RESET, IRQ1, IRQ2, KWI, SSPI (slave mode), or timebase interrupt.

If OSC is selected as the system clock source during stop mode, CPU resumes after the overflow of the POR counter and this overflow also sets the FTUP status flag.

If XOSC is selected as the system clock source during stop mode, no stop recovery time is required for exiting stop mode because XOSC never stops. Re-start of the main oscillator depends on the FOSCE bit.

During wait mode, only the CPU clocks are halted and the peripheral modules are not affected. Wait mode is exited by $\overline{\text{RESET}}$ and any interrupts.

General Release Specification

| Before Reset of | or Interru | ıpt | Power-On | External | Exit Stop Mode by |
|------------------|--------------------------------|---|----------|----------------------|------------------------|
| CPU Clock Source | Stop FOSCE | | Reset | Reset | Interrupt |
| | | | Wait | _ | — |
| OSC (OSC on) | Out | 1 | _ | No wait | — |
| OSC (OSC off) | Out In In ⁽¹⁾ | 0 ⁽²⁾ 1 0 ⁽¹⁾ | | Wait Wait Wait | Wait Wait |
| XOSC (OSC on) | Out | 1 | _ | No wait | — |
| XOSC (OSC off) | Out In In | 0 1 0 | | Wait Wait Wait | No wait No wait |

 Table 7-2. Recovery Time Requirements

Notes:

1. This case never occurs.

2. This case has no meaning for the applications.

7.6 Timebase

Timebase is a 14-bit up-counter which is clocked by XOSC input or OSC input divided by 128. TBCLK bit in the TBCR1 register selects the clock source.

This 14-bit divider is initialized to \$0078 only upon power-on reset (POR). After counting 8072 clocks, the STUP bit in the MISC register is set.

The divided clocks from the timebase are used for LCDCLK, STUP, TBI, and COP. (See **Figure 7-4**).

MC68HC(7)05L5 - Rev. 2.0

Oscillators/Clock Distributions





7.6.1 LCDCLK

The clocks divided by 64 and 128 are used as LCD clocks at the LCD driver module, and clocks are selected by the LCLK bit in the TBCR1.

7.6.2 STUP

Timebase divider is initialized to \$0078 by the power-on detection and when the count reaches 8072, the STUP flag in the MISC register is set. Once the STUP flag is set, it is never cleared until power down.

General Release Specification

7.6.3 TBI

Timebase interrupts may be generated every 0.5, 0.25, 0.125, or 0.0039 seconds with a 32.768-kHz crystal at XOSC pins.

The timebase interrupt flag (TBIF) is set every period and interrupt is requested if the enable bit (TBIE) is set. The clock divided by 128, 4096, 8192, or 16,384 is used to set TBIF, and this clock is selected by the TBR1 and TBR0 bits in the TBCR2 register. (See **Table 7-3**.)

| ТВО | CR2 | Divide Ratio | Frequency (Hz) | | | | |
|------|------|----------------|----------------|----------------|-----------------|--|--|
| TBR1 | TBR0 | | OSC = 4.0 M | OSC = 4.1943 M | XOSC = 32.768 k | | |
| 0 | 0 | TBCLK ÷ 128 | 244 | 256 | 256 | | |
| 0 | 1 | TBCLK ÷ 4096 | 7.63 | 8.00 | 8.00 | | |
| 1 | 0 | TBCLK ÷ 8192 | 3.81 | 4.00 | 4.00 | | |
| 1 | 1 | TBCLK ÷ 16,384 | 1.91 | 2.00 | 2.00 | | |

Table 7-3. Timebase Interrupt Frequency

Oscillators/Clock Distributions

7.6.4 COP

The computer operating properly (COP) watchdog timer is controlled by the COPE and COPC bits in the TBCR2 register.

The COP uses the same clock as TBI that is selected by the TBR1 and TBR0 bits. The TBI is divided by four and overflow of this divider generates COP timeout reset if the COP enable (COPE) bit is set. The COP timeout reset has the same vector address as POR and external RESET. To prevent the COP timeout, the COP divider is cleared by writing a logic 1 to the COP clear (COPC) bit.

When the timebase divider is driven by the OSC clock, clock for the divider is suspended during stop mode or when FOSCE is a logic 0. This may cause COP period stretching or no COP timeout reset when processing errors occur. To avoid these problems, it is recommended that the XOSC clock be used for the COP functions.

When the timebase (COP) divider is driven by the XOSC clock, the divider does not stop counting and the COPC bit must be triggered to prevent the COP timeout.

| тво | TBCR2 | | COP Period (ms) | | | | | | | |
|------|-------|---------|-----------------|-----------|----------|----------|-----------|--|--|--|
| TBR1 | TPDA | OSC = 4 | 4.0 MHz | OSC = 4.1 | 1943 MHz | XOSC = 3 | 2.768 kHz | | | |
| IDRI | TBR0 | Min | Max | Min | Max | Min | Max | | | |
| 0 | 0 | 12.3 | 16.4 | 11.7 | 15.6 | 11.7 | 15.6 | | | |
| 0 | 1 | 393 | 524 | 375 | 500 | 375 | 500 | | | |
| 1 | 0 | 786 | 1048 | 750 | 1000 | 750 | 1000 | | | |
| 1 | 1 | 1573 | 2097 | 1500 | 2000 | 1500 | 2000 | | | |

Table 7-4. COP Timeout Period

MOTOROLA

7.6.5 Timebase Control Register 1



Figure 7-5. Timebase Control Register 1 (TBCR1)

Read

Anytime

Write

Anytime; only one write is allowed on bit 7 after reset

TBCLK — Timebase Clock

The TBCLK bit selects the timebase clock source. This bit is cleared on reset. After reset, a write to this bit is allowed only once.

0 = XOSC clock selected

1 = OSC clock divided by 128 selected

Bit 6 — Reserved

This bit is not used and always reads as logic 0.

LCLK — LCD Clock

The LCLK bit selects the clock for the LCD driver. This bit is cleared on reset.

0 =Divide by 64 selected

1 = Divide by 128 selected

Bits 4-2 - Reserved

These bits are not used and always read as logic 0.

T2R1 and T2R0 — Timer 2 Prescale Rate Select Bits

T2R1 and T2R0 select timer 2 clock rate. See **9.4 Timer 2** for more detail.

Oscillators/Clock Distributions

7.6.6 Timebase Control Register 2



Figure 7-6. Timebase Control Register 2 (TBCR2)

Read

Anytime; bits 3 and 0 are write-only bits and always read as logic 0

Write

Anytime; bit 7 is a read-only bit and write has no effect; bit 1 is 1-time write bit

TBIF — Timebase Interrupt Flag

The TBIF bit is set every timeout interval of the timebase counter. This read-only bit is cleared by writing a logic 1 to the RTBIF bit. Reset clears the TBIF bit. The timebase interrupt period between reset and the first TBIF depends on the time elapsed during reset, since the timebase divider is not initialized on reset.

TBIE — Timebase Interrupt Enable

The TBIE bit enables the timebase interrupt capability. If TBIF = 1 and TDIF = 1 and

- TBIE = 1, the timebase interrupt is generated.
 - 0 = Timebase interrupt disabled
 - 1 = Timebase interrupt requested when TBIF = 1

TBR1 and TBR0 — Timebase Interrupt Rate Select

The TBR1 and TBR0 bits select one of four rates for the timebase interrupt period (see **Table 7-3**). The TBI rate is also related to the COP timeout reset period. These bits are set to logic 1 on reset.

| тво | CR2 | Divide Ratio | Frequency (Hz) | | | | |
|------|------|----------------|----------------|----------------|-----------------|--|--|
| TBR1 | TBR0 | Divide Katio | OSC = 4.0 M | OSC = 4.1943 M | XOSC = 32.768 k | | |
| 0 | 0 | TBCLK ÷ 128 | 244 | 256 | 256 | | |
| 0 | 1 | TBCLK ÷ 4096 | 7.63 | 8.00 | 8.00 | | |
| 1 | 0 | TBCLK ÷ 8192 | 3.81 | 4.00 | 4.00 | | |
| 1 | 1 | TBCLK ÷ 16,384 | 1.91 | 2.00 | 2.00 | | |

 Table 7-5. Timebase Interrupt Frequency

RTBIF — Reset Timebase Interrupt Flag

The RTBIF bit is a write-only bit and is always read as logic 0. Writing logic 1 to this bit clears the TBIF bit and writing logic 0 to this bit has no effect.

Bit 2 — Reserved

This bit is not used and is always read as logic 0.

COPE — COP Enable

When the COPE bit is logic 1, the COP reset function is enabled. This bit is cleared on reset (including COP timeout reset) and write to this bit is allowed only once after reset.

COPC — COP Clear

Writing logic 1 to the COPC bit clears the 2-bit divider to prevent COP timeout. (The COP timeout period depends on the TBI rate.) This bit is write-only and returns to logic 0 when read.

Oscillators/Clock Distributions

7.6.7 Miscellaneous Register



FTUP — OSC Time Up Flag

Power-on detection and clearing the FOSCE bit clears this read-only bit. This bit is set by the overflow of the POR counter. Reset does not affect this bit.

- 0 = During POR or OSC shut down
- 1 = OSC clock available for the system clock
- STUP XOSC Time Up Flag

Power-on detection clears this read-only bit. This bit is set after the timebase has counted 8072 clocks. Reset does not affect this bit.

- 0 = XOSC not stabilized or no signal on XOSC1 and XOSC2 pins
- 1 = XOSC clock available for the system clock
- Bits 5 and 4 Reserved

These bits are not used and always read as logic 0.

SYS1 and SYS0 — System Clock Select

These two bits select the system clock source. On reset, the SYS1 and SYS0 bits are initialized to 1 and 0, respectively.

General Release Specification

NOTE: Do not switch the system clock to XOSC (SYS1 and SYS0 = 11) when the XOSC clock is not available. The XOSC clock is available when the STUP flag is set.

Do not switch the system clock to OSC (SYS1 and SYS 0 = 00, 01, or 10) when the OSC clock is not available. The OSC clock is available when the FTUP flag is set.

| SYS1 | SYS0 | Divide Ratio | CPU Bus Frequency (Hz) | | |
|------|------|--------------|------------------------|----------------|-----------------|
| 3131 | | | OSC = 4.0 M | OSC = 4.1943 M | XOSC = 32.768 k |
| 0 | 0 | OSC ÷ 2 | 2.0 M | 2.0972 M | _ |
| 0 | 1 | OSC ÷ 4 | 1.0 M | 1.0486 M | _ |
| 1 | 0 | OSC ÷ 64 | 62.5 k | 65.536 k | — |
| 1 | 1 | XOSC ÷ 2 | _ | _ | 16.384 k |

Table 7-6. System Bus Clock Frequency Selection

FOSCE — Fast (Main) Oscillator Enable

The FOSCE bit controls the main oscillator activity. This bit should not be cleared by the CPU when the main oscillator is selected as the system clock source.

When this bit is cleared:

- 1. OSC is shut down.
- 2. 7-bit dividers at the OSC input and POR counter are initialized to \$0078.
- 3. FTUP flag is cleared.

When this bit is set:

- 1. Main oscillator starts again.
- 2. FTUP flag is set by the POR counter overflow (8072 clocks).

OPTM — Option Map Select

The OPTM bit selects one of two register maps at \$0000–\$000F. This bit is cleared on reset.

- 0 = Main register map selected
- 1 = Option map selected

Oscillators/Clock Distributions

General Release Specification

MC68HC(7)05L5-Rev. 2.0

MOTOROLA

Section 8. Simple Serial Peripheral Interface (SSPI)

8.1 Contents

| 8.2 | Introduction |
|-------|------------------------------------|
| 8.3 | Features |
| 8.4 | Functional Descriptions105 |
| 8.5 | Internal Block Descriptions |
| 8.5.1 | Control |
| 8.5.2 | SPDR |
| 8.5.3 | SPCR |
| 8.5.4 | SPSR107 |
| 8.5.5 | CLKGEN |
| 8.6 | Signal Descriptions107 |
| 8.6.1 | SSPI Data I/O (SDI and SDO)107 |
| 8.6.2 | Serial Clock (SCK)108 |
| 8.7 | Registers |
| 8.7.1 | Serial Peripheral Control Register |
| 8.7.2 | Serial Peripheral Status Register |
| 8.7.3 | Serial Peripheral Data Register |
| 8.8 | Port Function |
| | |

Simple Serial Peripheral Interface (SSPI)

8.2 Introduction

The simple serial peripheral interface (SSPI) of the MC68HC05L5 is a master/slave synchronous serial communication module.

SSPI uses a 3-wire protocol: data input, data output, and serial clock. In this format, the clock is not being included in the data stream and must be provided as a separate signal.

When the SSPI is enabled (SPE = 1), bits 0-2 of port C become SDI (serial data in), SDO (serial data out), and SCK (serial clock) pins. The corresponding DDRC bit does not change the direction of the pin.

The MSTR bit decides the SSPI operation mode. The SCK pin is configured as output in master mode and configured as input in slave mode.

The DORD bit in the serial peripheral control register (SPCR) selects the data transmission order. When DORD is set, the least significant bit (LSB) of serial data is shifted out/in first. When the DORD is clear, serial data is shifted from/to the most significant bit (MSB).

Master serial clock speed is selected by the SPR bit in the SPCR. An interrupt may be generated by the completion of a transfer.

8.3 Features

Features of the SSPI are:

- Full-duplex, 3-wire synchronous transfers
- Master or slave operation
- Programmable data transmission order, LSB or MSB first
- 1.05-MHz (maximum) transmission bit frequency at 2.1-MHz CPU bus frequency at 5 Vdc
- Two programmable transmission bit rates
- End-of-transmission interrupt flag
- Wakeup from stop mode (slave mode only)

MOTOROLA

8.4 Functional Descriptions

In master mode, the clock start logic is triggered by the CPU (detection of a CPU write to the 8-bit shift register (SPDR)). The SCK is based on the internal processor clock. This clock is also used in the 3-bit counter and 8-bit shift register. See **Figure 8-2**.

When data is written to the 8-bit shift register of the master device, it is then shifted out to the SDO pin for application to the slave device. At the same time, data applied from the slave device via the SDI pin is shifted into the 8-bit shift register.

After 8-bit data is shifted in/out, SCK stops and SPIF is set. If SPIE is enabled, an interrupt request is generated. The slave device in stop mode wakes up by this interrupt. Further transfers (writes to SPDR) are inhibited while SPIF is a logic 1.

The master-slave basic interconnection is illustrated in Figure 8-1.



Figure 8-1. SSPI Master-Slave Interconnection

Simple Serial Peripheral Interface (SSPI)

8.5 Internal Block Descriptions

The following paragraphs describe the main blocks in the SSPI module. (See **Figure 8-2**).



Figure 8-2. SSPI Block Diagram

8.5.1 Control

This block is an interface to the HC05 internal bus and generates a start signal when a write to the SPDR is detected in master mode. It also generates an interrupt request to the CPU.

8.5.2 SPDR

This serial peripheral data register (SPDR) is an 8-bit shift register. The DORD bit in the SPCR determines the bus connection between the internal data bus and SPDR. This register can be read and written by the CPU.

General Release Specification

| 8.5.3 SPCR | |
|---------------------|---|
| | Bits in the serial peripheral control register (SPCR) control SSPI functions. |
| 8.5.4 SPSR | |
| | The serial peripheral status register (SPSR) mainly sets flags such as SPIF and DCOL. |
| 8.5.5 CLKGEN | |
| | In master mode, this block generates SCK when the CPU writes to the data register (SPDR) and the clock rate is selected by the SPR bit in the control register. |
| | In slave mode, the external clock from the SCK pin is used instead of the master mode clock, and SPR has no affect. |
| | This clock generator includes a 3-bit clock counter. Overflow of this counter sets SPIF. |
| 8.6 Signal Descri | ptions |
| | Three basic signals — SDI, SDO, and SCK — are described in the following subsections. The relationship among SCK, SDI, and SDO is shown in Figure 8-3 . |
| 8.6.1 SSPI Data I/O | (SDI and SDO) |
| | The two serial data lines — SDI for input and SDO for output — are |

The two serial data lines — SDI for input and SDO for output — are connected to PC0 and PC1, respectively, when SSPI is enabled (SPE = 1).

At the falling edge of SCK, a serial data bit is transmitted out of the SDO pin. At the rising edge of SCK, a serial data bit on the SDI pin is sampled internally.

MC68HC(7)05L5 - Rev. 2.0

Simple Serial Peripheral Interface (SSPI)



Figure 8-3. SSPI Clock-Data Timing Diagram

When data is transmitted to other devices via the SDO line, the receiving data is shifted into the shift register through the SDI pin. This implies full-duplex transmission with both data-out and data-in synchronized with the same clock signal. Thus, the byte transmitted is replaced by the byte received and eliminates the need for separate transmit-empty and receiver-full status bits. A single status bit, SPIF, is used to signify the completion of data transfer.

8.6.2 Serial Clock (SCK)

SCK is used for synchronization of both input and output data streams through its SDI and SDO pins.

The master and slave devices are capable of exchanging a data byte during a sequence of eight clock pulses. Since the SCK is generated by

General Release Specification
the master, slave data transfer is accomplished by synchronization to SCK.

The master generates the SCK through a circuit driven by the internal processor clock and uses the SCK to latch incoming slave device data on the SDI pin and shift out data to the slave via the SDO pin. The SPR bit in the SPCR of the master selects the transmission clock rate.

The slave device receives the SCK from the master device, and uses the SCK to latch incoming master device data on the SDI pin and shifts out data to the master via the SDO pin. The SPR bit in the SPCR of the slave has no meaning.

NOTE: PC2/SCK should be at V_{DD} level before SSPI is enabled. This can be done with an internal or external pullup resistor or by setting DDRC2 = 1 and PC2 = 1 prior to enabling the SSPI. Otherwise, the circuit will not initialize correctly.

8.7 Registers

Three registers are in the SSPI provide control, status, and data storage functions. They are:

- Serial peripheral control register, SPCR location \$000A
- Serial peripheral status register, SPSR location \$000B
- Serial peripheral data register, SPDR location \$000C

MC68HC(7)05L5-Rev. 2.0

Simple Serial Peripheral Interface (SSPI)

8.7.1 Serial Peripheral Control Register



Figure 8-4. Serial Peripheral Control Register (SPCR)

SPIE — SSPI Interrupt Enable

If the serial peripheral interrupt enable (SPIE) bit is set, an interrupt is generated when SPIF in the SPSR is set and I bit (interrupt mask bit) in the condition code register (CCR) is clear.

During stop mode, an SSPI request is accepted only in slave mode. Interrupt in master mode will be pending until stop mode is exited. STOP instruction does not change SPIF and SPIE.

0 = Disable SSPI interrupt

1 = Enable SSPI interrupt

SPE — SSPI Enable

When the SSPI enable (SPE) bit is set, the SSPI system is enabled and connected to the port C pins.

Clearing the SPE bit initializes all control logic in the SSPI modules and disconnects the SSPI from port C pins.

This bit is cleared on reset.

- 0 = Disable SSPI
- 1 = Enable SSPI

General Release Specification

MC68HC(7)05L5-Rev. 2.0

Simple Serial Peripheral Interface (SSPI) Registers

DORD — Data Transmission ORDer

When this bit is set, the data in the 8-bit shift register (SPDR) is shifted in/out from the LSB. When this bit is cleared, the data in the SPDR is shifted in/out from the MSB.

This bit is cleared on reset.

0 = MSB first

MSTR — MaSTeR Mode Select

The MSTR bit determines whether the device is in master mode or slave mode.

In master mode (MSTR = 1), the SCK pin is configured as an output and the serial clock is generated by the internal clock generator when the CPU writes to the SPDR.

In slave mode (MSTR = 0), the SCK pin is configured as an input and the serial clock is applied externally. This bit is cleared on reset.

0 = Slave mode 1 = Master mode

Bits 3-1 — Reserved

These bits are not used and are fixed to 0.

SPR — SSPI Clock Rate Select

This serial peripheral clock rate bit selects one of two bit rates of SCK. This bit is cleared on reset.

0 = Internal processor clock divided by 2

1 = Internal processor clock divided by 16

MC68HC(7)05L5-Rev. 2.0

Simple Serial Peripheral Interface (SSPI)

8.7.2 Serial Peripheral Status Register





SPIF — Serial Transfer Complete Flag

The serial peripheral data transfer complete flag bit notifies the user that a data transfer between the MC68HC05L5 and an external device has been completed. With the completion of the data transfer, the rising edge of the eighth pulse sets SPIF, and if SPIE is set, SSPI is generated. However, during STOP, the interrupt request is serviced only in slave mode. STOP execution never affects the SPIF flag or SPIE.

When SPIF is set, the ninth clock from the clock generator or from the SCK pin is inhibited.

Clearing the SPIF bit is done by a software sequence of accessing the SPSR while the SPIF bit is set followed by accessing SPDR (8-bit shift register). This also clears the DCOL bit. While SPIF is set, all writes to the SPDR are inhibited until SPSR is read by the CPU.

The SPIF bit is a read-only bit and is cleared on reset.

- 0 = Data transfer not complete
- 1 = Data transfer complete

DCOL — Data COLlision

The data collision bit notifies the user that an attempt was made to write or read the serial peripheral data register while a data transfer was taking place with an external device. The transfer continues uninterrupted; therefore, a write will be unsuccessful, and a data read will be incorrect.

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

A data collision only sets the DCOL bit and does not generate an SSPI interrupt. The DCOL bit indicates only the occurrence of data collision.

Clearing the DCOL bit is done by a software sequence of accessing the SPSR while SPIF is set followed by accessing the SPDR. Both the SPIF and DCOL bits will be cleared by this sequence.

The DCOL bit is cleared on reset.

0 = No data collision

1 = Data collision occurred

Bits 5–0 — Reserved

These bits are not used and are fixed to 0.

8.7.3 Serial Peripheral Data Register

| Address: | \$000C | | | | | | | |
|-----------------|--------|-------|-------|------------|----------|-------|-------|-------|
| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
| Read: Write: | MSB | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 2 | LSB |
| Docot: | | | | Unoffector | hy Docot | | | |

Reset:

Unaffected by Reset

Figure 8-6. Serial Peripheral Data Register (SPDR)

Read

A read during transmission causes DCOL to be set.

Write

A write during transmission causes DCOL to be set.

The SPDR is used to transmit and receive data on the serial bus.

In master mode, a write to this register initiates transmission/reception of a data byte.

The SPIF status bit is set at the completion of data byte transmission. A write to the SPDR is inhibited while this register is shifting (a write

| MC68HC(7)05L5 | — Rev. 2.0 |
|---------------|------------|
|---------------|------------|

MOTOROLA

Simple Serial Peripheral Interface (SSPI)

attempt sets DCOL) or when the SPIF bit is set without reading SPSR. Data collision never affects the receiving and transmitting data in SPDR.

A write or read of the SPDR after accessing the SPSR with SPIF set will clear the SPIF and DCOL bits.

The ability to access the SPDR is inhibited when a transmission is taking place. It is important to read the discussion defining the DCOL and SPIF bits to understand the limits on using the SPDR.

When SSPI is not used (SPE = 0), the SPDR can be used as a generalpurpose data storage register.

8.8 Port Function

The SSPI shares I/O pins with PC0–PC2. When SPE is set, PC0 becomes SDI input, PC1 becomes SDO output and PC2 becomes SCK. The direction of SCK depends on the MSTR bit. Setting DDRC bits 0–2 does not change the data direction of the pin to output, but instead changes the source of data when PC0–PC2 is read. If DDRCx = 1, port C bit x data latch is read and if DDRCx = 0, PORTCx pin level is read by the CPU.

When SPE is clear, SSPI is disconnected from the I/O pins and PC0–PC2 are used as general-purpose I/O pins. See **6.5 Port C.**

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

Section 9. Timer System

9.1 Contents

| 9.2 | Introduction |
|---|---|
| 9.3 | Timer 1 |
| 9.3.1 | Counter |
| 9.3.2 | Output Compare Register119 |
| 9.3.3 | Input Capture Register120 |
| 9.3.4 | Timer Control Register121 |
| 9.3.5 | Timer Status Register |
| 9.3.6 | Timer During Wait Mode |
| 9.3.7 | Timer During Stop Mode |
| | |
| 9.4 | Timer 2 |
| 9.4 9.4.1 | Timer 2 124 Timer Control Register 2 128 |
| | |
| 9.4.1 | Timer Control Register 2128 |
| 9.4.1 9.4.2 | Timer Control Register 2 |
| 9.4.1 9.4.2 9.4.3 | Timer Control Register 2 |
| 9.4.1 9.4.2 9.4.3 9.4.4 | Timer Control Register 2.128Timer Status Register 2.130Output Compare Register 2131Timer Counter Register 2131 |
| 9.4.1 9.4.2 9.4.3 9.4.4 9.4.5 | Timer Control Register 2.128Timer Status Register 2.130Output Compare Register 2131Timer Counter Register 2131Timebase Control Register 1.132 |

MC68HC(7)05L5-Rev. 2.0

Timer System

9.2 Introduction

The MC68HC05L5 has two timer modules: timer 1 with a 16-bit counter and timer 2 with an 8-bit counter. Timer 1 has one input pin (TCAP) and no output pin. Timer 2 has one input pin (EVI) and one output pin (EVO). **Figure 9-1** illustrates the timer system of the MC68HC05L5.



Figure 9-1. Timer System Block Diagram

General Release Specification

MC68HC(7)05L5-Rev. 2.0

MOTOROLA

9.3 Timer 1

Timer 1 consists of a 16-bit software-programmable counter driven by a fixed divide-by-four prescaler. This timer can be used for many purposes, including input waveform measurements while simultaneously generating an output compare interrupt. Pulse widths can vary from several microseconds to many seconds. See **Figure 9-2**.



Figure 9-2. Timer 1 Block Diagram

MC68HC(7)05L5-Rev. 2.0

Timer System

Because the timer has a 16-bit architecture, each specific functional segment (capability) is represented by two registers. These registers contain the high byte and low byte of that functional segment. Generally, accessing the low byte of a specific timer function allows full control of that function; however, an access of the high byte inhibits that specific timer function until the low byte is accessed also.

NOTE: The I bit in the condition code register (CCR) should be set while manipulating both the high byte and low byte register of a specific timer function to ensure that an interrupt does not occur.

9.3.1 Counter

The key element in the programmable timer is a 16-bit, free-running counter or counter register preceded by a prescaler that divides the internal processor clock by four. The prescaler gives the timer a resolution of 2.0 microseconds if the internal bus clock is 2.0 MHz. The counter is incremented during the low portion of the internal bus clock. Software can read the counter at any time without affecting its value.

The double-byte, free-running counter can be read from either of two locations: \$18–\$19 (counter register) or \$1A–\$1B (counter alternate register). A read from only the least significant byte (LSB) of the free-running counter (\$19, \$1B) receives the count value at the time of the read. If a read of the free-running counter or counter alternate register first addresses the most significant byte (MSB) (\$18, \$1A), the LSB (\$19, \$1B) is transferred to a buffer. This buffer value remains fixed after the first MSB read, even if the user reads the MSB several times. This buffer is accessed when reading the free-running counter or counter alternate register LSB (\$19 or \$1B) and, thus, completes a read sequence of the total counter value. In reading either the free-running counter or counter alternate register, if the MSB is read, the LSB must also be read to complete the sequence.

The counter alternate register differs from the counter register in one respect: A read of the counter register MSB can clear the timer overflow flag (TOF). Therefore, the counter alternate register can be read at any time without the possibility of missing timer overflow interrupts due to clearing of the TOF.

MC68HC(7)05L5 - Rev. 2.0

The free-running counter is configured to \$FFFC during reset and is always a read-only register. During a power-on reset, the counter is also preset to \$FFFC and begins running after the oscillator startup delay. Because the free-running counter is 16 bits preceded by a fixed dividedby-4 prescaler, the value in the free-running counter repeats every 262,144 internal bus clock cycles. When the counter rolls over from \$FFFF to \$0000, the TOF bit is set. An interrupt also can be enabled when counter roll over occurs by setting its interrupt enable bit (TOIE).

9.3.2 Output Compare Register

The 16-bit output compare register is made up of two 8-bit registers at locations \$16 (MSB) and \$17 (LSB). The output compare register is used for several purposes, such as indicating when a period of time has elapsed. All bits are readable and writable and are not altered by the timer hardware or reset. If the compare function is not needed, the two bytes of the output compare register can be used as storage locations.

The output compare register contents are compared with the contents of the free-running counter continually, and if a match is found, the corresponding output compare flag (OCF) bit is set. The output compare register values should be changed after each successful comparison to establish a new elapsed timeout. An interrupt also can accompany a successful output compare, provided the corresponding interrupt enable bit (OCIE) is set.

After a processor write cycle to the output compare register containing the MSB (\$16), the output compare function is inhibited until the LSB (\$17) also is written. The user must write both bytes (locations) if the MSB is written first. A write made only to the LSB (\$17) will not inhibit the compare function. The free-running counter is updated every four internal bus clock cycles. The minimum time required to update the output compare register is a function of the program rather than the internal hardware.

The processor can write to either byte of the output compare register without affecting the other byte.

Timer System

9.3.3 Input Capture Register

Two 8-bit registers, which make up the 16-bit input capture register, are read-only and are used to latch the value of the free-running counter after the corresponding input capture edge detector senses a defined transition. The level transition which triggers the counter transfer is defined by the corresponding input edge bit (IEDG). Reset does not affect the contents of the input capture register.

The result obtained by an input capture will be one more than the value of the free-running counter on the rising edge of the internal bus clock preceding the external transition. This delay is required for internal synchronization. Resolution is one count of the free-running counter, which is four internal bus clock cycles.

The free-running counter contents are transferred to the input capture register on each proper signal transition regardless of whether the input capture flag (ICF) is set or clear. The input capture register always contains the free-running counter value that corresponds to the most recent input capture.

After a read of the input capture register (\$14) MSB, the counter transfer is inhibited until the LSB (\$15) is also read. This characteristic causes the timer used in the input capture software routine and its interaction with the main program to determine the minimum pulse period.

A read of the input capture register LSB (\$15) does not inhibit the freerunning counter transfer since they occur on opposite edges of the internal bus clock.

NOTE: Since the TCAP pin is shared with the PC3 I/O pin, changing the state of the PC3 DDR or data register can cause an unwanted TCAP interrupt. This can be handled by clearing the ICIE bit before changing the configuration of PC3 and clearing any pending interrupts before enabling ICIE.

MOTOROLA

9.3.4 Timer Control Register

The TCR is a read/write register containing five control bits. Three bits enable interrupts associated with the timer status register flags ICF, OCF, and TOF.



Figure 9-3. Timer Control Register (TCR)

- ICIE Input Capture Interrupt Enable
 - 0 = Interrupt disabled
 - 1 = Interrupt enabled
- OC1IE Output Compare 1 Interrupt Enable
 - 0 = Interrupt disabled
 - 1 = Interrupt enabled
- TOIE Timer Overflow Interrupt Enable
 - 0 = Interrupt disabled
 - 1 = Interrupt enabled
- IEDG Input Edge

The value of the input edge determines which level transition on the TCAP pin will trigger free-running counter transfer to the input capture register.

Reset does not affect the IEDG bit.

- 0 = Negative edge
- 1 = Positive edge
- Bits 2-4 Not Used

Always read logic 0

OLVL - Not Used

Always read logic 0

MC68HC(7)05L5 - Rev. 2.0

Timer System

9.3.5 Timer Status Register

The TSR is a read-only register containing three status flag bits.



Figure 9-4. Timer Status Register (TSR)

- ICF Input Capture Flag
 - 0 = Flag cleared when TSR and input capture low register (\$15) are accessed
 - 1 = Flag set when selected polarity edge is sensed by input capture edge detector
- OC1F Output Compare 1 Flag
 - 0 = Flag cleared when TSR and output compare low register (\$17) are accessed
 - 1 = Flag set when output compare register contents match the freerunning counter contents
- TOF Timer Overflow Flag
 - 0 = Flag cleared when TSR and counter low register (\$19) are accessed
 - 1 = Flag set when free-running counter transition from \$FFFF to \$0000 occurs
- Bits 0-4 Not Used

Always read logic 0

Accessing the timer status register satisfies the first condition required to clear status bits. The remaining step is to access the register corresponding to the status bit.

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

A problem can occur when using the timer overflow function and reading the free-running counter at random times to measure an elapsed time. Without incorporating the proper precautions into software, the timer overflow flag could unintentionally be cleared if:

- 1. The timer status register is read or written when TOF is set.
- 2. The LSB of the free-running counter is read but not for the purpose of servicing the flag.

The counter alternate register at address \$1A and \$1B contains the same value as the free-running counter (at address \$18 and \$19); therefore, this alternate register can be read at any time without affecting the timer overflow flag in the timer status register.

9.3.6 Timer During Wait Mode

The CPU clock halts during wait mode, but timer 1 remains active. If interrupts are enabled, a timer interrupt will cause the processor to exit wait mode.

9.3.7 Timer During Stop Mode

In stop mode, timer 1 stops counting and holds the last count value if STOP is exited by an interrupt. If RESET is used, the counter is forced to \$FFFC. During STOP, if at least one valid input capture edge occurs at the TCAP pin, the input capture detect circuit is armed. This does not set any timer flags or wake up the MCU. When the MCU does wake up, there is an active input capture flag and data from the first valid edge that occurred during stop mode. If RESET is used to exit stop mode, then no input capture flag or data remains, even if a valid input capture edge occurred.

MC68HC(7)05L5-Rev. 2.0

MOTOROLA

Timer System

9.4 Timer 2

Timer 2 is an 8-bit event counter which has one compare register, one event input pin (EVI), and one event output pin (EVO). The event counter is clocked by the external clock (EXCLK) or prescaled system clock (CLK2), selected by the T2CLK bit in the TCR2 register. The EXCLK may be EVI direct or EVI gated by CLK2, which is selected by the IM2 bit at the EVI block (see **9.4.6 Timer Input 2 (EVI)**).

Timer 2 may be used as a modulus clock divider with EVO pin, freerunning counter (when compare register is \$00), or periodic interrupt timer.

The timer counter 2 (TCNT2) is an 8-bit up counter with preset input. The counter is preset to \$01 by a CMP2 signal from the comparator or by a CPU write to it that is done while the system clock (PH2) is low.



Figure 9-5. Timer 2 Block Diagram

MOTOROLA

The CLK2 from the prescaler or the EXTCLK from the EVI block is selected as timer clock by the T2CLK bit in the TCR2 register. The CLK2 and the EXCLK are synchronized to the falling edge of system clock in the prescaler and the EVI blocks. The minimum pulse width of CLK2 is the same as the system clock, and the minimum pulse width of EXCLK (event mode) is one PH2 cycle. When the EXCLK (event mode) is selected, 50% duty is not guaranteed.

The counter is incremented by the falling edge of the timer clock and the period between two falling edges is defined as one timer cycle in the following description.

The compare register (OC2) is provided for comparison with the timer counter 2 (TCNT2). The OC2 data is transferred to the buffer register when the counter is preset by a CPU write or by a compare output (CMP2). This buffer register is compared with the timer counter 2 (TCNT2).

The comparison between the counter and the OC2 buffer register is done when the system clock is high in each bus cycle. If the counter matches with the OC2 buffer register, the comparator latches this result during the current timer cycle. When the next timer cycle begins, the comparator outputs CMP2 signal (if the compare match is detected during previous timer cycle). This CMP2 is used in the counter preset data transfer to the buffer register, setting OC2F in the TSR2 and the EVO block. The counter preset overrides the counter increment.

The OC2F bit may generate interrupt requests if the OC2IE bit in the TCR2 is set.

MC68HC(7)05L5 - Rev. 2.0

Timer System

OC2 = 2, 3, 4 . . . FF, 0









General Release Specification

MC68HC(7)05L5-Rev. 2.0





MC68HC(7)05L5-Rev. 2.0

Timer System

9.4.1 Timer Control Register 2



Figure 9-8. Timer Control Register 2 (TCR2)

TI2IE — Timer Input 2 Interrupt Enable

The TI2IE bit enables timer input 2 (EVI) interrupt when TI2F is set. This bit is cleared on reset.

0 = Timer input 2 interrupt disabled

1 = Timer input 2 interrupt enabled

OC2IE — Compare 2 Interrupt Enable

The OC2IE bit enables compare 2 (CMP2) interrupt when compare match is detected (OC2F is set). This bit is cleared on reset.

0 = Timer input 2 interrupt disabled

1 = Timer input 2 interrupt enabled

Bit 5 — Reserved

This bit is not used and is always read as logic 0.

T2CLK — Timer 2 Clock Select

The T2CLK bit selects the clock source for the timer counter 2. This bit is cleared on reset.

0 = CLK2 from prescaler selected

1 = EXCLK from EVI input block selected

IM2 — Timer Input 2 Mode Select

The IM2 bit selects whether EVI input is gated or not gated by CLK2. This bit is cleared on reset.

0 = EVI not gated by CLK2 (event mode)

1 = EVI gated by CLK2 (gate mode)

General Release Specification

MC68HC(7)05L5 – Rev. 2.0

IL2 — Timer Input 2 Active Edge (Level) Select

The IL2 bit selects the active edge of EVI to increment the counter for event mode (IM2 = 0) or gate enable level of EVI for gate mode (IM2 = 1). This bit is cleared on reset.

- 0 = Falling edge selected (event mode)
 - Low level enables counting (gate mode)
- 1 = Rising edge selected (event mode)
 - High level enables counting (gate mode)

| IM2 | IL2 | Action on Clock | | |
|-----|-----|--|--|--|
| 0 | 0 | Falling edge of EVI increments counter | | |
| 0 | 1 | Rising edge of EVI increments counter | | |
| 1 | 0 | Low level on EVI enables counting | | |
| 1 | 1 | High level on EVI enables counting | | |

Table 9-1. EVI Modes Selection

OE2 — Timer Output 2 (EVO) Output Enable

The OE2 bit enables EVO output on the PC5 pin. When this bit is changed, control of the pin is delayed (synchronized) until the next active edge of EVO is selected by the OL2 bit. This bit is cleared on reset.

- 0 = EVO output disabled
- 1 = EVO output enabled
- OL2 Timer Output 2 Edge Select for Synchronization

The OL2 bit selects which edge of EVO clock should be synchronized by the OE2 bit control. The OL2 bit also decides the initial value of the CMP2 divider, when counter 2 is written to by the CPU. This bit is cleared on reset.

- 0 = The falling edge of EVO switches EVO output and PC5 if the OE2 bit has been changed.
- 1 = The rising edge of EVO switches EVO output and PC5 if the OE2 bit has been changed.

Timer System

9.4.2 Timer Status Register 2

| Address: | \$001D | | | | | | | |
|----------|-----------------|------|---|---|-------|-------|---|-------|
| | Blt 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
| Read: | TI2F | OC2F | 0 | 0 | 0 | 0 | 0 | 0 |
| Write: | | | 0 | 0 | RTI2F | ROC2F | 0 | 0 |
| Reset: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| [| = Unimplemented | | | | | | | |
| | _ | | _ | _ | | | _ | |

Figure 9-9. Timer Status Register 2 (TSR2)

TI2F — Timer Input 2 (EVI) Interrupt Flag

In event mode, the event edge sets TI2F. In gated time accumulation mode, the trailing edge of the gate signal at the EVI input pin sets TI2F. When the TI2IE bit and this bit are set, an interrupt is generated. This bit is a read-only bit and writes have no effect. The TI2F is cleared by writing a logic 1 to the RTI2F bit and on reset.

OC2F — Compare 2 Interrupt Flag

The OC2F bit is set when compare match is detected between counter 2 and OC2 register. When OC2IE bit and this bit are set, an interrupt is generated. This bit is a read-only bit and writes have no effect. The OC2F is cleared by writing a logic 1 to ROC2F bit and on reset.

Bits 5 and 4 — Reserved

These bits are not used and always read as logic 0.

RTI2F — Reset Timer Input 2 Flag

The RTI2F bit is a write-only bit and always reads as logic 0. Writing logic 1 to this bit clears the TI2F bit and writing a logic 0 to this bit has no effect.

ROC2F — Reset Output Compare 2 Flag

The ROC2F bit is a write-only bit and always reads as logic 0. Writing logic 1 to this bit clears the OC2F bit and writing a logic 0 to this bit has no effect.

Bits 1 and 0 — Reserved

These bits are not used and always read as logic 0.

General Release Specification

MC68HC(7)05L5 – Rev. 2.0

9.4.3 Output Compare Register 2



Figure 9-10. Output Compare Register 2 (OC2)

The OC2 register data is transferred to the buffer register when the CPU writes to TCNT2, when the CMP2 presets the TCNT2, or when system resets.

When the OC2 buffer register matches the TCNT2 register, the OC2F bit in the TSR2 register is set and TCNT2 is preset to \$01.

9.4.4 Timer Counter Register 2





TCNT2 is incremented by the falling edge of the timer clock, which is synchronized and has the same timing as the falling edge of PH2.

The TCNT2 register is compared with the OC2 buffer register and initialized to \$01 if it matches. It is also initialized to \$01 on reset and any CPU write to this register.

The CPU read of this counter should be done while PH2 is high. Data may be latched by the local or main data bus while PH2 is low.

MOTOROLA

Timer System

9.4.5 Timebase Control Register 1



Figure 9-12. Timebase Control Register 1 (TBCR1)

T2R1/T2R0 — Prescale Rate Select Bits for Timer 2

The T2R1 and T2R0 bits select prescale rate of CLK2 for timer 2 and timer input 2. These bits are cleared on reset.

 Table 9-2. Time Base Prescale Rate Selection

| T2R1 | T2R0 | System Clock Divided by | | |
|------|------|----------------------------|--|--|
| 0 | 0 | 1 | | |
| 0 | 1 | 4 | | |
| 1 | 0 | 32 | | |
| 1 | 1 | 256 | | |

9.4.6 Timer Input 2 (EVI)

The event input (EVI) is used as an external clock input for timer 2.



Figure 9-13. EVI Block Diagram

MC68HC(7)05L5-Rev. 2.0

Since the external clock may be asynchronous to the internal clock, this input has a synchronizer which samples external clock by the internal system clock. (The input transition synchronizes to the falling edge of PH2. Therefore, to be measured, the minimum pulse width for EVI must be larger than one system clock.)

The IM2 and IL2 bits in the TCR2 determine how this synchronized external clock is used. The IM2 bit decides between event mode and gate mode, and the IL2 bit decides which level or edge is activated.

In event mode (IM2 = 0), the external clock drives the timer 2 counter directly and the active edge at the EVI pin is selected by the IL2 bit. When an active edge is detected, the TI2F bit in the TCR2 is set.

| IM2 | IL2 | Action on Clock | | |
|-----|-----|--|--|--|
| 0 | 0 | Falling edge of EVI increments counter | | |
| 0 | 1 | Rising edge of EVI increments counter | | |
| 1 | 0 | Low level on EVI enables counting | | |
| 1 | 1 | High level on EVI enables counting | | |

Table 9-3. EVI Modes Selection

NOTE: Since the EVI pin is shared with the PC4 I/O pin, DDRC4 should always be cleared whenever EVI is used. EVI should not be used when DDRC4 is high.

In gate mode (IM2 = 1), the EVI input is gated by CLK2 from the prescaler and gate output drives the timer 2 counter. The IL2 bit decides active level of the external input. When the transition from active level to inactive level is detected, the TI2F bit is set.

Changing the IM2 bit may cause an illegal count up of TCNT2, thus presetting TCNT2 after initializing IM2 is required.

Timer System

IM2 = 0 Event Mode



IM2 = 1 Gate Mode



Figure 9-14. EVI Timing Diagram

General Release Specification

MC68HC(7)05L5-Rev. 2.0

9.4.7 Event Output (EVO)

The EVO pin is the clock output pin of timer 2. The compare output from the timer 2 (CMP2) is divided in this block for 50% duty output signal. This 1/2 divider is initialized to the level of the OL2 bit when the timer counter 2 is written to by the CPU (initialized). When the OE2 bit in the timer control register 2 (TCR2) is set, the EVO output is activated, and, when OE2 is cleared, EVO is deactivated. These controls must be done synchronously to the EVO output signal to avoid an incomplete pulse on the pin. The OL2 bit in the TCR2 decides which edge of EVO should be synchronized.

When the DDRC5 bit is set or the synchronized output enable is high (clock on), the output buffer at the EVO/PC5 pin is enabled. If the DDRC5 bit is set to 1, the pin state during the idling condition (clock off) depends on the PC5 output data latch. If the DDRC5 bit is cleared, the pin becomes high impedance during clock off.



Figure 9-15. EVO Block Diagram

Timer System





Figure 9-16. EVO Timing Diagram

MC68HC(7)05L5-Rev. 2.0

9.5 Prescaler

The 8-bit prescaler in the timer system divides system clock (PH2) and provides divided clock to each timer and event input.

CLK1 for timer 1 is a fixed frequency clock (PH2/PH4).

CLK2 for timer 2 is selected by T2R1 and T2R0 bits in the TBCR1, and this clock is also used as the event input for gate mode. The CLK2 transitions must be synchronous to the falling edge of PH2.

| T2R1 | T2R0 | System Clock Divided by | | |
|------|------|----------------------------|--|--|
| 0 | 0 | 1 | | |
| 0 | 1 | 4 | | |
| 1 | 0 | 32 | | |
| 1 | 1 | 256 | | |

 Table 9-4. Timebase Prescale Rate Selection



Figure 9-17. Prescaler Block Diagram

Timer System

General Release Specification

MC68HC(7)05L5-Rev. 2.0

MOTOROLA

General Release Specification — MC68HC05L5

Section 10. LCD Driver

10.1 Contents

| 10.2 | Introduction |
|------|--------------------------------------|
| 10.3 | LCD Waveform Examples140 |
| 10.4 | Backplane Driver and Port Selection |
| 10.5 | Frontplane Driver and Port Selection |
| 10.6 | LCD Control Register146 |
| 10.7 | LCD Data Register |

10.2 Introduction

The LCD driver may be configured with four backplanes (BP) and 39 frontplanes (FP) maximum. The V_{DD} voltage is the highest level of the output waveform and the lower three levels are applied from VLCD1, VLCD2, and VLCD3 inputs.

On reset, LCD enable bit (LCDE) in the LCD control register (LCDCR) is cleared (LCD drivers at a disabled state) and all BP pins and FP pins output V_{DD} levels.

The LCD clock is generated by the timebase module, and the LCLK bit in the TBCR1 selects the clock frequency.

MC68HC(7)05L5 - Rev. 2.0

LCD Driver

10.3 LCD Waveform Examples

Figure 10-1, **Figure 10-2**, **Figure 10-3**, and **Figure 10-4** illustrate the LCD timing examples.



Figure 10-1. LCD 1/1 Duty and 1/1 Bias Timing Diagram

Freescale Semiconductor, Inc.

General Release Specification

MC68HC(7)05L5-Rev. 2.0

MOTOROLA

LCD Driver LCD Waveform Examples



Figure 10-2. LCD 1/2 Duty and 1/2 Bias Timing Diagram

MC68HC(7)05L5-Rev. 2.0

LCD Driver



Figure 10-3. LCD 1/3 Duty and 1/3 Bias Timing Diagram

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

LCD Driver LCD Waveform Examples





MC68HC(7)05L5 - Rev. 2.0

General Release Specification

Freescale Semiconductor, Inc.

LCD Driver

10.4 Backplane Driver and Port Selection

The number of backplane (port D) pins depends on the LCD duty. It is automatically selected by DUTY1 and DUTY0 bits in the LCD control register (LCDCR). On reset, these bits are cleared and 1/4 duty is selected. (See **Table 10-1**.)

| Duty | LCD C | ontrol | Pin Selection | | | |
|-------|-------|--------|---------------|---------|---------|-----|
| | DUTY1 | DUTY0 | BP3/PD3 | BP2/PD2 | BP1/PD1 | BP0 |
| 1 / 1 | 0 | 1 | PD3 | PD2 | PD1 | BP0 |
| 1 / 2 | 1 | 0 | PD3 | PD2 | BP1 | BP0 |
| 1/3 | 1 | 1 | PD3 | BP2 | BP1 | BP0 |
| 1 / 4 | 0 | 0 | BP3 | BP2 | BP1 | BP0 |

Table 10-1. Backplane and Port Selection

General Release Specification

MC68HC(7)05L5-Rev. 2.0

Semiconductor, Inc.

reescale

LL.
10.5 Frontplane Driver and Port Selection

The number of frontplane (FP) pins depends on the number of port D and port E bits. If port bits are selected as a parallel output port, the number of the FP pins is decreased to 27 as a minimum. The selections between frontplane and port (nibble wide) are done by the PEH, PEL, and PDH bits in the LCDCR (see **Table 10-2**). On reset, port D and port E bits are disconnected and FP27–FP38 pins output V_{DD} levels.

| FP / Port Control | | Port Selection | | | |
|-------------------|-----|---|-----------|-----------------------|-----------|
| PEH | PEL | EL PDH FP27:FP30/ FP31:FP34/ PE7:PE4 PE3:PE0 | | FP35:FP38/ PD7:PD4 | |
| | | 0 | | | FP35:FP38 |
| | | 1 | | | PD7:PD4 |
| | 0 | | | FP31:FP34 | |
| | 1 | | | PE3:PE0 | |
| 0 | | | FP27:FP30 | | |
| 1 | | | PE7:PE4 | | |

Table 10-2. Frontplane and Port Selection

LCD Driver

10.6 LCD Control Register



Figure 10-5. LCD Control Register (LCDCR)

LCDE — LCD Output Enable

The LCDE bit enables all BP and FP outputs. (This bit does not affect PEH, PEL, or PDH bits.) This bit is cleared on reset.

- 0 = All dedicated FP pins output highest (V_{DD}) level; BP and FP pins are shared with an output port data.
- 1 = All BP and FP pins output LCD waveforms.

DUTY1 and DUTY0 - LCD Duty Select

The DUTY1 and DUTY0 bits select the duty of the LCD driver. The number of BP pins is related to this duty selection. The unused BP pin is used as a port D pin. Default duty is 1/4 duty. These bits are cleared on reset. See **Table 10-1**.

Bit 4 — Reserved

This bit is not used and always reads as logic 0.

PEH — Select Port E (H)

The PEH bit enables the upper four bits of port E instead of LCD drivers. This bit is cleared on reset. See **10.5 Frontplane Driver and Port Selection**.

0 = FP27–FP30 selected

1 = PE7–PE4 selected

MC68HC(7)05L5-Rev. 2.0

PEL — Select Port E (L)

The PEL bit enables the lower four bits of port E instead of LCD drivers. This bit is cleared on reset. See **10.5 Frontplane Driver and Port Selection**.

0 = FP31-FP34 selected

1 = PE3–PE0 selected

PDH — Select Port D (H)

The PDH bit enables the upper four bits of port D instead of LCD drivers. This bit is cleared on reset. See **10.5 Frontplane Driver and Port Selection**.

0 = FP35–FP38 selected

1 = PD7–PD4 selected

Bit 0 — Reserved

This bit is not used and is always read as logic 0.

MC68HC(7)05L5 - Rev. 2.0

LCD Driver

10.7 LCD Data Register

| 21–\$0034 |
|-----------|
| |

| | FP (2x–1) | | | | FP (2x–2) | | | |
|-----------------|-----------|-----|-----|------------|------------|-----|-----|-------|
| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
| Read: Write: | BP3 | BP2 | BP1 | BP0 | BP3 | BP2 | BP1 | BP0 |
| Reset: | | | | Unaffected | d by Reset | | | |

Figure 10-6. LDC Data Registers

LCDRx — LCD Data Registers

Data in the LCDR*x* (LCDR1–LCDR20) controls the waveform of the two frontplane drivers. Bits 0–3 and bits 4–7 of this register decide the waveforms at the BP0–BP3 timings. If the LCD duty is not 1/4, the register bit for the unused backplane has no meaning. The upper four bits of LCDR20 are not implemented and unknown data may be read. (See **Table 10-3**.)

- 0 = Output deselect waveform at the corresponding backplane timing
- 1 = Output select waveform at the corresponding backplane timing

| Duty | | Frontplane Data Register Bit Usage | | | | | | |
|-------|-------|------------------------------------|-------|-------|-------|-------|-------|-------|
| Duty | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
| 1 / 1 | _ | _ | _ | BP0 | _ | _ | _ | BP0 |
| 1 / 2 | _ | _ | BP1 | BP0 | _ | _ | BP1 | BP0 |
| 1/3 | _ | BP2 | BP1 | BP0 | _ | BP2 | BP1 | BP0 |
| 1 / 4 | BP3 | BP2 | BP1 | BP0 | BP3 | BP2 | BP1 | BP0 |

Table 10-3. Frontplane Data Register Bit Usage

MOTOROLA

Section 11. Instruction Set

11.1 Contents

| 11.2 In | troduction |
|---------|--------------------------------|
| 11.3 Ao | ddressing Modes150 |
| 11.3.1 | Inherent |
| 11.3.2 | Immediate |
| 11.3.3 | Direct |
| 11.3.4 | Extended |
| 11.3.5 | Indexed, No Offset152 |
| 11.3.6 | Indexed, 8-Bit Offset152 |
| 11.3.7 | Indexed,16-Bit Offset |
| 11.3.8 | Relative |
| 11.4 In | struction Types153 |
| 11.4.1 | Register/Memory Instructions |
| 11.4.2 | Read-Modify-Write Instructions |
| 11.4.3 | Jump/Branch Instructions156 |
| 11.4.4 | Bit Manipulation Instructions |
| 11.4.5 | Control Instructions |
| 11.5 ln | struction Set Summary160 |
| 11.6 O | pcode Map |
| | |

MC68HC(7)05L5 - Rev. 2.0

Instruction Set

11.2 Introduction

The MCU instruction set has 62 instructions and uses eight addressing modes. The instructions include all those of the M146805 CMOS Family plus one more: the unsigned multiply (MUL) instruction. The MUL instruction allows unsigned multiplication of the contents of the accumulator (A) and the index register (X). The high-order product is stored in the index register, and the low-order product is stored in the accumulator.

11.3 Addressing Modes

The CPU uses eight addressing modes for flexibility in accessing data. The addressing modes provide eight different ways for the CPU to find the data required to execute an instruction. The eight addressing modes are:

- Inherent
- Immediate
- Direct
- Extended
- Indexed, no offset
- Indexed, 8-bit offset
- Indexed, 16-bit offset
- Relative

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

11.3.1 Inherent

Inherent instructions are those that have no operand, such as return from interrupt (RTI) and stop (STOP). Some of the inherent instructions act on data in the CPU registers, such as set carry flag (SEC) and increment accumulator (INCA). Inherent instructions require no operand address and are one byte long.

11.3.2 Immediate

Immediate instructions are those that contain a value to be used in an operation with the value in the accumulator or index register. Immediate instructions require no operand address and are two bytes long. The opcode is the first byte, and the immediate data value is the second byte.

11.3.3 Direct

Direct instructions can access any of the first 256 memory locations with two bytes. The first byte is the opcode, and the second is the low byte of the operand address. In direct addressing, the CPU automatically uses \$00 as the high byte of the operand address.

11.3.4 Extended

Extended instructions use three bytes and can access any address in memory. The first byte is the opcode; the second and third bytes are the high and low bytes of the operand address.

When using the Motorola assembler, the programmer does not need to specify whether an instruction is direct or extended. The assembler automatically selects the shortest form of the instruction.

Instruction Set

11.3.5 Indexed, No Offset

Indexed instructions with no offset are 1-byte instructions that can access data with variable addresses within the first 256 memory locations. The index register contains the low byte of the effective address of the operand. The CPU automatically uses \$00 as the high byte, so these instructions can address locations \$0000–\$00FF.

Indexed, no offset instructions are often used to move a pointer through a table or to hold the address of a frequently used RAM or I/O location.

11.3.6 Indexed, 8-Bit Offset

Indexed, 8-bit offset instructions are 2-byte instructions that can access data with variable addresses within the first 511 memory locations. The CPU adds the unsigned byte in the index register to the unsigned byte following the opcode. The sum is the effective address of the operand. These instructions can access locations \$0000–\$01FE.

Indexed 8-bit offset instructions are useful for selecting the kth element in an n-element table. The table can begin anywhere within the first 256 memory locations and could extend as far as location 510 (\$01FE). The k value is typically in the index register, and the address of the beginning of the table is in the byte following the opcode.

11.3.7 Indexed, 16-Bit Offset

Indexed, 16-bit offset instructions are 3-byte instructions that can access data with variable addresses at any location in memory. The CPU adds the unsigned byte in the index register to the two unsigned bytes following the opcode. The sum is the effective address of the operand. The first byte after the opcode is the high byte of the 16-bit offset; the second byte is the low byte of the offset.

Indexed, 16-bit offset instructions are useful for selecting the kth element in an n-element table anywhere in memory.

As with direct and extended addressing, the Motorola assembler determines the shortest form of indexed addressing.

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

Semiconductor, Inc

1

eescal

11.3.8 Relative

Relative addressing is only for branch instructions. If the branch condition is true, the CPU finds the effective branch destination by adding the signed byte following the opcode to the contents of the program counter. If the branch condition is not true, the CPU goes to the next instruction. The offset is a signed, two's complement byte that gives a branching range of -128 to +127 bytes from the address of the next location after the branch instruction.

When using the Motorola assembler, the programmer does not need to calculate the offset, because the assembler determines the proper offset and verifies that it is within the span of the branch.

11.4 Instruction Types

The MCU instructions fall into the following five categories:

- Register/Memory Instructions
- Read-Modify-Write Instructions
- Jump/Branch Instructions
- Bit Manipulation Instructions
- Control Instructions

Instruction Set

11.4.1 Register/Memory Instructions

These instructions operate on CPU registers and memory locations. Most of them use two operands. One operand is in either the accumulator or the index register. The CPU finds the other operand in memory.

| Instruction | Mnemonic |
|---|----------|
| Add Memory Byte and Carry Bit to Accumulator | ADC |
| Add Memory Byte to Accumulator | ADD |
| AND Memory Byte with Accumulator | AND |
| Bit Test Accumulator | BIT |
| Compare Accumulator | CMP |
| Compare Index Register with Memory Byte | СРХ |
| EXCLUSIVE OR Accumulator with Memory Byte | EOR |
| Load Accumulator with Memory Byte | LDA |
| Load Index Register with Memory Byte | LDX |
| Multiply | MUL |
| OR Accumulator with Memory Byte | ORA |
| Subtract Memory Byte and Carry Bit from Accumulator | SBC |
| Store Accumulator in Memory | STA |
| Store Index Register in Memory | STX |
| Subtract Memory Byte from Accumulator | SUB |

Table 11-1. Register/Memory Instructions

General Release Specification

MC68HC(7)05L5-Rev. 2.0

11.4.2 Read-Modify-Write Instructions

These instructions read a memory location or a register, modify its contents, and write the modified value back to the memory location or to the register.

NOTE: Do not use read-modify-write operations on write-only registers.

| Instruction | Mnemonic |
|-------------------------------------|---------------------|
| Arithmetic Shift Left (Same as LSL) | ASL |
| Arithmetic Shift Right | ASR |
| Bit Clear | BCLR ⁽¹⁾ |
| Bit Set | BSET ⁽¹⁾ |
| Clear Register | CLR |
| Complement (One's Complement) | СОМ |
| Decrement | DEC |
| Increment | INC |
| Logical Shift Left (Same as ASL) | LSL |
| Logical Shift Right | LSR |
| Negate (Two's Complement) | NEG |
| Rotate Left through Carry Bit | ROL |
| Rotate Right through Carry Bit | ROR |
| Test for Negative or Zero | TST ⁽²⁾ |
| | |

1. Unlike other read-modify-write instructions, BCLR and BSET use only direct addressing.

2. TST is an exception to the read-modify-write sequence because it does not write a replacement value.

Instruction Set

11.4.3 Jump/Branch Instructions

Jump instructions allow the CPU to interrupt the normal sequence of the program counter. The unconditional jump instruction (JMP) and the jump-to-subroutine instruction (JSR) have no register operand. Branch instructions allow the CPU to interrupt the normal sequence of the program counter when a test condition is met. If the test condition is not met, the branch is not performed.

The BRCLR and BRSET instructions cause a branch based on the state of any readable bit in the first 256 memory locations. These 3-byte instructions use a combination of direct addressing and relative addressing. The direct address of the byte to be tested is in the byte following the opcode. The third byte is the signed offset byte. The CPU finds the effective branch destination by adding the third byte to the program counter if the specified bit tests true. The bit to be tested and its condition (set or clear) is part of the opcode. The span of branching is from -128 to +127 from the address of the next location after the branch instruction. The CPU also transfers the tested bit to the carry/borrow bit of the condition code register.

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

MOTOROLA

| Instruction | Mnemonic |
|--------------------------------|----------|
| Branch if Carry Bit Clear | BCC |
| Branch if Carry Bit Set | BCS |
| Branch if Equal | BEQ |
| Branch if Half-Carry Bit Clear | BHCC |
| Branch if Half-Carry Bit Set | BHCS |
| Branch if Higher | BHI |
| Branch if Higher or Same | BHS |
| Branch if IRQ Pin High | BIH |
| Branch if IRQ Pin Low | BIL |
| Branch if Lower | BLO |
| Branch if Lower or Same | BLS |
| Branch if Interrupt Mask Clear | BMC |
| Branch if Minus | BMI |
| Branch if Interrupt Mask Set | BMS |
| Branch if Not Equal | BNE |
| Branch if Plus | BPL |
| Branch Always | BRA |
| Branch if Bit Clear | BRCLR |
| Branch Never | BRN |
| Branch if Bit Set | BRSET |
| Branch to Subroutine | BSR |
| Unconditional Jump | JMP |
| Jump to Subroutine | JSR |

MC68HC(7)05L5-Rev. 2.0

Instruction Set

11.4.4 Bit Manipulation Instructions

The CPU can set or clear any writable bit in the first 256 bytes of memory, which includes I/O registers and on-chip RAM locations. The CPU can also test and branch based on the state of any bit in any of the first 256 memory locations.

| Instruction | Mnemonic |
|---------------------|----------|
| Bit Clear | BCLR |
| Branch if Bit Clear | BRCLR |
| Branch if Bit Set | BRSET |
| Bit Set | BSET |

General Release Specification

MC68HC(7)05L5 - Rev. 2.0

11.4.5 Control Instructions

These instructions act on CPU registers and control CPU operation during program execution.

| Table 11-5. | Control | Instructions |
|-------------|---------|--------------|
|-------------|---------|--------------|

| Instruction | Mnemonic |
|--|----------|
| Clear Carry Bit | CLC |
| Clear Interrupt Mask | CLI |
| No Operation | NOP |
| Reset Stack Pointer | RSP |
| Return from Interrupt | RTI |
| Return from Subroutine | RTS |
| Set Carry Bit | SEC |
| Set Interrupt Mask | SEI |
| Stop Oscillator and Enable IRQ Pin | STOP |
| Software Interrupt | SWI |
| Transfer Accumulator to Index Register | TAX |
| Transfer Index Register to Accumulator | TXA |
| Stop CPU Clock and Enable Interrupts | WAIT |

Instruction Set

11.5 Instruction Set Summary

| Source Form | Operation Description | | | | | | n | Address Mode | Opcode | Operand | Cycles |
|--|---------------------------------------|---|----|---|----|----|----|---------------------------------------|--|--|--|
| | | | н | I | Ν | Z | С | ₽₫ ₽ | do | ð | ပ် |
| ADC #opr ADC opr ADC opr ADC opr,X ADC opr,X ADC ,X | Add with Carry | $A \gets (A) + (M) + (C)$ | \$ | _ | \$ | \$ | \$ | IMM DIR EXT IX2 IX1 IX | A9 B9 C9 D9 E9 F9 | ii dd hh II ee ff ff | 2 3 4 5 4 3 |
| ADD #opr ADD opr ADD opr ADD opr,X ADD opr,X ADD ,X | Add without Carry | A ← (A) + (M) | \$ | | \$ | \$ | \$ | IMM DIR EXT IX2 IX1 IX | AB BB CB DB EB FB | ii dd hh II ee ff ff | |
| AND #opr AND opr AND opr AND opr,X AND opr,X AND ,X | Logical AND | $A \gets (A) \land (M)$ | | | \$ | \$ | _ | IMM DIR EXT IX2 IX1 IX | A4 B4 C4 D4 E4 F4 | ii dd hh II ee ff ff | 2 3 4 5 4 3 |
| ASL opr ASLA ASLX ASL opr,X ASL ,X | Arithmetic Shift Left (Same as LSL) | | _ | _ | ¢ | \$ | \$ | DIR INH INH IX1 IX | 38 48 58 68 78 | dd ff | 5 3 3 6 5 |
| ASR opr ASRA ASRX ASR opr,X ASR ,X | Arithmetic Shift Right | | _ | _ | \$ | \$ | \$ | DIR INH INH IX1 IX | 37 47 57 67 77 | dd ff | 5 3 3 6 5 |
| BCC rel | Branch if Carry Bit Clear | $PC \leftarrow (PC) + 2 + \mathit{rel} ? C = 0$ | - | — | - | | - | REL | 24 | rr | 3 |
| BCLR n opr | Clear Bit n | Mn ← 0 | | | | | | | 11 13 15 17 19 1B 1D 1F | dd dd dd dd dd dd dd dd dd | 5 5 5 5 5 5 5 5 5 5 |
| BCS rel | Branch if Carry Bit Set (Same as BLO) | PC ← (PC) + 2 + <i>rel</i> ? C = 1 | - | - | | - | _ | REL | 25 | rr | 3 |
| BEQ rel | Branch if Equal | PC ← (PC) + 2 + <i>rel</i> ? Z = 1 | - | - | - | - | _ | REL | 27 | rr | 3 |
| BHCC rel | Branch if Half-Carry Bit Clear | $PC \leftarrow (PC) + 2 + \mathit{rel} ? H = 0$ | _ | _ | _ | _ | _ | REL | 28 | rr | 3 |
| BHCS rel | Branch if Half-Carry Bit Set | PC ← (PC) + 2 + <i>rel</i> ? H = 1 | _ | | _ | _ | _ | REL | 29 | rr | 3 |

Table 11-6. Instruction Set Summary

General Release Specification

160

MC68HC(7)05L5-Rev. 2.0

Instruction Set For More Information On This Product, Go to: www.freescale.com

| Source Form | Operation | Description | | Eff | eci C | | n | Address Mode | Opcode | Operand | Cycles |
|--|---------------------------------------|--|---|-----|----------|----|----|--|----------------------------------|---|--|
| Form | • | | Н | I | Ν | Z | С | Add | 0 D | Ope | 2 |
| BHI rel | Branch if Higher | $PC \leftarrow (PC) + 2 + \mathit{rel} ? C \lor Z = 0$ | - | — | _ | | | REL | 22 | rr | 3 |
| BHS rel | Branch if Higher or Same | $PC \leftarrow (PC) + 2 + \mathit{rel} ? C = 0$ | - | _ | _ | _ | | REL | 24 | rr | 3 |
| BIH <i>rel</i> | Branch if IRQ Pin High | PC ← (PC) + 2 + <i>rel</i> ? IRQ = 1 | _ | _ | _ | _ | | REL | 2F | rr | 3 |
| BIL <i>rel</i> | Branch if IRQ Pin Low | $PC \leftarrow (PC) + 2 + \mathit{rel} ? IRQ = 0$ | - | _ | _ | — | | REL | 2E | rr | 3 |
| BIT #opr BIT opr BIT opr,X BIT opr,X BIT opr,X BIT ,X | Bit Test Accumulator with Memory Byte | (A) ∧ (M) | | _ | \$ | \$ | | IMM DIR EXT IX2 IX1 IX | A5 B5 C5 D5 E5 F5 | dd hh ll ee ff | |
| BLO <i>rel</i> | Branch if Lower (Same as BCS) | PC ← (PC) + 2 + <i>rel</i> ? C = 1 | _ | _ | _ | | | REL | 25 | rr | 3 |
| BLS rel | Branch if Lower or Same | $PC \leftarrow (PC) + 2 + \mathit{rel} ? C \lor Z = 1$ | _ | — | _ | | | REL | 23 | rr | 3 |
| BMC rel | Branch if Interrupt Mask Clear | $PC \leftarrow (PC) + 2 + \mathit{rel} ? I = 0$ | - | _ | _ | | | REL | 2C | rr | 3 |
| BMI rel | Branch if Minus | PC ← (PC) + 2 + <i>rel</i> ? N = 1 | - | — | _ | | | REL | 2B | rr | 3 |
| BMS rel | Branch if Interrupt Mask Set | PC ← (PC) + 2 + <i>rel</i> ? I = 1 | | - | _ | | | REL | 2D | rr | 3 |
| BNE rel | Branch if Not Equal | $PC \leftarrow (PC) + 2 + \mathit{rel} ? Z = 0$ | - | _ | _ | _ | | REL | 26 | rr | 3 |
| BPL <i>rel</i> | Branch if Plus | $PC \leftarrow (PC) + 2 + \mathit{rel} ? N = 0$ | - | _ | _ | — | | REL | 2A | rr | 3 |
| BRA <i>rel</i> | Branch Always | PC ← (PC) + 2 + <i>rel</i> ? 1 = 1 | | _ | _ | _ | | REL | 20 | rr | 3 |
| BRCLR n opr rel | Branch if Bit n Clear | PC ← (PC) + 2 + <i>rel</i> ? Mn = 0 | | | | | \$ | DIR (b0) DIR (b1) DIR (b2) DIR (b3) DIR (b3) DIR (b4) DIR (b5) DIR (b6) DIR (b7) | 03 05 07 09 0B 0D | dd rr dd rr dd rr dd rr dd rr dd rr dd rr | 5 5 5 5 5 5 5 5 5 |
| BRN <i>rel</i> | Branch Never | $PC \leftarrow (PC) + 2 + \mathit{rel} ? 1 = 0$ | _ | _ | | _ | | REL | 21 | rr | 3 |
| BRSET n opr rel | Branch if Bit n Set | PC ← (PC) + 2 + <i>rel</i> ? Mn = 1 | | | | | \$ | DIR (b0) DIR (b1) DIR (b2) DIR (b3) DIR (b3) DIR (b4) DIR (b5) DIR (b6) DIR (b7) | 02 04 06 08 0A 0C | dd rr dd rr dd rr dd rr dd rr dd rr dd rr | 5 5 5 5 5 5 5 5 5 |
| BSET n opr | Set Bit n | Mn ← 1 | | | | | | DIR (b0) DIR (b1) DIR (b2) DIR (b3) DIR (b3) DIR (b5) DIR (b5) DIR (b6) DIR (b7) | 12 14 16 18 1A 1C | dd | 5 5 5 5 5 5 5 5 5 5 |

Table 11-6. Instruction Set Summary (Continued)

MC68HC(7)05L5 - Rev. 2.0

Instruction Set

| Source | Operation | Description | | Effo | eci CC | | n | Address Mode | Opcode | Operand | Cvcles |
|--|---|---|---|------|-----------|----|----|---------------------------------------|----------------------------------|----------------------------------|----------------------------|
| Form | | • | Н | I | Ν | Z | С | Ado Ado | 0 D | Ope | 2 |
| BSR rel | Branch to Subroutine | $\begin{array}{l} PC \leftarrow (PC) + 2; push \; (PCL) \\ SP \leftarrow (SP) - 1; push \; (PCH) \\ \qquad $ | _ | | _ | | | REL | AD | rr | 6 |
| CLC | Clear Carry Bit | $C \leftarrow 0$ | | _ | _ | _ | 0 | INH | 98 | | 2 |
| CLI | Clear Interrupt Mask | $I \leftarrow 0$ | _ | 0 | _ | _ | - | INH | 9A | | 2 |
| CLR opr CLRA CLRX CLR opr,X CLR ,X | Clear Byte | $\begin{array}{l} M \leftarrow \$00\\ A \leftarrow \$00\\ X \leftarrow \$00\\ M \leftarrow \$00\\ M \leftarrow \$00\\ M \leftarrow \$00 \end{array}$ | | | 0 | 1 | _ | DIR INH INH IX1 IX | 3F 4F 5F 6F 7F | dd ff | 5 3 3 6 5 |
| CMP #opr CMP opr CMP opr CMP opr,X CMP opr,X CMP ,X | Compare Accumulator with Memory Byte | (A) – (M) | | | \$ | \$ | \$ | IMM DIR EXT IX2 IX1 IX | A1 B1 C1 D1 E1 F1 | ii dd hh II ee ff ff | |
| COM opr COMA COMX COM opr,X COM ,X | Complement Byte (One's Complement) | $\begin{array}{l} M \leftarrow (\overline{M}) = \$FF - (M) \\ A \leftarrow (\overline{A}) = \$FF - (A) \\ X \leftarrow (\overline{X}) = \$FF - (X) \\ M \leftarrow (\overline{M}) = \$FF - (M) \\ M \leftarrow (\overline{M}) = \$FF - (M) \end{array}$ | | | \$ | \$ | 1 | DIR INH INH IX1 IX | 33 43 53 63 73 | dd ff | 5 3 3 6 5 |
| CPX #opr CPX opr CPX opr CPX opr,X CPX opr,X CPX ,X | Compare Index Register with Memory Byte | (X) – (M) | | | \$ | \$ | \$ | IMM DIR EXT IX2 IX1 IX | A3 B3 C3 D3 E3 F3 | dd hh ll | 2 3 4 5 4 3 |
| DEC opr DECA DECX DEC opr,X DEC ,X | Decrement Byte | $\begin{array}{l} M \leftarrow (M) - 1 \\ A \leftarrow (A) - 1 \\ X \leftarrow (X) - 1 \\ M \leftarrow (M) - 1 \\ M \leftarrow (M) - 1 \end{array}$ | | | \$ | \$ | _ | DIR INH INH IX1 IX | 3A 4A 5A 6A 7A | | 5 3 3 6 5 |
| EOR #opr EOR opr EOR opr EOR opr,X EOR opr,X EOR ,X | EXCLUSIVE OR Accumulator with Memory Byte | $A \gets (A) \oplus (M)$ | | | \$ | \$ | | IMM DIR EXT IX2 IX1 IX | A8 B8 C8 D8 E8 F8 | dd | |
| INC opr INCA INCX INC opr,X INC ,X | Increment Byte | $\begin{array}{l} M \leftarrow (M) + 1 \\ A \leftarrow (A) + 1 \\ X \leftarrow (X) + 1 \\ M \leftarrow (M) + 1 \\ M \leftarrow (M) + 1 \end{array}$ | | | \$ | \$ | | DIR INH INH IX1 IX | 3C 4C 5C 6C 7C | dd ff | 5 3 3 6 5 |

General Release Specification

MC68HC(7)05L5-Rev. 2.0

Freescale Semiconductor, Inc.

| Source Form | Operation | Description | | Eff (| ect CC | | n | Address Mode | Opcode | Operand | Cvcles |
|--|--------------------------------------|---|---|----------|-----------|----|----|---------------------------------------|----------------------------------|----------------------|----------------------------|
| Form | | | Н | I | Ν | Z | С | Add A | ð | ope | ပြ |
| JMP opr JMP opr JMP opr,X JMP opr,X JMP ,X | Unconditional Jump | $PC \gets Jump \; Address$ | _ | _ | _ | | | DIR EXT IX2 IX1 IX | BC CC DC EC FC | hh II ee ff ff | |
| JSR opr JSR opr JSR opr,X JSR opr,X JSR ,X | Jump to Subroutine | $\begin{array}{l} PC \leftarrow (PC) + n \ (n = 1, 2, \text{or} \ 3) \\ Push \ (PCL); \ SP \leftarrow (SP) - 1 \\ Push \ (PCH); \ SP \leftarrow (SP) - 1 \\ PC \leftarrow Effective \ Address \end{array}$ | _ | | _ | | | DIR EXT IX2 IX1 IX | BD CD DD ED FD | hh ll ee ff | - |
| LDA #opr LDA opr LDA opr LDA opr,X LDA opr,X LDA ,X | Load Accumulator with Memory Byte | A ← (M) | _ | | \$ | \$ | | IMM DIR EXT IX2 IX1 IX | A6 B6 C6 D6 E6 F6 | | 1 . |
| LDX #opr LDX opr LDX opr LDX opr,X LDX opr,X LDX ,X | Load Index Register with Memory Byte | X ← (M) | _ | | \$ | \$ | | IMM DIR EXT IX2 IX1 IX | AE BE CE DE EE FE | hh II ee ff | 2 3 4 5 4 3 |
| LSL opr LSLA LSLX LSL opr,X LSL ,X | Logical Shift Left (Same as ASL) | C - 0 b7 b0 | _ | _ | \$ | \$ | \$ | DIR INH INH IX1 IX | 38 48 58 68 78 | dd ff | 5 3 3 6 5 |
| LSR opr LSRA LSRX LSR opr,X LSR ,X | Logical Shift Right | | _ | _ | 0 | \$ | \$ | DIR INH INH IX1 IX | 34 44 54 64 74 | dd ff | 5 3 3 6 5 |
| MUL | Unsigned Multiply | $X:A \leftarrow (X) \times (A)$ | 0 | _ | - | _ | 0 | INH | 42 | | 11 |
| NEG opr NEGA NEGX NEG opr,X NEG ,X | Negate Byte (Two's Complement) | $\begin{array}{c} M \leftarrow -(M) = \$00 - (M) \\ A \leftarrow -(A) = \$00 - (A) \\ X \leftarrow -(X) = \$00 - (X) \\ M \leftarrow -(M) = \$00 - (M) \\ M \leftarrow -(M) = \$00 - (M) \end{array}$ | | | \$ | \$ | \$ | DIR INH INH IX1 IX | 30 40 50 60 70 | dd ff | 5 3 3 6 5 |
| NOP | No Operation | | - | - | - | _ | - | INH | 9D | | 2 |
| ORA #opr ORA opr ORA opr ORA opr,X ORA opr,X ORA ,X | Logical OR Accumulator with Memory | $A \gets (A) \lor (M)$ | | | \$ | \$ | | IMM DIR EXT IX2 IX1 IX | AA BA CA DA EA FA | hh ll | 2 3 4 5 4 3 |

Table 11-6. Instruction Set Summary (Continued)

Instruction Set

| Source | Operation | Description | | | eci CC | | n | Address Mode | Opcode | Operand | Cvcles |
|--|--|---|----|----|-----------|----|----|---------------------------------------|----------------------------------|----------------------------------|----------------------------|
| Form | | | н | I | Ν | Z | С | Add | 0 D | Ope | <u>ک</u> |
| ROL <i>opr</i> ROLA ROLX ROL <i>opr</i> ,X ROL ,X | Rotate Byte Left through Carry Bit | | | | \$ | \$ | \$ | DIR INH INH IX1 IX | 39 49 59 69 79 | dd ff | 5 3 3 6 5 |
| ROR <i>opr</i> RORA RORX ROR <i>opr</i> ,X ROR ,X | Rotate Byte Right through Carry Bit | | | | ¢ | \$ | \$ | DIR INH INH IX1 IX | 36 46 56 66 76 | dd ff | 5 3 3 6 5 |
| RSP | Reset Stack Pointer | $SP \leftarrow \$00FF$ | _ | _ | _ | _ | - | INH | 9C | | 2 |
| RTI | Return from Interrupt | $\begin{array}{c} SP \leftarrow (SP) + 1; Pull (CCR) \\ SP \leftarrow (SP) + 1; Pull (A) \\ SP \leftarrow (SP) + 1; Pull (X) \\ SP \leftarrow (SP) + 1; Pull (PCH) \\ SP \leftarrow (SP) + 1; Pull (PCL) \end{array}$ | \$ | \$ | \$ | \$ | \$ | INH | 80 | | 9 |
| RTS | Return from Subroutine | $\begin{array}{c} SP \leftarrow (SP) + 1; Pull (PCH) \\ SP \leftarrow (SP) + 1; Pull (PCL) \end{array}$ | _ | _ | _ | _ | _ | INH | 81 | | 6 |
| SBC #opr SBC opr SBC opr SBC opr,X SBC opr,X SBC ,X | Subtract Memory Byte and Carry Bit from Accumulator | $A \gets (A) - (M) - (C)$ | | | \$ | \$ | \$ | IMM DIR EXT IX2 IX1 IX | A2 B2 C2 D2 E2 F2 | ii dd hh II ee ff ff | 2 3 4 5 4 3 |
| SEC | Set Carry Bit | C ← 1 | _ | _ | _ | _ | 1 | INH | 99 | | 2 |
| SEI | Set Interrupt Mask | I ← 1 | _ | 1 | _ | _ | _ | INH | 9B | | 2 |
| STA opr STA opr STA opr,X STA opr,X STA ,X | Store Accumulator in Memory | M ← (A) | _ | _ | ¢ | \$ | _ | DIR EXT IX2 IX1 IX | B7 C7 D7 E7 F7 | dd hh II ee ff ff | - |
| STOP | Stop Oscillator and Enable IRQ Pin | | _ | 0 | - | _ | - | INH | 8E | | 2 |
| STX opr STX opr STX opr,X STX opr,X STX ,X | Store Index Register In Memory | M ← (X) | _ | | ¢ | \$ | _ | DIR EXT IX2 IX1 IX | BF CF DF EF FF | dd hh II ee ff ff | 4 5 6 5 4 |
| SUB #opr SUB opr SUB opr SUB opr,X SUB opr,X SUB ,X | Subtract Memory Byte from Accumulator | $A \gets (A) - (M)$ | _ | | \$ | \$ | \$ | IMM DIR EXT IX2 IX1 IX | A0 B0 C0 D0 E0 F0 | ii dd hh II ee ff ff | |

Table 11-6. Instruction Set Summary (Continued)

MC68HC(7)05L5 - Rev. 2.0

Instruction Set For More Information On This Product, Go to: www.freescale.com

| Source | Operation | Description | Effect on CCR | | | | | Address Mode | Opcode | Operand | Cvcles |
|--|--|---|---|-------------------------------------|---------------------------|---------------------------|-------|--------------------------------|----------------------------|----------|-----------------------|
| Form | | | Н | I | N | Z | С | ₽ ₽ | 0 0 | 0 0 | ပြ |
| SWI | Software Interrupt | $\begin{array}{c} PC \leftarrow (PC) + 1; Push \; (PCL) \\ SP \leftarrow (SP) - 1; \; Push \; (PCH) \\ SP \leftarrow (SP) - 1; \; Push \; (X) \\ SP \leftarrow (SP) - 1; \; Push \; (A) \\ SP \leftarrow (SP) - 1; \; Push \; (CCR) \\ SP \leftarrow (SP) - 1; \; I \leftarrow 1 \\ PCH \leftarrow \; Interrupt \; Vector \; High \; Byte \\ PCL \leftarrow \; Interrupt \; Vector \; Low \; Byte \end{array}$ | | 1 | | | | INH | 83 | | 10 |
| TAX | Transfer Accumulator to Index Register | $X \gets (A)$ | | | | | - | INH | 97 | | 2 |
| TST opr TSTA TSTX TST opr,X TST ,X | Test Memory Byte for Negative or Zero | (M) – \$00 | | | \$ | \$ | _ | DIR INH INH IX1 IX | 3D 4D 5D 6D 7D | dd ff | 4 3 3 5 4 |
| ТХА | Transfer Index Register to Accumulator | $A \leftarrow (X)$ | - | _ | _ | - | _ | INH | 9F | | 2 |
| WAIT | Stop CPU Clock and Enable Interrupts | | _ | 0 | | _ | _ | INH | 8F | | 2 |
| C Carry CCR Cond dd Direc dd rr Direc DIR Direc ee ff High EXT Exter ff Offse H Half- hh II High I Interr ii Imme | mulator //borrow flag lition code register t address of operand t address of operand and relative offset of branch in t addressing mode and low bytes of offset in indexed, 16-bit offset add nded addressing mode t byte in indexed, 8-bit offset addressing carry flag and low bytes of operand address in extended add upt mask ediate operand byte ediate addressing mode | ressing rel Relative prog ressing rr Relative prog SP Stack pointer X Index register Z Zero flag | nter nter nter ress ram r an r | · hig ilov ilon ilon co | yh b v by mc unt | yte de er c er c | offse | | | | |

Table 11-6. Instruction Set Summary (Continued)

- INH Inherent addressing mode
- IX Indexed, no offset addressing mode
- Indexed, 8-bit offset addressing mode IX1
- IX2 Indexed, 16-bit offset addressing mode
- Μ Memory location
- Negative flag Ν
- Any bit n

- Logical EXCLUSIVE OR
- Contents of ()
- Negation (two's complement) -()
- Loaded with \leftarrow
- ? lf
- Concatenated with
- \$ Set or cleared
- Not affected

11.6 Opcode Map

See Table 11-7.

Instruction Set

Freescale Semiconductor, Inc.

| | | | MSB LSB | 0 | - | 2 | 3 | 4 | 5 | 9 | 7 | 8 | 6 | A | В | c | D | ш | Ľ | |
|------------------|-------------------------|-----|------------|-------------------------|----------------------------------|----------------------------------|-----------------------------|---------------------------|---------------------|-------------------------------------|---|----------------------------------|----------------------------------|-----------------------------|-------------------|-------------------------------|---------------------|----------------------------------|----------------------------------|--|
| | | × | Ľ. | sub 3 1 SUB | 1 CMP 3 | 1 SBC 3 | 1 CPX 3 | 1 AND 3 | 1 BIT 3 | 1 LDA 3 | 1 STA 4 | 1 EOR 3 | 1 ADC 3 | 1 ORA IX | 4DD 3 | 1 JMP 2 | JSR 1 | 1 LDX 3 | stx 4 IX | e la |
| | | IX1 | ш | 2 SUB IX1 | 2 CMP 4 | 2 SBC IX1 | 2 CPX 2 IX1 | AND 2 IX1 | BIT 2 IX1 | 2 LDA IX1 | 2 STA 2 IX1 | EOR 2 IX1 | ADC ADC | 2 ORA IX1 | 4 ADD 2 IX1 | 3 JMP 2 IX1 | JSR 2 IX1 | 2 LDX IX1 | STX 2 IX1 | MSB of Opcode in Hexadecimal Number of Cycles Opcode Mnemonic Number of Bytes/Addressing Mode |
| | Register/Memory | IX2 | ۵ | 5 SUB 3 IX2 | 5 CMP 3 IX2 | 3 SBC 5 3 IX2 2 | 5 CPX 3 IX2 | 3 AND 5 3 IX2 2 | BIT 5 3 BIT 222 | 3 LDA 5 3 IX2 2 | 3 STA IX2 | EOR 3 IX2 2 | ADC 3 IX2 | 3 ORA 3 IX2 2 | ADD 3 IX2 | JMP 3 IX2 | JSR 3 IX2 | 3 LDX 5 3 IX2 2 | STX 3 IX2 | Dpcode in f Cycles Inemonic f Bytes/Add |
| | Register | ЕХТ | ပ | sub 3 SUB 5XT | CMP 4 | 3 SBC 4 | CPX 4 | | | LDA 4 3 LDA 3 | | | ADC 4 | ORA 4 | | | | | STX 5 3 STX 3 | |
| | | DIR | ۵ | SUB SUB | | SBC 3 | | | N | LDA 2 LDA 2 DIR | 2 STA 4 2 DIR 3 | EOR 3 | ADC 3 | ORA 0RA 12 DIR | | | JSR 5 2 DIR | | STX 2 DIR 3 | ۳ ص |
| | | MMI | ۲ | SUB 2 SUB 2 | CMP 2 CMP 2 | 2 SBC 2 2 IMM 2 | 2 CPX 2 CPX 2 2 IMM 2 | AND 2 2 IMM 2 | BIT 2 BIT 2 | LDA 2 2 IMM 2 | | EOR 2 2 EOR 2 | ADC 2 12 ADC 2 | | ADD 2 2 ADD 2 | | BSR 2 REL | 2 LDX 2 IMM 2 | | n o Balance |
| e Map | Control | HNI | 6 | 6 T | H | | H | | | | TAX 1 INH | CLC 2 1 CLC 2 | SEC 2 1 INH 2 | CLI 2 1 CLI 2 | SEI 2 1 NH2 | RSP 2 1 INH | NOP 2 1 INH | T D | 4 TXA 2 1 INH | LSB of Opcode in Hexadecimal |
| 11-7. Opcode Map | ပိ | HNI | œ | 1 RTI INI | RTS 1 INH | | 5 SWI X 1 SWI NH | 5 X | | 5 X | X 5 | 5 X | 5 X | 5 X | | 5 X | 4 | STOP 2 | 5 WAIT 2 X 1 WAIT 1NH | code in He |
| 11-7. | | × | 7 | NEG | | | 1 COM | LSR 1 | | ROR | ASR | ASL/LSL | ROL 1 | DEC 1 | | 1 INC | 5 TST 4 1 TST 1X | | 1 CLR | LSB of Op |
| Table . | Write | IX1 | 9 | NEG IX | | | 2 COM | LSR | | ROR 6 12 IX1 1 | ASR ASR ASR ASR | ASL/LSL 12 IX1 | 2 ROL | DEC 6 | | | TST IX | | CLR | |
| | Read-Modify-Write | HNI | 5 | NEGX | | | COMX | LSRX | | RORX RNH2 | ASRX ASRX ASRX | ASLXLSLX | 3 3 3 H1 ROLX H1 INH2 | becx DECX 11 DECX | | INCX 3 INCX 3 I 1 INH 2 | | | CLRX 3 CLRX 3 | et set |
| | Rea | HNI | 4 | 5 3 NEGA R 1 INH | | MUL ¹¹ | | LSRA LSRA | | RORA INI | ASRA ASRA ASRA | ASLA/LSLA | ROLA | | | INCA IN | TSTA IN | | CLRA 3 CLRA 1 | REL = Relative IX = Indexed, No Offset IX1 = Indexed, 8-Bit Offset IX2 = Indexed, 16-Bit Offset |
| | | DIR | e | | | | 2 COM | | | ROR DII | ASR 5 2 ASR 1 | ASL/LSL | 2 ROL | DEC 5 | | | 2 | | CLR 5 CLR 1 | REL = Relative IX = Indexed, No Offset IX1 = Indexed, 8-Bit Off IX2 = Indexed, 16-Bit Of |
| | Branch | REL | 7 | 5 BRA 8 2 REL 2 | 5 BRN 82 REL | BHI 3 2 BHI | BLS 2 BLS | BCC 3 | BCS/BL0 | 5 BNE 3 8 BNE 2 | BEQ | S BHCC A 8 BHCC A | BHCS 2 BHCS | 5 BPL 3 82 REL 2 | \sim | | 5 BMS 2 REL | 8 BIL 3 | 8 BIH 3 | REI X = X1 = |
| | Bit Manipulation | DIR | - | BSET0 BSET0 BIR 2 | BCLR0 BCLR0 BCLR0 BCLR0 | BSET1 BSET1 BSET1 BIR 2 | BCLR1 2 BCLR1 | BSET2 BSET2 BIR 2 | BCLR2 B BCLR2 B | BSET3 BSET3 BSET3 | BCLR3 2 DIR 2 | BSET4 BSET4 BSET4 BIR 2 | BCLR4 BCLR4 BCLR4 BCLR4 | BSET5 BSET5 BSET5 | BCLR5 | BSET6 BSET6 BSET6 | BCLR6 2 DIR 2 | BSET7 BSET7 BSET7 BIR 2 | BCLR7 BCLR7 BCLR7 BCLR7 | ierent imediate ect tended |
| | Bit Man | DIR | 0 | BRSET0 3 DIR 2 | BRCLR0 BRCLR0 3 DIR 2 | BRSET1 F | BRCLR1 BRCLR1 3 DIR2 | BRSET2 BRSET2 BIR 2 | BRCLR2 E 3 DIR 2 | BRSET3 BRSET3 BRSET3 BIR 2 | BRCLR3 BRCLR3 BRCLR3 BRCLR3 2 | BRSET4 BRSET4 3 DIR 2 | BRCLR4 E 3 DIR 2 | BRSET5 BRSET5 3 DIR 2 | BRCLR5 3 DIR 2 | BRSET6 BRSET6 3 DIR 2 | BRCLR6 3 DIR 2 | BRSET7 3 DIR 2 | BRCLR7 3 DIR2 | INH = Inherent IMM = Immediate DIR = Direct EXT = Extended |
| | 7-1 | • - | MSB LSB | o | - | 7 | e | 4 | 2 | 9 | 7 | 8 | 6 | A | В | U | | ш | ш | Rev 20 |

General Release Specification

MC68HC(7)05L5-Rev. 2.0

Instruction Set For More Information On This Product, Go to: www.freescale.com

General Release Specification — MC68HC05L5

Section 12. Electrical Specifications

12.1 Contents

| 12.2 | Introduction |
|-------|---|
| 12.3 | Maximum Ratings168 |
| 12.4 | Operating Temperature Range169 |
| 12.5 | Thermal Characteristics |
| 12.6 | Recommended Operating Conditions |
| 12.7 | 5.0-Volt DC Electrical Characteristics170 |
| 12.8 | 3.3-Volt DC Electrical Characteristics171 |
| 12.9 | 2.7-Volt DC Electrical Characteristics172 |
| 12.10 | Control Timing |

12.2 Introduction

This section contains parametric and timing information.

MC68HC(7)05L5 - Rev. 2.0

Electrical Specifications

12.3 Maximum Ratings

Maximum ratings are the extreme limits to which the MCU can be exposed without permanently damaging it.

The MCU contains circuitry to protect the inputs against damage from high static voltages; however, do not apply voltages higher than those shown in this table. Keep V_{In} and V_{Out} within the range $V_{SS} \leq (V_{In} \text{ or } V_{Out}) \leq V_{DD}$. Connect unused inputs to the appropriate voltage level, either V_{SS} or V_{DD} .

| Rating | Symbol | Value | Unit |
|---|--|--|------|
| Supply voltage | V _{DD} V _{LCD1} V _{LCD2} V _{LCD3} | -0.3 to +7.0 V _{SS} -0.3 to V _{DD} +0.3 V _{SS} -0.3 to V _{DD} +0.3 V _{SS} -0.3 to V _{DD} +0.3 | V |
| Input voltage | V _{In} | V_{SS} –0.3 to V_{DD} + 0.3 | V |
| Self-check mode (IRQ1 pin only) | V _{In} | V _{SS} –0.3 to 2 x V _{DD} + 0.3 | V |
| Output voltage | V _{Out} | V_{SS} –0.3 to V_{DD} + 0.3 | V |
| Current drain per pin excluding V_{DD} and V_{SS} | I | 12.5 | mA |
| Operating junction temperature | TJ | +150 | °C |
| Storage temperature range | T _{stg} | -55 to +150 | °C |

NOTE: This device is not guaranteed to operate properly at the maximum ratings. Refer to **12.7 5.0-Volt DC Electrical Characteristics** and **12.8 3.3-Volt DC Electrical Characteristics** for guaranteed operating conditions.

MC68HC(7)05L5-Rev. 2.0

MOTOROLA

12.4 Operating Temperature Range

| Characteristic | Symbol | Value | Unit |
|--|----------------|--|------|
| Operating temperature range MC68HC05L5 (standard) MC68HC05L5C (extended) | T _A | T _L to T _H 0 to +70 –40 to +85 | °C |

12.5 Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|---------------|-------|------|
| Thermal resistance 80-pin plastic quad flat pack | θ_{JA} | 120 | °C/W |

12.6 Recommended Operating Conditions

| Rating ⁽¹⁾ | Symbol | Min | Тур | Max | Unit |
|--|-------------------|----------------|-----------------------------------|-----|------|
| (f _{OP} = 2.1 MHz) | V _{DD} | 4.5 | 5.0 | 5.5 | V |
| (f _{OP} = 1.0 MHz) | V _{DD} | 2.2 | | 5.5 | V |
| Supply voltage | V _{LCD1} | VD | _D – 1/3 V _I | _CD | V |
| | V _{LCD2} | V _D | _D – 2/3 V _I | _CD | V |
| | V _{LCD3} | VD | _D – 3/3 V _I | _CD | V |
| Fast clock oscillation frequency | f _{OSC} | _ | 3.52 | 4.2 | MHz |
| External capacitance (f _{OSC} = 3.52 MHz) | C1 C2 | _ | 33 33 | _ | pF |
| Slow clock oscillation frequency | f _{XOSC} | _ | 32.768 | _ | MHz |
| External capacitance (f _{XOSC} = 32.768 kHz) | CX1 CX2 | _ | 18 22 | _ | pF |

1. +2.2 \leq V_{DD} \leq +5.5 Vdc, V_{SS} = 0 Vdc, T_L \leq T_A \leq T_H, unless otherwise noted

Electrical Specifications

12.7 5.0-Volt DC Electrical Characteristics

| Characteristic ⁽¹⁾ | Symbol | Min | Тур | Max | Unit |
|---|------------------------------------|--------------------------|---------------------------|--------------------------|----------------------|
| Output voltage $I_{Load} = 10.0 \mu A$ $I_{Load} = -10.0 \mu A$ | V _{OL} V _{OH} | V _{DD} _0.1 | _ | 0.1 | V |
| Output high voltage ($V_{DD} = 5.0 \text{ V}$) ($I_{Load} = -0.4 \text{ mA}$) PA0–PA7, PC0–PC5, PD1–PD7, PE0–PE7 | V _{OH} | V _{DD} –0.8 | _ | _ | V |
| Output low voltage (V_{DD} = 5.0 V) (I_{Load} = 0.8 mA) PA0–PA7, PC0–PC5, PD1–PD7, PE0–PE7 | V _{OL} | _ | _ | 0.4 | V |
| Input high voltage PA0–PA7, PB0–PB7, PC0–PC7, RESET, OSC1, XOSC1 | V _{IH} | 0.8 x V _{DD} | _ | V _{DD} | V |
| Input low voltage PA0–PA7, PB0–PB7, PC0–PC7, RESET, OSC1, XOSC1 | VIL | V _{SS} | _ | 0.2 x V _{DD} | V |
| $\begin{array}{l} \mbox{Supply current}^{(2), \ (3), \ (4), \ (5)} \\ \mbox{Run } (f_{op} = 2.1 \ \mbox{MHz}) \\ \mbox{Wait } (f_{op} = 2.1 \ \mbox{MHz}) \\ \mbox{Stop} \\ \mbox{No clock} \\ \mbox{XOSC} = 32.768 \ \mbox{kHz}, \ \mbox{V}_{DD} = 5.0 \ \mbox{V}, \ \mbox{T}_{A} = +25 \ \ \mbox{oC} \end{array}$ | I _{DD} | | 6.0 3.0 3.0 17.0 | 12.0 6.0 10.0 — | mA mA μA μA |
| Input current ⁽⁶⁾ (with pullups disabled) PA0–PA7, PB0–PB7, PC0–PC7, RESET, OSC1, XOSC1 | l _{in} | _ | _ | ± 1.0 | μΑ |
| Input current ⁽⁶⁾ (with pullups enabled, $V_{DD} = 5.0 \text{ V}$) PA0–PA7 PB0–PB7 PC0–PC7 | l _{in} | 40 40 150 | 150 150 500 | 340 340 1000 | μΑ μΑ μΑ |
| LCD pin output impedance FP0–FP26 BP0–BP3 | Zo, FP Zo, BP | | 10 5 | 20 18 | kΩ kΩ |

1. +4.5 \leq V_{DD} \leq +5.5 Vdc, V_{SS} = 0 Vdc, T_L \leq T_A \leq T_H, unless otherwise noted. All values shown reflect average measurements. Typical values at midpoint of voltage range, 25 °C only.

Run (Operating) I_{DD}, wait I_{DD}; measured using external square wave clock source (f_{OSC} = 4.2 MHz); all inputs 0.2 V from rail (V_{SS} or V_{DD}); no dc loads; less than 50 pF on all outputs; C_L = 20 pF on OSC2

3. Wait, stop I_DD; all ports configured as inputs; V_IL = 0.2 V; V_IH = V_DD – 0.2 V

4. Stop I_{DD} measured with OSC1 = V_{SS} .

5. Wait $I_{\mbox{\scriptsize DD}}$ is affected linearly by the OSC2 capacitance.

6. Input current is measured with output transistor turned off and $V_{In} = 0$ V.

reescale Semiconductor, Inc.

Electrical Specifications 3.3-Volt DC Electrical Characteristics

12.8 3.3-Volt DC Electrical Characteristics

| Characteristic ⁽¹⁾ | Symbol | Min | Тур | Max | Unit |
|--|------------------------------------|--------------------------|--------------------------|----------------------|----------------------|
| Output voltage $I_{Load} = 10.0 \mu A$ $I_{Load} = -10.0 \mu A$ | V _{OL} V _{OH} | V _{DD} _0.1 | _ | 0.1 | V |
| Output high voltage (V _{DD} = 3.5 V) (I _{Load} = -0.4 mA) PA0-PA7, PC0-PC5, PD1-PD7, PE0-PE7 | V _{OH} | V _{DD} –0.8 | _ | _ | V |
| Output low voltage (V _{DD} = 3.5 V) (I _{Load} = 0.8 mA) PA0–PA7, PC0–PC5, PD1–PD7, PE0–PE7 | V _{OL} | _ | _ | 0.4 | V |
| Input high voltage PA0–PA7, PB0–PB7, PC0–PC7, RESET,OSC1, XOSC1 | V _{IH} | 0.8 x V _{DD} | _ | V _{DD} | V |
| Input low voltage PA0–PA7, PB0–PB7, PC0–PC7, RESET, OSC1, XOSC1 | V _{IL} | V _{SS} | _ | 02 x V _{DD} | V |
| Supply current ^{(2), (3), (4), (5)} Run ($f_{op} = 1.0 \text{ MHz}$) Wait ($f_{op} = 1.0 \text{ MHz}$) Stop No clock XOSC = 32.768 kHz, V _{DD} = 3.0 V, T _A = +25 °C | I _{DD} | | 1.8 0.8 2.0 8.0 | 8.0 5.0 10.0 | mA mA μA μA |
| Input current ⁽⁶⁾ (with pullups disabled) PA0–PA7, PB0–PB7, PC0–PC7, RESET, OSC1, XOSC1 | l _{in} | | | ± 1.0 | μΑ |
| Input current ⁽⁶⁾ (with pullups enabled, $V_{DD} = 3.3 \text{ V}$) PA0–PA7 PB0–PB7 PC0–PC7 | l _{in} | 20 20 60 | 80 80 300 | 230 230 760 | μΑ μΑ μΑ |
| LCD pin output impedance FP0–FP26 BP0–BP3 | Zo, FP Zo, BP | | 10 5 | 20 18 | kΩ kΩ |

1. +3.0 \leq V_{DD} < +4.5 Vdc, V_{SS} = 0 Vdc, T_L \leq T_A \leq T_H, unless otherwise noted. All values shown reflect average measurements. Typical values at midpoint of voltage range, 25 °C only.

2. Run (Operating) I_{DD}, wait I_{DD}; measured using external square wave clock source (f_{OSC} = 2.0 MHz); all inputs 0.2 V from rail (V_{SS} or V_{DD}); no dc loads; less than 50 pF on all outputs; C_L = 20 pF on OSC2

3. Wait, stop I_DD; all ports configured as inputs; V_IL = 0.2 V; V_IH = V_DD – 0.2 V

4. Stop I_{DD} measured with OSC1 = V_{SS} .

5. Wait I_{DD} is affected linearly by the OSC2 capacitance.

6. Input current is measured with output transistor turned off and $V_{In} = 0 V$.

MOTOROLA

Electrical Specifications

12.9 2.7-Volt DC Electrical Characteristics

| Characteristic ⁽¹⁾ | Symbol | Min | Тур | Мах | Unit |
|--|------------------------------------|--------------------------|--------------------------|-------------------------|----------------------|
| Output voltage $I_{Load} = 10.0 \mu A$ $I_{Load} = -10.0 \mu A$ | V _{OL} V _{OH} | V _{DD} _0.1 | _ | 0.1 | V |
| Output high voltage (V _{DD} = 2.2 V) (I _{Load} = -0.4 mA) PA0-PA7, PC0-PC5, PD1-PD7, PE0-PE7 | V _{OH} | V _{DD} –0.6 | _ | _ | V |
| Output low voltage (V _{DD} = 2.2 V) (I _{Load} = 0.4 mA) PA0–PA7, PC0–PC5, PD1–PD7, PE0–PE7 | V _{OL} | _ | _ | 0.3 | V |
| Input high voltage PA0–PA7, PB0–PB7, PC0–PC7, RESET, OSC1, XOSC1 | V _{IH} | 0.8 x V _{DD} | _ | V _{DD} | V |
| Input low voltage PA0–PA7, PB0–PB7, PC0–PC7, RESET, OSC1, XOSC1 | VIL | V _{SS} | | 0.2 x V _{DD} | V |
| Supply current ^{(2), (3), (4), (5)} Run ($f_{op} = 1.0 \text{ MHz}$) Wait ($f_{op} = 1.0 \text{ MHz}$) Stop No clock XOSC = 32.768 kHz, V _{DD} = 2.2 V, T _A = +25 °C | IDD | | 0.7 0.4 1.5 5.0 | 8.0 5.0 10.0 — | mA mA μA μA |
| Input current ⁽⁶⁾ (with pullups disabled) PA0–PA7, PB0–PB7, PC0–PC7, RESET, OSC1, XOSC1 | I _{In} | _ | | ± 1.0 | μΑ |
| Input current ⁽⁶⁾ (with pullups enabled, V _{DD} = 2.7 V) PA0–PA7 PB0–PB7 PC0–PC7 | I _{In} | 5 5 30 | 40 40 150 | 110 110 420 | μΑ μΑ μΑ |
| LCD pin output impedance FP0–FP26 BP0–BP3 | Zo, FP Zo, BP | _ | 10 5 | 20 18 | kΩ kΩ |

1. +2.2 \leq V_{DD} < +3.0 Vdc, V_{SS} = 0 Vdc, T_L \leq T_A \leq T_H, unless otherwise noted. All values shown reflect average measurements. Typical values at midpoint of voltage range, 25 °C only.

Run (Operating) I_{DD}, wait I_{DD}; measured using external square wave clock source (f_{OSC} = 2.0 MHz); all inputs 0.2 V from rail (V_{SS} or V_{DD}); no dc loads; less than 50 pF on all outputs; C_L = 20 pF on OSC2

3. Wait, stop I_{DD}; all ports configured as inputs; V_{IL} = 0.2 V; V_{IH} = V_{DD} –0.2 V

4. Stop I_{DD} measured with OSC1 = V_{SS} .

5. Wait I_{DD} is affected linearly by the OSC2 capacitance.

6. Input current is measured with output transistor turned off and $V_{In} = 0 V$.

Semiconductor, Inc.

reescale

11.

12.10 Control Timing

| Characteristic ⁽¹⁾ | Symbol | Min | Max | Unit |
|---|--|------------|------------|------------------------|
| Frequency of oscillation (OSC) Crystal External clock | f _{osc} | dc | 4.2 4.2 | MHz |
| Internal operating frequency ⁽²⁾ , crystal or external clock ($f_{OSC}/2$) $V_{DD} = 4.5 \text{ V}$ to 5.5 V $V_{DD} = 2.2 \text{ V}$ to 5.5 V | f _{op} | | 2.1 1.0 | MHz |
| Cycle time (fast OSC selected) $V_{DD} = 4.5 \text{ V to } 5.5 \text{ V}$ $V_{DD} = 2.2 \text{ V to } 5.5 \text{ V}$ | t _{cyc} | 480 1.0 | _ | ns μs |
| RESET pulse width when bus clock active | t _{RL} | 1.5 | | t _{cyc} |
| Timer Resolution Input capture (TCAP) pulse width | t _{RESL} t _{TH} , t _{TL} | 4.0 284 | | t _{cyc} ns |
| Interrupt pulse width low (edge-triggered) | t _{ILIH} | 284 | _ | ns |
| Interrupt pulse period ⁽³⁾ | t _{ILIL} | note 3 | — | t _{cyc} |
| OSC1 pulse width (external clock input) | t _{OH} , t _{OL} | 110 | — | ns |

1. +2.2 \leq V_{DD} \leq +5.5 Vdc, V_{SS} = 0 Vdc, T_L \leq T_A \leq T_H, unless otherwise noted.

2. The system clock divider configuration (SYS1–SYS0 bits) should be selected such that the internal operating frequency (f_{OP}) does not exceed value specified in f_{OP} for a given f_{OSC}.

3. The minimum period, t_{ILIL}, should not be less than the number of cycle times it takes to execute the interrupt service routine plus 21 t_{cyc}.

MC68HC(7)05L5-Rev. 2.0

Electrical Specifications



Figure 12-1. Stop Recovery Timing Diagram

General Release Specification

MC68HC(7)05L5-Rev. 2.0

General Release Specification — MC68HC05L5

Section 13. Mechanical Specifications

13.1 Contents

| 13.2 | | 175 |
|------|-------------------------------------|-----|
| 13.3 | Quad Flat Pack (QFP) — Case 841B-01 | 176 |

13.2 Introduction

This section describes the dimensions of the quad flat pack (QFP).

MC68HC(7)05L5 - Rev. 2.0

Mechanical Specifications

13.3 Quad Flat Pack (QFP) — Case 841B-01



General Release Specification

MC68HC(7)05L5-Rev. 2.0

Section 14. Ordering Information

14.1 Contents

| 14.2 | Introduction |
|------|----------------------------------|
| 14.3 | MCU Ordering Forms |
| 14.4 | Application Program Media |
| 14.5 | ROM Program Verification |
| 14.6 | ROM Verification Units (RVUs)180 |
| 14.7 | MC Order Numbers |

14.2 Introduction

This section contains instructions for ordering custom-masked ROM MCUs.

14.3 MCU Ordering Forms

To initiate an order for a ROM-based MCU, first obtain the current ordering form for the MCU from a Motorola representative. Submit the following items when ordering MCUs:

- A current MCU ordering form that is **completely filled out** (Contact your Motorola sales office for assistance.)
- A copy of the customer specification if the customer specification deviates from the Motorola specification for the MCU
- Customer's application program on one of the media listed in **14.4** Application Program Media

MOTOROLA

Ordering Information

The current MCU ordering form is also available through the Motorola Freeware Bulletin Board Service (BBS). The telephone number is (512) 891-FREE. After making the connection, type bbs in lowercase letters. Then press the return key to start the BBS software.

14.4 Application Program Media

Please deliver the application program to Motorola in one of the following media:

- Macintosh^{®1} 3 1/2-inch diskette (double-sided 800 K or double-sided high-density 1.4 M)
- MS-DOS^{®2} or PC-DOS^{™3} 3 1/2-inch diskette (double-sided 720 K or double-sided high-density 1.44 M)
- MS-DOS[®] or PC-DOS[™] 5 1/4-inch diskette (double-sided double-density 360 K or double-sided high-density 1.2 M)

Use positive logic for data and addresses.

When submitting the application program on a diskette, clearly label the diskette with the following information:

- Customer name
- Customer part number
- Project or product name
- File name of object code
- Date
- Name of operating system that formatted diskette
- Formatted capacity of diskette

On diskettes, the application program must be in Motorola's S-record format (S1 and S9 records), a character-based object file format generated by M6805 cross assemblers and linkers.

General Release Specification

MC68HC(7)05L5 – Rev. 2.0

^{1.} Macintosh is a registered trademark of Apple Computer, Inc.

^{2.} MS-DOS is a registered trademark of Microsoft Corporation.

^{3.} PC-DOS is a trademark of International Business Machines Corporation.

NOTE: Begin the application program at the first user ROM location. Program addresses must correspond exactly to the available on-chip user ROM addresses as shown in the memory map. Write \$00 in all non-user ROM locations or leave all non-user ROM locations blank. Refer to the current MCU ordering form for additional requirements. Motorola may request pattern re-submission if non-user areas contain any non-zero code.

If the memory map has two user ROM areas with the same addresses, then write the two areas in separate files on the diskette. Label the diskette with both filenames.

In addition to the object code, a file containing the source code can be included. Motorola keeps this code confidential and uses it only to expedite ROM pattern generation in case of any difficulty with the object code. Label the diskette with the filename of the source code.

14.5 ROM Program Verification

The primary use for the on-chip ROM is to hold the customer's application program. The customer develops and debugs the application program and then submits the MCU order along with the application program.

Motorola inputs the customer's application program code into a computer program that generates a listing verify file. The listing verify file represents the memory map of the MCU. The listing verify file contains the user ROM code and may also contain non-user ROM code, such as self-check code. Motorola sends the customer a computer printout of the listing verify file along with a listing verify form.

To aid the customer in checking the listing verify file, Motorola will program the listing verify file into customer-supplied blank preformatted Macintosh or DOS disks. All original pattern media are filed for contractual purposes and are not returned.

Check the listing verify file thoroughly, then complete and sign the listing verify form and return the listing verify form to Motorola. The signed listing verify form constitutes the contractual agreement for the creation of the custom mask.

MOTOROLA

Ordering Information

14.6 ROM Verification Units (RVUs)

After receiving the signed listing verify form, Motorola manufactures a custom photographic mask. The mask contains the customer's application program and is used to process silicon wafers. The application program cannot be changed after the manufacture of the mask begins. Motorola then produces 10 MCUs, called RVUs, and sends the RVUs to the customer. RVUs are usually packaged in unmarked ceramic and tested to 5 Vdc at room temperature. RVUs are not tested to environmental extremes because their sole purpose is to demonstrate that the customer's user ROM pattern was properly implemented. The 10 RVUs are free of charge with the minimum order quantity. These units are not to be used for qualification or production. RVUs are not guaranteed by Motorola Quality Assurance.

14.7 MC Order Numbers

Table 14-1 shows the MC order numbers for the available package types.

| Package Type | Operating Temperature Range | MC Order Number |
|-------------------------------------|-----------------------------------|-----------------|
| 80 pip plastic guad flat pack (OEP) | 0 °C to +70 °C | MC68HC05L5FU |
| 80-pin plastic quad flat pack (QFP) | –40 °C to +85 °C | MC68HC05L5CFU |

General Release Specification

MOTOROLA
Appendix A. MC68HC705L5

A.1 Contents

| A.2 | Introduction |
|------------------|---|
| A.3 | Differences between MC68HC05L5 |
| | and MC68HC705L5182 |
| A.4 | MCU Structure |
| A.5 | Mask Options |
| A.6 | Functional Pin Description |
| A.7 | Programming Voltage (VPP) |
| A.8 | Modes of Operation |
| A.8.1 | Mode Entry |
| A.8.2 | Single-Chip Mode (SCM)187 |
| A.8.3 | Bootstrap Mode |
| A.9 | Memory Map |
| A.10 | Boot ROM |
| A.11 | EPROM |
| A.11.1 | Programming Sequence |
| A.11.2 | 2 Program Control Register |
| A.12 | COP Watchdog Timer |
| A.13 | LCD 1/2 Duty and 1/2 Bias Timing Diagram192 |
| A.14 | Electrical Specifications |
| A.14.1 | |
| A.14.2 | |
| A.14.3 | |
| A.15 | |
| A.15.1 | |
| A.15.2 | |
| A.15.3 A.15.4 | |
| - | 5 |
| A.16 | MC Order Numbers |

MC68HC(7)05L5 - Rev. 2.0

General Release Specification

Freescale Semiconductor, Inc.

A.2 Introduction

The MC68HC705L5 is similar to the MC68HC05L5 with the exception of the EPROM feature. The program ROM on the MC68HC05L5 has been replaced by 8-K electrically programmable read-only memory to allow modification of the program code for emulation. All information pertaining to the MC68HC05L5 in this document applies to the EPROM part with the additions and exceptions explained in this appendix.

The additional features available on the MC68HC705L5 are:

- 8,192 bytes of EPROM
- On-chip bootstrap firmware for programming use
- Self-check mode replaced by bootstrap capability

A.3 Differences between MC68HC05L5 and MC68HC705L5

Table A-1. Differences Between MC68HC05L5 and MC68HC705L5

| Item | MC68HC05L5 | MC68HC705L5 |
|--|--------------------------|-------------------------------------|
| ROM memory type | nory type Mask ROM EPROM | |
| Internal test mode | Self-check mode | Bootstrap mode |
| LCD 1/2 duty 1/2 bias waveform | See Figure 10-2 | See Figure A-6 |
| COP watch dog timer | Software selectable | No COP function |
| EPROM programming | Not applicable | Through V _{PP} pin and PCR |
| Mask option | Customer specified | No mask option |
| OSC, XOSC, and RESET pin resistor option | Available by mask option | Not available |

A.4 MCU Structure

Figure A-1 shows the structure of the MC68HC705L5 MCU.

General Release Specification



Note 1. The V_{PP} pin should be connected to V_{DD} in single-chip mode.

Figure A-1. Block Diagram

NOTE: A line over a signal name indicates an active low signal. For example, RESET is active low.

| MC68HC(7)05L5 - Rev. 2.0 | General Release Specification |
|--------------------------|-------------------------------|
| | |

A.5 Mask Options

There are no mask options available for the MC68HC705L5. For this reason, the MOR register at address \$000F of option map shown in **Section 2. Memory Map** has no meaning.

A.6 Functional Pin Description

The MC68HC705L5 is available in the 80-pin quad flat pack (QFP). The pin assignment is shown in **Figure A-2.**





Figure A-2. Pin Assignments for Single-Chip Mode

General Release Specification

MC68HC705L5

| Pin Number | SCM, Bootstrap | I/O | Pin Number | SCM, Bootstrap | I/O |
|--|---|---|--|--|---------------------------------|
| 23 24 25 26 27 28 29 30 | PA0 PA1 PA2 PA3 PA4 PA5 PA6 PA7 | I/O I/O I/O I/O I/O I/O I/O | 52 53 54 55 56 57 58 59 | FP0 FP1 FP2 FP3 FP4 FP5 FP6 FP7 | 0 0 0 0 0 0 0 |
| 31 32 33 34 35 36 37 38 | PB0/KWI0 PB1/KWI1 PB2/KWI2 PB3/KWI3 PB4/KWI4 PB5/KWI5 PB6/KWI6 PB7/KWI7 | | 61 62 63 64 65 66 67 68 69 | FP8 FP9 FP10 FP11 FP12 FP13 FP14 FP15 FP16 | |
| 39 40 41 42 43 44 45 46 | PC0/SDI PC1/SDO PC2/SCK PC3/TCAP PC4/EVI PC5/EVO PC6/IRQ2 PC7/IRQ1 | I/O I/O I/O I/O I/O I I | 70 71 72 73 74 75 76 77 78 | FP17 FP18 FP19 FP20 FP21 FP22 FP23 FP24 FP25 | |
| 17 | V _{PP} ⁽¹⁾ | I | 79 | FP26 | Ō |
| 47 1 60 16 21 22 18 19 | $\begin{array}{c} V_{DD} \\ V_{DD} \\ V_{SS} \\ V_{SS} \\ OSC1 \\ OSC2 \\ XOSC1 \\ XOSC2 \end{array}$ | 0 0 0 | 80 2 3 4 5 6 7 8 | FP27/PE7 FP28/PE6 FP29/PE5 FP30/PE4 FP31/PE3 FP32/PE2 FP33/PE1 FP34/PE0 | 0 0 0 0 0 0 0 |
| 15 14 13 48 49 50 51 | VLCD1 VLCD2 VLCD3 BP3/PD3 BP2/PD2 BP1/PD1 BP0 | 0 0 0 | | FP35/PD7 FP36/PD6 FP37/PD5 FP38/PD4 P pin should be co single-chip mode. | O O O O nnected to |

Table A-2. Pin Configuration

MC68HC(7)05L5 - Rev. 2.0

MOTOROLA

A.7 Programming Voltage (V_{PP})

In single-chip (user) mode, the V_{PP} pin should be tied to V_{DD} level.

A.8 Modes of Operation

The MC68HC705L5 has two operating modes: single-chip mode (SCM) and bootstrap mode.

Single-chip mode, also called user mode, allows maximum use of pins for on-chip peripheral functions.

The bootstrap mode is provided for EPROM programming, dumping EPROM contents, and loading programs into the internal RAM and executing them. This is a very versatile mode because there are essentially no limitations on the special-purpose program that is bootloaded into the internal RAM.

A.8.1 Mode Entry

Mode entry is done at the rising edge of the RESET pin. Once the device enters one of the modes, the mode cannot be changed by software. Only an external reset can change the mode.

At the rising edge of the RESET pin, the device latches the states of IRQ1 and IRQ2 and places itself in the specified mode. While the RESET pin is low, all pins are configured as single-chip mode. **Table A-3** shows the states of IRQ1 and IRQ2 for each mode entry.

High voltage $V_{TST} = 2 \times V_{DD}$ is required to select modes other than single-chip mode.

| Table | A-3. | Mode | Select | Summary |
|-------|------|------|--------|---------|
| | | | | |

| Modes | RESET | PC6/IRQ1 | PC7/IRQ2 |
|-------------------------|-------|------------------------------|----------------------|
| Single-chip (user) mode | | $\rm V_{SS}$ or $\rm V_{DD}$ | V_{SS} or V_{DD} |
| Boot-strap mode | | V _{TST} | V _{DD} |

General Release Specification

MC68HC705L5





A.8.2 Single-Chip Mode (SCM)

In this mode, all address and data bus activity occurs within the MCU. Thus, no external pins are required for these functions. The single-chip mode allows the maximum number of I/O pins for on-chip peripheral functions, for example, ports A through E, and LCD drivers.

A.8.3 Bootstrap Mode

In this mode, the reset vector is fetched from a 496-byte internal bootstrap ROM at \$3E00–\$3FEF. The bootstrap ROM contains a small program which loads a program into the internal RAM and then passes control to that program at location \$00C0 or executes the EPROM programming sequence and dumps EPROM contents.

Since these modes are not normal user modes, all of the privileged control bits are accessible. This allows the bootstrap mode to be used for self test of the device.

MOTOROLA

A.9 Memory Map

The MC68HC705L5 contains a 8,192-byte EPROM, 496 bytes of bootstrap ROM, and 256 bytes of RAM. An additional 16 bytes of EPROM are provided for user vectors at \$3FF0-\$3FFF.

The MCU's memory map is shown in Figure A-4.



Figure A-4. Memory Map

General Release Specification

A.10 Boot ROM

Boot ROM is 496 bytes of mask ROM positioned at \$3E00-\$3FEF. This ROM contains bootstrap loader programs and reset/interrupt vectors in the bootstrap mode. The bootstrap loader programs include:

- EPROM programming and verification
- Dumping EPROM contents
- Loading programs into the internal RAM
- Executing programs in the internal RAM

A.11 EPROM

The 8-Kbyte EPROM is positioned at \$1000–\$2FFF, and the additional 16 bytes of EPROM are located at \$3FF0–\$3FFF for user vectors. The erased state of EPROM is read as \$FF and EPROM power is supplied from the V_{PP} pin and the V_{DD} pin.

The program control register (PCR) is provided for EPROM programming and testing. The functions of EPROM depend on the device mode.

In user mode, ELAT and PGM bits in the PCR are available for user programming, and the remaining test bits become read-only bits. The V_{PP} pin should be tied to 5 volts or programming voltage.

A.11.1 Programming Sequence

To program the MC68HC705L5, execute this sequence:

- Set the ELAT bit
- Write the data to the address to be programmed
- Set the PGM bit
- Delay for an appropriate amount of time
- Clear the PGM bit and the ELAT bit

MOTOROLA

Clearing the PGM bit and the ELAT bit may be done on a single CPU write.

NOTE: It is important to remember that an external programming voltage must be applied to the V_{PP} pin while programming, but it should be equal to V_{DD} during normal operations.

A.11.2 Program Control Register

A program control register is provided for EPROM programming.



Figure A-5. Program Control Register (PCR)

Bits 7-3 - Reserved

These bits are reserved and read as logic 0 in user mode.

Bit 2 — Reserved

This bit is not used and always reads as logic 0.

- ELAT EPROM LATch control
 - 0 = EPROM address and data bus configured for normal reads
 - 1 = EPROM address and data bus configured for programming (Writes to EPROM cause address and data to be latched.) EPROM is in programming mode and cannot be read if ELAT is logic 1. This bit should not be set when no programming voltage is applied to the V_{PP} pin.
- PGM EPROM ProGraM command
 - 0 = Programming power switched off from EPROM array
 - 1 = Programming power switched on to EPROM array
 - If ELAT \neq 1, then PGM = 0.

General Release Specification

A.12 COP Watchdog Timer

The MC68HC705L5 does not have a COP watchdog timer. For this reason, the COPE and COPC bits in timebase control register 2 (address: \$0011) has no meaning. These bits are not used and always read as logic 0.

Also or the same reason, COP watchdog timer reset does not occur on the MC68HC705L5.

MC68HC(7)05L5 - Rev. 2.0

MOTOROLA

A.13 LCD 1/2 Duty and 1/2 Bias Timing Diagram



Figure A-6. CD 1/2 Duty and 1/2 Bias Timing Diagram

General Release Specification

A.14 Electrical Specifications

This section contains parametric and timing information for the MC68HC705L5.

A.14.1 Maximum Ratings

Maximum ratings are the extreme limits to which the MCU can be exposed without permanently damaging it.

The MCU contains circuitry to protect the inputs against damage from high static voltages; however, do not apply voltages higher than those shown in this table. Keep V_{In} and V_{OUT} within the range $V_{SS} \leq (V_{In} \text{ or } V_{OUT}) \leq V_{DD}$. Connect unused inputs to the appropriate voltage level, either V_{SS} or V_{DD}.

| Rating | Symbol | Value | Unit |
|---|--|---|------|
| Supply voltage | V _{DD} V _{LCD1} V _{LCD2} V _{LCD3} | $\begin{array}{c} -0.3 \text{ to } +7.0 \\ \text{V}_{\text{SS}} -0.3 \text{ to } \text{V}_{\text{DD}} +0.3 \\ \text{V}_{\text{SS}} -0.3 \text{ to } \text{V}_{\text{DD}} +0.3 \\ \text{V}_{\text{SS}} -0.3 \text{ to } \text{V}_{\text{DD}} +0.3 \end{array}$ | V |
| Input voltage | V _{In} | V_{SS} –0.3 to V_{DD} + 0.3 | V |
| Boot-strap mode IRQ1 pin only | V _{In} | V _{SS} –0.3 to 2 x V _{DD} + 0.3 | V |
| Output voltage | V _{Out} | V_{SS} –0.3 to V_{DD} + 0.3 | V |
| Current drain per pin excluding $V_{\mbox{\scriptsize DD}}$ and $V_{\mbox{\scriptsize SS}}$ | I | 12.5 | mA |
| Operating junction temperature | TJ | +150 | °C |
| Storage temperature range | T _{stg} | -55 to +150 | °C |

NOTE: This device is not guaranteed to operate properly at the maximum ratings. Refer to **A.15.2 5.0-Volt DC Electrical Characteristics** and **A.15.3 3.3-Volt DC Electrical Characteristics** for guaranteed operating conditions.

A.14.2 Operating Temperature Range

| Characteristic | Symbol | Value | Unit |
|---|----------------|--|------|
| Operating temperature range MC68HC705L5 (standard) | T _A | T _L to T _H 0 to +70 | °C |

A.14.3 Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|---------------|-------|------|
| Thermal resistance 80-pin plastic quad flat pack | θ_{JA} | 120 | °C/W |

A.15 Recommended Operating Conditions

| Rating ⁽¹⁾ | Symbol | Min | Тур | Max | Unit |
|--|-------------------|------------------------|--|-----|------|
| (f _{OP} = 2.1 MHz) | V _{DD} | 4.5 | 5.0 | 5.5 | V |
| (f _{OP} = 1.0 MHz) | V _{DD} | 3.0 | | 5.5 | V |
| Supply voltage | V _{LCD1} | VD | V _{DD} – 1/3 V _{LCD} | | |
| | V _{LCD2} | VD | _D – 2/3 V _l | _CD | V |
| | V _{LCD3} | $V_{DD} - 3/3 V_{LCD}$ | | | V |
| Fast clock oscillation frequency | f _{OSC} | _ | 3.52 | 4.2 | MHz |
| External capacitance (f _{OSC} = 3.52 MHz) | C1 C2 | _ | 33 33 | _ | pF |
| Slow clock oscillation frequency | f _{XOSC} | | 32.768 | | MHz |
| External capacitance (f _{XOSC} = 32.768 kHz) | CX1 CX2 | | 18 22 | | pF |

1. +3.0 \leq V_DD \leq +5.5 Vdc, V_SS = 0 Vdc, T_L \leq T_A \leq T_H, unless otherwise noted

A.15.1 EPROM Programming Voltage

| Characteristics ⁽¹⁾ | Symbol | Min | Тур | Max | Unit |
|--|--------------------|------|------|------|------|
| EPROM programming voltage | V _{PP} | 12.0 | 12.5 | 13.0 | V |
| $\frac{1}{1} = \frac{1}{2} = \frac{1}$ | $\hat{\mathbf{c}}$ | | | | |

1. $V_{DD} = 5.0$ Vdc, $V_{SS} = 0$ Vdc, $T_A = 25$ °C

General Release Specification

| A.15.2 5.0-Volt DC Electrical Characteristics |
|---|
|---|

| Characteristic ⁽¹⁾ | Symbol | Min | Тур | Мах | Unit |
|---|------------------------------------|--------------------------|-------------------|-----------------------|----------------|
| Output voltage $I_{Load} = 10.0 \mu A$ $I_{Load} = -10.0 \mu A$ | V _{OL} V _{OH} | V _{DD} _0.1 | _ | 0.1 | V |
| Output high voltage (V _{DD} = 5.0 V) (I _{Load} = -0.4 mA) PA0-PA7, PC0-PC5, PD1-PD7, PE0-PE7 | V _{OH} | V _{DD} –0.8 | _ | _ | V |
| Output low voltage (V _{DD} = 5.0 V) (I _{Load} = 0.8 mA) PA0–PA7, PC0–PC5, PD1–PD7, PE0–PE7 | V _{OL} | _ | _ | 0.4 | V |
| Input high voltage PA0–PA7, PB0–PB7, PC0–PC7, RESET, OSC1, XOSC1 | V _{IH} | 0.8 x V _{DD} | _ | V _{DD} | V |
| Input low voltage PA0–PA7, PB0–PB7, PC0–PC7, RESET, OSC1, XOSC1 | V _{IL} | V _{SS} | _ | 0.2 x V _{DD} | V |
| Supply current ^{(2), (3), (4), (5)} Run ($f_{OP} = 2.1 \text{ MHz}$) Wait ($f_{OP} = 2.1 \text{ MHz}$) Stop No clock | I _{DD} | | 6.0 3.0 3.0 | 12.0 6.0 10.0 | mA mA μA |
| XOSC = 32.768 kHz, V_{DD} = 5.0 V, T_A = +25 °C | | — | 17.0 | _ | μA |
| Input current ⁽⁶⁾ (with pullups disabled) PA0–PA7, PB0–PB7, PC0–PC7, RESET, OSC1, XOSC1 | I _{In} | _ | _ | ± 1.0 | μA |
| Input current ⁽⁶⁾ (with pullups enabled, V _{DD} = 5.0 V) PA0–PA7 PB0–PB7 PC0–PC7 | l _{In} | 40 40 160 | 150 150 500 | 340 340 1000 | μΑ μΑ μΑ |
| LCD pin output impedance FP0–FP26 BP0–BP3 | Zo, FP Zo, BP | | 10 5 | 20 18 | kΩ kΩ |

1. +4.5 \leq V_{DD} \leq +5.5 Vdc, V_{SS} = 0 Vdc, T_L \leq T_A \leq T_H, unless otherwise noted. All values shown reflect average measurements. Typical values at midpoint of voltage range, 25 °C only.

Run (Operating) I_{DD}, wait I_{DD}; measured using external square wave clock source (f_{OSC} = 4.2 MHz); all inputs 0.2 V from rail (V_{SS} or V_{DD}); no dc loads; less than 50 pF on all outputs; C_L = 20 pF on OSC2

3. Wait, stop I_{DD}; all ports configured as inputs; $V_{IL} = 0.2 \text{ V}$; $V_{IH} = V_{DD} - 0.2 \text{ V}$

4. Stop I_{DD} measured with OSC1 = V_{SS} .

5. Wait $I_{\mbox{\scriptsize DD}}$ is affected linearly by the OSC2 capacitance.

6. Input current measured with output transistor turned off and $V_{In} = 0$ V.

A.15.3 3.3-Volt DC Electrical Characteristics

| Characteristic ⁽¹⁾ | Symbol | Min | Тур | Max | Unit |
|---|------------------------------------|--------------------------|-----------------|-----------------------|----------------|
| Output voltage $I_{Load} = 10.0 \mu A$ $I_{Load} = -10.0 \mu A$ | V _{OL} V _{OH} | V _{DD} _0.1 | | 0.1 | V |
| Output high voltage (V _{DD} = 3.5 V) (I _{Load} = -0.4 mA) PA0-PA7, PC0-PC5, PD1-PD7, PE0-PE7 | V _{OH} | V _{DD} –0.8 | | | V |
| Output low voltage (V _{DD} = 3.5 V) (I _{Load} = 0.8 mA) PA0–PA7, PC0–PC5, PD1–PD7, PE0–PE7 | V _{OL} | _ | | 0.4 | V |
| Input high voltage PA0–PA7, PB0–PB7, PC0–PC7, RESET, OSC1, XOSC1 | V _{IH} | 0.8 x V _{DD} | _ | V _{DD} | V |
| Input low voltage PA0–PA7, PB0–PB7, PC0–PC7, RESET, OSC1, XOSC1 | V _{IL} | V _{SS} | _ | 0.2 x V _{DD} | V |
| $\begin{array}{l} \mbox{Supply current}^{(2), \ (3), \ (4), \ (5)} \\ \mbox{Run } (f_{OP} = 1.0 \ \mbox{MHz}) \\ \mbox{Wait } (f_{OP} = 1.0 \ \mbox{MHz}) \\ \mbox{Stop} \end{array}$ | I _{DD} | | 1.8 0.8 | 8.0 5.0 | mA mA |
| No clock XOSC = 32.768 kHz, V_{DD} = 3.0 V, T_A = +25 °C | | — | 2.0 8.0 | 10.0 | μΑ μΑ |
| Input current ⁽⁶⁾ (with pullups disabled) PA0–PA7, PB0–PB7, PC0–PC7, RESET, OSC1, XOSC1 | l _{in} | _ | _ | ± 1.0 | μA |
| Input current ⁽⁶⁾ (with pullups enabled, $V_{DD} = 3.3 \text{ V}$) PA0–PA7 PB0–PB7 PC0–PC7 | l _{in} | 20 20 60 | 80 80 300 | 230 230 760 | μΑ μΑ μΑ |
| LCD pin output impedance FP0–FP26 BP0–BP3 | Zo, FP Zo, BP | | 10 5 | 20 18 | kΩ kΩ |

1. +3.0 \leq V_{DD} < +4.5 Vdc, V_{SS} = 0 Vdc, T_L \leq T_A \leq T_H, unless otherwise noted. All values shown reflect average measurements. Typical values at midpoint of voltage range, 25 °C only.

Run (Operating) I_{DD}, wait I_{DD}; measured using external square wave clock source (f_{OSC} = 2.0 MHz); all inputs 0.2 V from rail (V_{SS} or V_{DD}); no dc loads; less than 50 pF on all outputs; C_L = 20 pF on OSC2

3. Wait, stop I_{DD}; all ports configured as inputs; V_{IL} = 0.2 V; V_{IH} = V_{DD} –0.2 V

4. Stop I_{DD} measured with OSC1 = V_{SS} .

5. Wait I_{DD} is affected linearly by the OSC2 capacitance.

6. Input current measured with output transistor turned off and $V_{In} = 0$ V.

General Release Specification

Semiconductor, Inc.

reescale

11.

A.15.4 3.3-Volt and 5.0-Volt Control Timing

| Characteristic ⁽¹⁾ | Symbol | Min | Max | Unit |
|--|--|------------|------------|------------------------|
| Frequency of oscillation (OSC) Crystal External Clock | fosc | dc | 4.2 4.2 | MHz |
| Internal operating frequency ⁽²⁾ , crystal or external clock ($f_{OSC}/2$) $V_{DD} = 4.5 V$ to 5.5 V $V_{DD} = 3.0 V$ to 5.5 V | f _{OP} | | 2.1 1.0 | MHz |
| Cycle time (fast OSC selected) $V_{DD} = 4.5 \text{ V to } 5.5 \text{ V}$ $V_{DD} = 3.0 \text{ V to } 5.5 \text{ V}$ | t _{cyc} | 480 1.0 | | ns μs |
| RESET pulse width (when bus clock active) | t _{RL} | 1.5 | _ | t _{cyc} |
| Timer Resolution Input capture (TCAP) pulse width | t _{RESL} t _{TH} , t _{TL} | 4.0 284 | _ | t _{cyc} ns |
| Interrupt pulse width low (edge-triggered) | t _{ILIH} | 284 | _ | ns |
| Interrupt pulse period ⁽³⁾ | t _{ILIL} | see note | _ | t _{cyc} |
| OSC1 pulse width (external clock input) | t _{OH} , t _{OL} | 110 | | ns |

1. +3.0 \leq V_{DD} $\,\leq$ +5.5 Vdc, V_{SS} = 0 Vdc,T_L \leq T_A \leq T_H, unless otherwise noted.

2. The system clock divider configuration (SYS1–SYS0 bits) should be selected such that the internal operating frequency (f_{OP}) does not exceed value specified in f_{OP} for a given f_{OSC}.

3. The minimum period, t_{ILIL}, should not be less than the number of cycle times it takes to execute the interrupt service routine plus 21 t_{cyc}.

A.16 MC Order Number

Table A-4 shows the MC order number for the available package type.

Table A-4. MC Order Number

| Package Type | Operating Temperature Range | MC Order Number |
|--|-----------------------------------|-----------------|
| 80-pin plastic quad flat pack (QFP) | 0 °C to +70 °C | MC68HC705L5FU |

General Release Specification

Motorola reserves the right to make changes without further notice to any products herein. Motorola makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Motorola assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters which may be provided in Motorola data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. Motorola does not convey any license under its patent rights or the rights of others. Motorola products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Motorola was negligent regarding the design or manufacture of the part. Motorola and (A) are registered trademarks of Motorola, Inc. Motorola, Inc. is an Equal Opportunity/Affirmative Action Employer.

How to reach us:

USA/EUROPE/Locations Not Listed: Motorola Literature Distribution, P.O. Box 5405, Denver, Colorado 80217, 1-800-441-2447 or 1-303-675-2140. Customer Focus Center, 1-800-521-6274

JAPAN: Nippon Motorola Ltd.: SPD, Strategic Planning Office, 141, 4-32-1 Nishi-Gotanda, Shinagawa-ku, Tokyo, Japan. 03-5487-8488 ASIA/PACIFIC: Motorola Semiconductors H.K. Ltd., 8B Tai Ping Industrial Park, 51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852-26629298 Mfax™, Motorola Fax Back System: RMFAX0@email.sps.mot.com; http://sps.motorola.com/mfax/;

TOUCHTONE, 1-602-244-6609; US and Canada ONLY, 1-800-774-1848

HOME PAGE: http://motorola.com/sps/

Mfax is a trademark of Motorola, Inc.



© Motorola, Inc., 1998

For More Information On This Product, Go to: www.freescale.com HC05L5GRS/D